MODEL NAME : *QCL00_QCL20*

PCB NO : *LA-8241P*

BOM P/N : *4619GP31L21 Inspiron DIS*
4619GQ31L21 Inspiron UMA
4619GP31L01 Vostro DIS
4619GQ31L01 Vostro UMA

Dell / Compal Confidential

Schematic Document

Inspron A5 & Vostro 3560 (Intel Chief River)
Ivy Bridge(rPGA) + Panther Point(mainstream)

Discrete AMD Thames-XT

2012-02-01

Rev: 1.0

MB Type	BOM P/N	Config

46@ : for 46 level
@ : Nopop Component
CONN@ : Connector Component
KB930@ : ENE KB930 Implemented
KB9012@ : ENE KB9012 Implemented
EXP@ : Express Card Implemented
FFS@ : Only for Free Fall Sensor
VOS@ : Only for Vostro
INS@ : Only for Inspiron
UMA@ : Only for UMA
GCLK@ : Green CLK implemented
AMP@ : External Amplifier implemented
KBBL@ : Keyboard Back Light implemented

X76@ : VRAM Group
CH@ : Chelsea M2
SE@ : Seymour M2
TH@ : Thames-XT
DIS@ : Only for Discrete

Security Classification	Compal Secret Data		
Issued Date	2012/01/17	Deciphered Date	2013/01/16

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Title: *Cover Page*

Size | Document Number: *LA-8241P* | Rev: 1.0

Date: Wednesday, February 01, 2012 | Sheet 1 of 56

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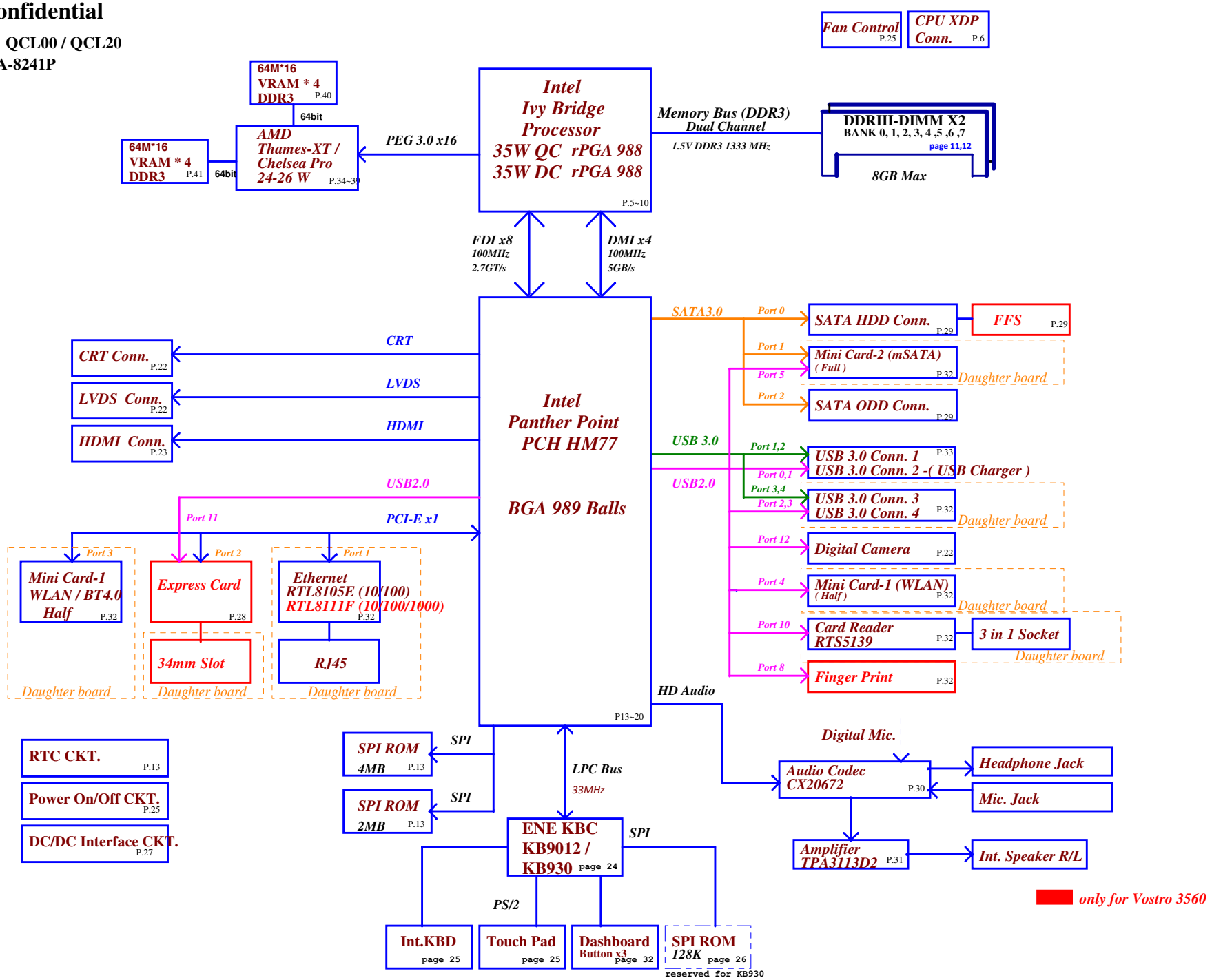
Project Code : QCL00 / QCL20
File Name : LA-8241P

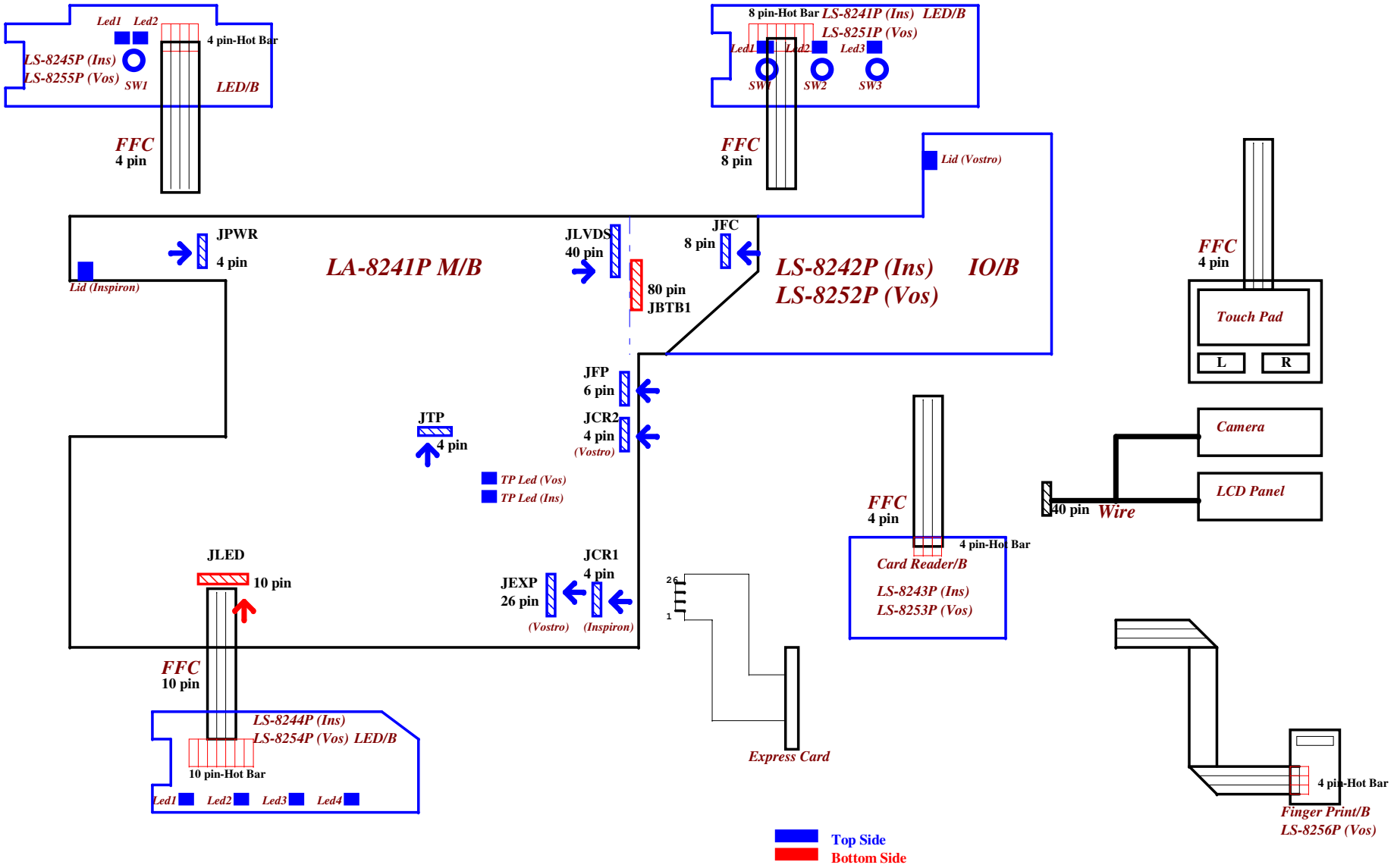


Security Classification	Compal Secret Data		
Issued Date	2012/01/17	Deciphered Date	2013/01/16

Compal Electronics, Inc.			
Title: Block Diagram			
Size	Document Number: LA-8241P		Rev: 1.0
Date: Wednesday, February 01, 2012	Sheet 2 of 56		

Compal Confidential

Project Code : QCL00 / QCL20
File Name : LA-8241P



Security Classification	Compal Secret Data		
Issued Date	2012/01/17	Deciphered Date	2013/01/16

Compal Electronics, Inc.

Title: **Block Diagram**

Size	Document Number	Rev 1.0
Date: Wednesday, February 01, 2012	Sheet 3 of 56	

Board ID Table for AD channel

Vcc	3.3V +/- 5%
Ra	100K +/- 5%

Board ID	Rb	V_{AD_BID} min	V_{AD_BID} typ	V_{AD_BID} max	EC AD3
0	0	0 V	0 V	0.155 V	0x00-0x0C
1	8.2K +/- 5%	0.168 V	0.250 V	0.362 V	0x0D-0x1C
2	18K +/- 5%	0.375 V	0.503 V	0.621 V	0x1D-0x30
3	33K +/- 5%	0.634 V	0.819 V	0.945 V	0x31-0x49
4	56K +/- 5%	0.958 V	1.185 V	1.359 V	0x4A-0x69
5	100K +/- 5%	1.372 V	1.650 V	1.838 V	0x6A-0x8E
6	200K +/- 5%	1.851 V	2.200 V	2.420 V	0x8F-0xBB
7	NC	2.433 V	3.300 V	3.300 V	0xBC-0xFF

BOARD ID Table

Board ID	PCB Revision					
0	0.1					
1			0.1			
2	0.2					
3			0.2			
4	0.3				0.2	
5			0.3		0.3	
6	1.0				1.0	
7			1.0			
	QCL00		QCL20		QCL01	

SMBUS Control Table

	SOURCE	MINI1	MINI2	BATT	SODIMM	Express Card	Thermal Sensor	FFS	VGA Thermal Sensor	VGA	XDP	Charger
EC_SMB_CK1 EC_SMB_DA1	KB9012			V								V
EC_SMB_CK2 EC_SMB_DA2	KB9012								V	V		
PCH_SML0CLK PCH_SML0DATA	PCH											
PCH_SML1CLK PCH_SML1DATA	PCH											
MEM_SMBCLK MEM_SMBDATA	PCH	V	V		V	V		V			V	

Link

PCH	USB PORT#	DESTINATION
	0	USB conn.1
	1	USB conn.2 - Power Share
	2	USB conn.3
	3	USB conn.4
	4	MINI CARD-1 (WLAN)
	5	NC
	6	NC
	7	NC
	8	Finger Print
	9	NC
	10	Card Reader
	11	Express Card
	12	Camera
	13	NC

CLKOUT	DESTINATION
PCI0	PCH_LOOPBACK
PCI1	EC LPC
PCI2	None
PCI3	None
PCI4	None

CLK	DIFFERENTIAL	DESTINATION	FLEX CLOCKS	DESTINATION
	CLKOUT_PCIE0	10/100/1G LAN	CLKOUTFLEX0	None
	CLKOUT_PCIE1	MINI CARD-1 WLAN	CLKOUTFLEX1	None
	CLKOUT_PCIE2	Express Card	CLKOUTFLEX2	None
	CLKOUT_PCIE3	None	CLKOUTFLEX3	None
	CLKOUT_PCIE4	None		
	CLKOUT_PCIE5	None		
	CLKOUT_PCIE6	None		
	CLKOUT_PCIE7	None		
	CLKOUT_PEG_B	None		

SATA	DESTINATION
SATA0	HDD
SATA1	SSD
SATA2	ODD
SATA3	None
SATA4	None
SATA5	None

PCI EXPRESS	DESTINATION
Lane 1	10/100/1G LAN
Lane 2	MINI CARD-1 (WLAN)
Lane 3	Express Card
Lane 4	None
Lane 5	None
Lane 6	None
Lane 7	None
Lane 8	None

Symbol Note :

: means Digital Ground

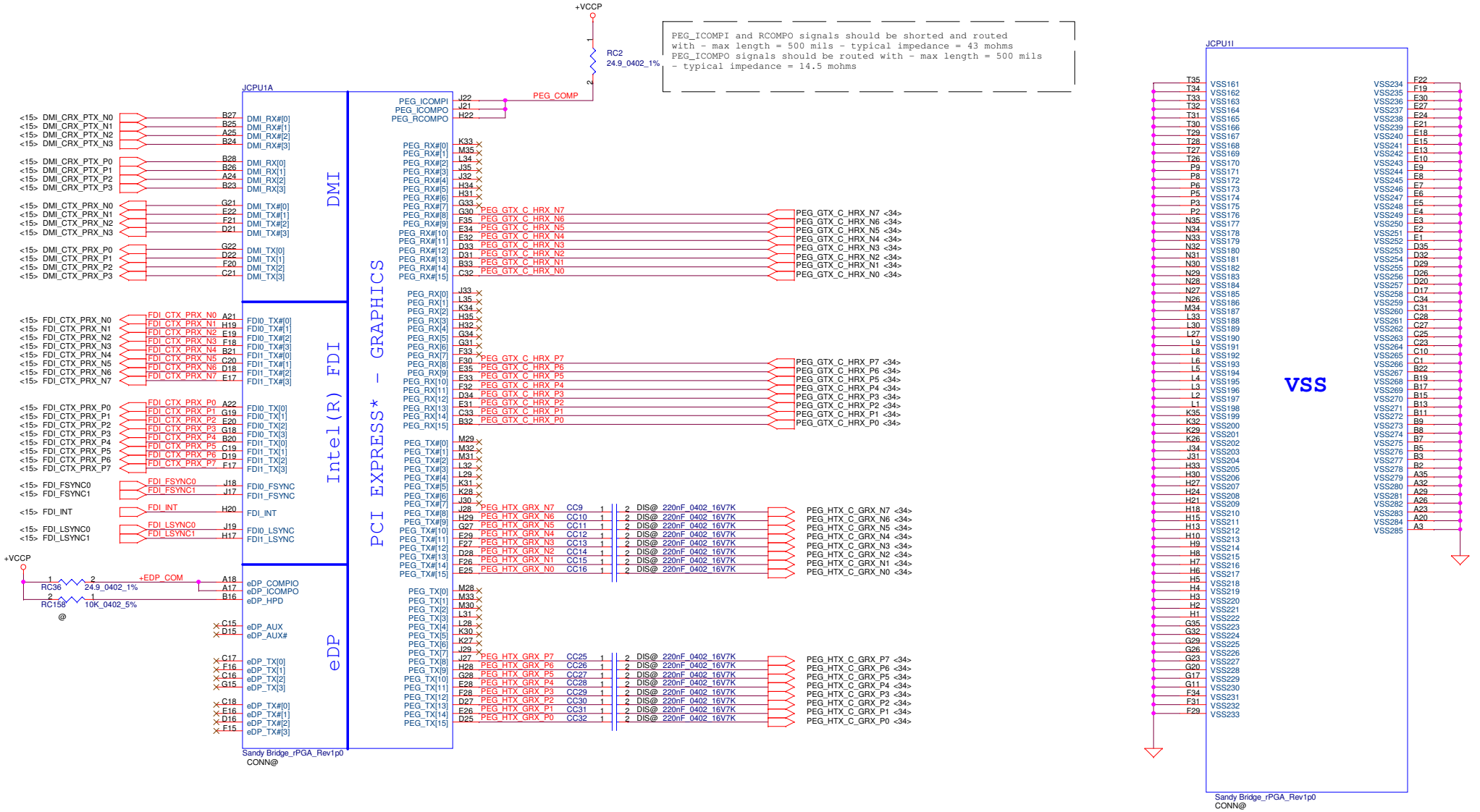
: means Analog Ground

Compal Electronics, Inc.

Title: Notes List

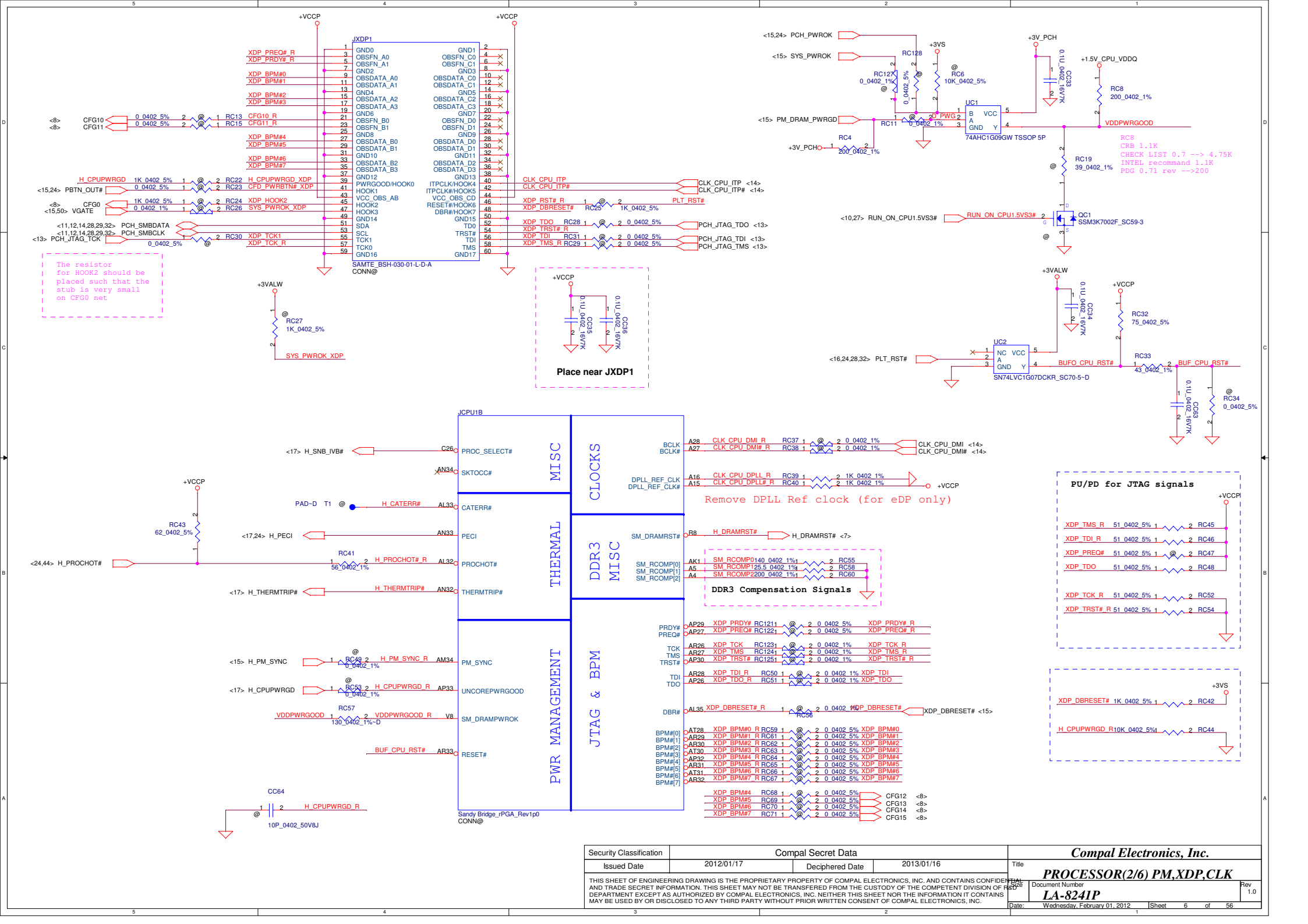
Size: Document Number: LA-8241P Rev: 1.0

Date: Wednesday, February 01, 2012 Sheet 4 of 56



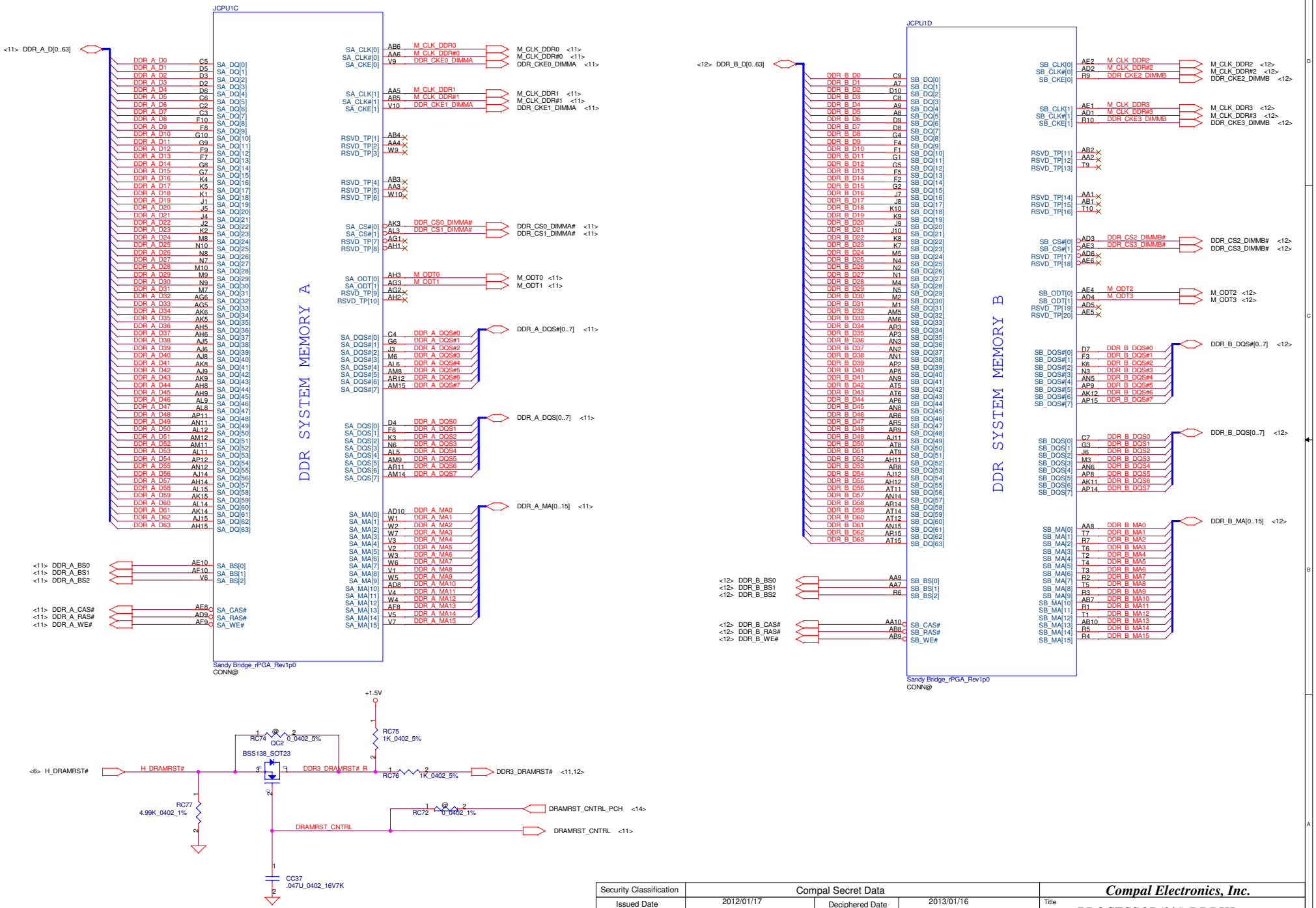
Security Classification	Compal Secret Data		
Issued Date	2012/01/17	Deciphered Date	2013/01/16

Compal Electronics, Inc.			
Title	PROCESSOR(1/6) DMI,FDI,PEG		
Size	Document Number	LA-8241P	Rev 1.0
Date:	Wednesday, February 01, 2012	Sheet 5 of 56	



Security Classification	Compal Secret Data		
Issued Date	2012/01/17	Deciphered Date	2013/01/16

Compal Electronics, Inc.	
Title	PROCESSOR(2/6) PM,XDP,CLK
Size	Document Number: LA-8241P
Rev	1.0
Date: Wednesday, February 01, 2012	Sheet 6 of 56



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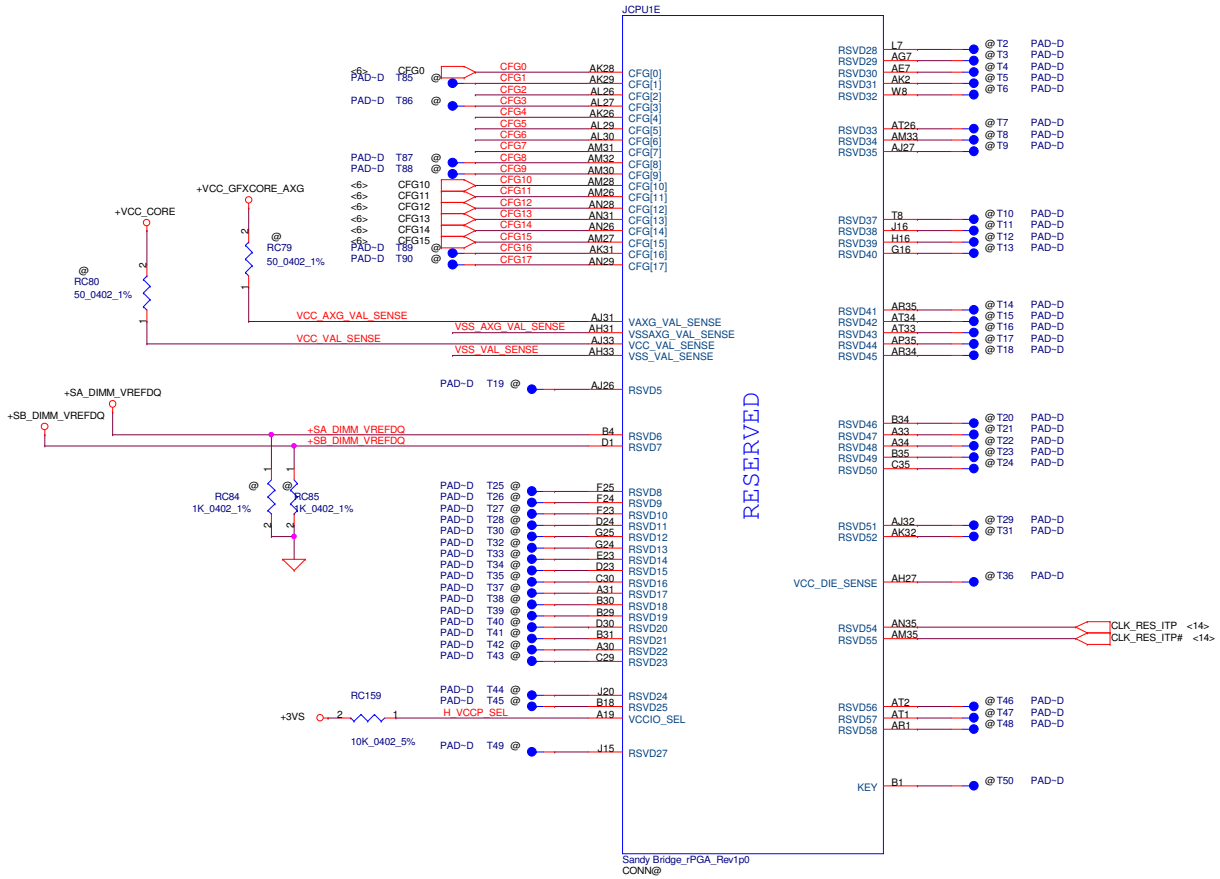
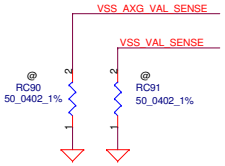
Compal Electronics, Inc.

Title: **PROCESSOR(3/6) DDRIII**

Size | Document Number: **LA-8241P** | Rev: 1.0

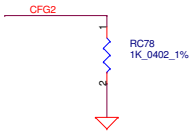
Date: Wednesday, February 01, 2012 | Sheet 7 of 56



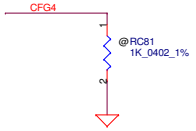


INTEL 12/28 recommand
to add RC120, RC121, RC122, RC123
Please place as close as JCPU1

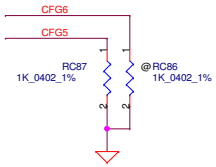
CFG Straps for Processor



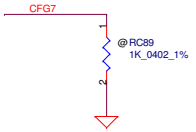
PEG Static Lane Reversal – CFG2 is for the 16x	
CFG2	1:(Default) Normal Operation; Lane # definition matches socket pin map definition *0:Lane Reversed



Display Port Presence Strap	
CFG4	* 1 : Disabled; No Physical Display Port attached to Embedded Display Port 0 : Enabled; An external Display Port device is connected to the Embedded Display Port



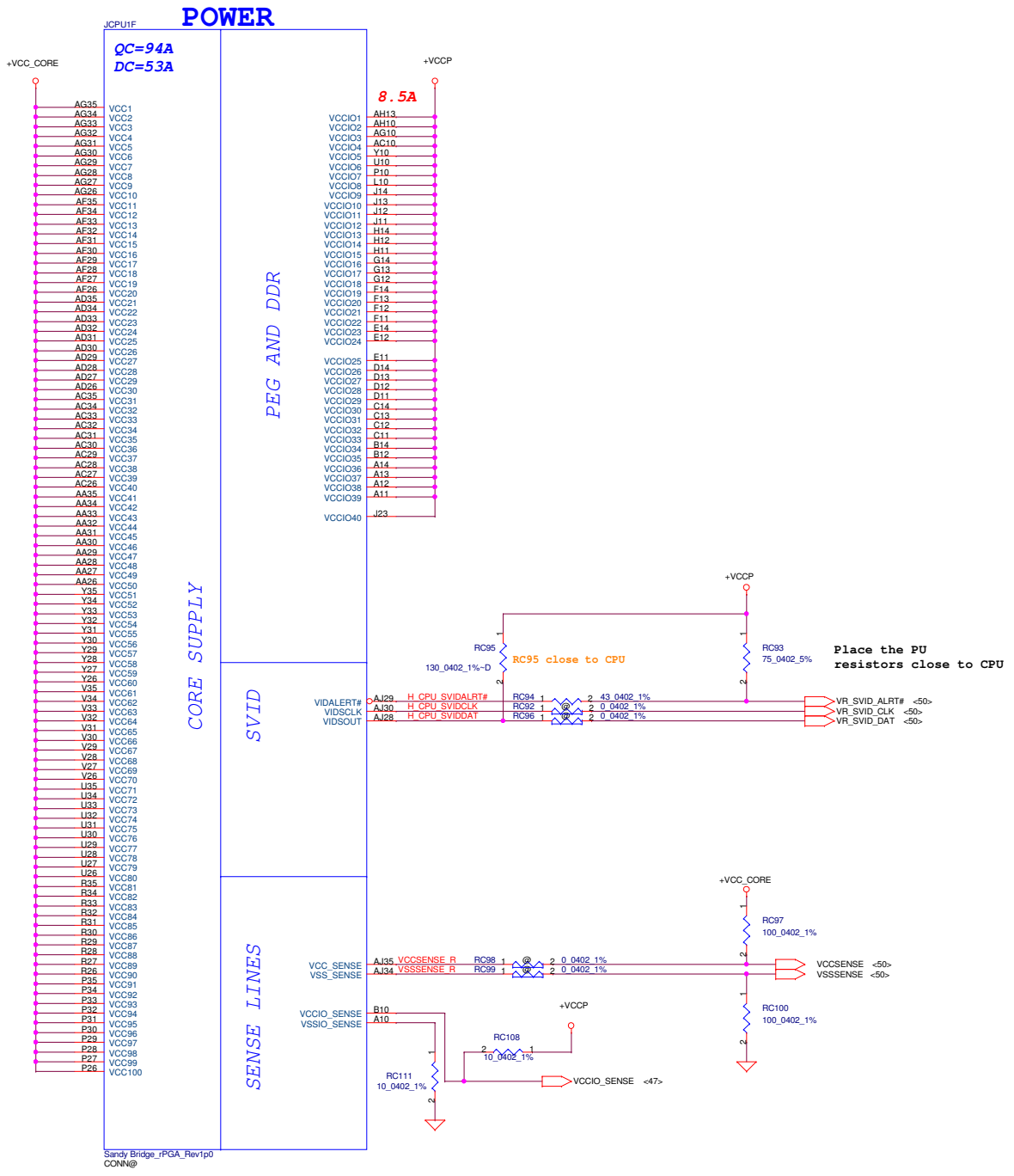
PCIE Port Bifurcation Straps	
CFG[6:5]	11: (Default) x16 – Device 1 functions 1 and 2 disabled *10: x8, x8 – Device 1 function 1 enabled ; function 2 disabled 01: Reserved – (Device 1 function 1 disabled ; function 2 enabled) 00: x8,x4,x4 – Device 1 functions 1 and 2 enabled



PEG DEFER TRAINING	
CFG7	*1: (Default) PEG Train immediately following xxRESETB de assertion 0: PEG Wait for BIOS for training

Security Classification	Compal Secret Data		
Issued Date	2012/01/17	Deciphered Date	2013/01/16

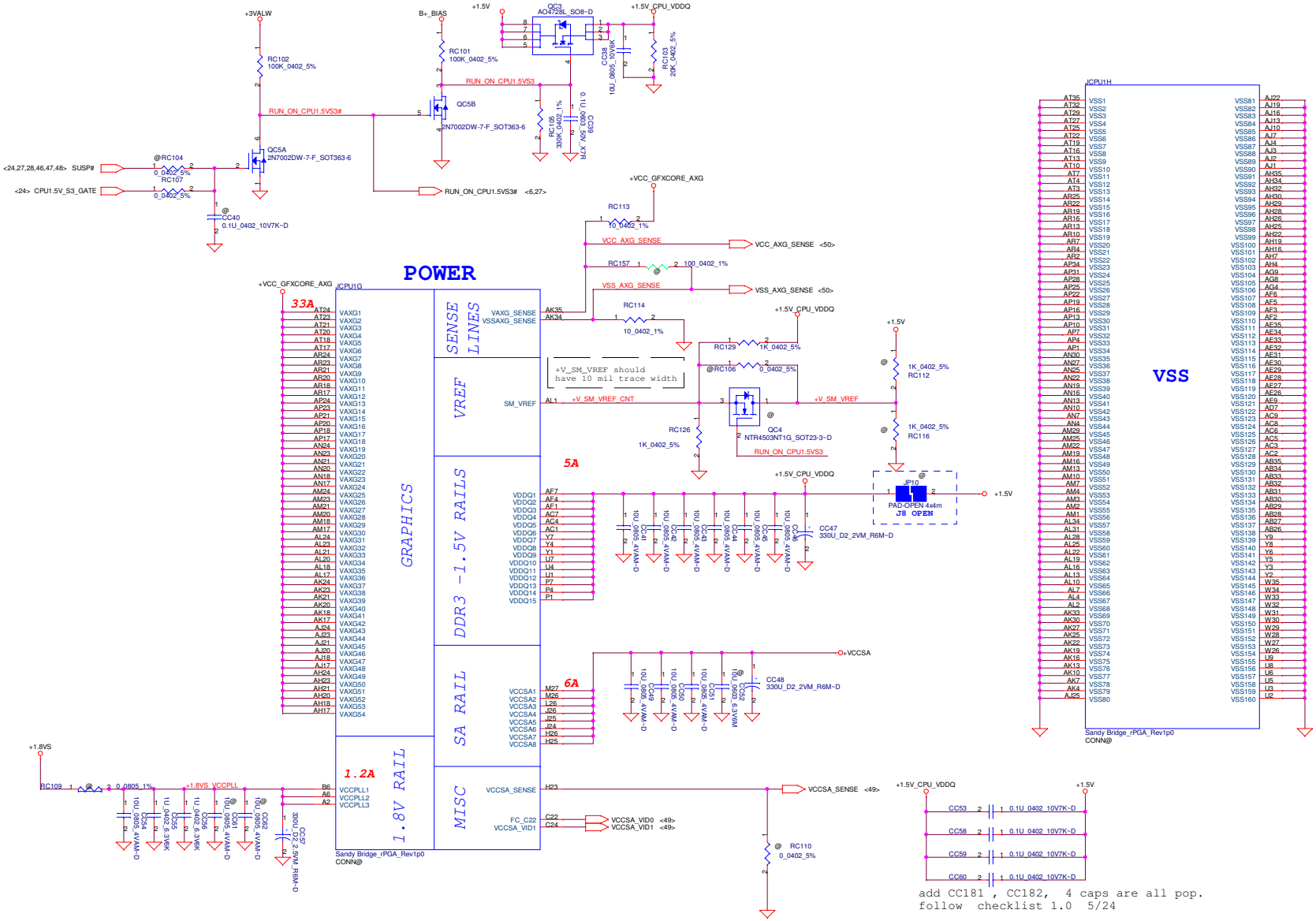
Compal Electronics, Inc.			
Title	PROCESSOR(4/6) RSVD,CFG		
Size	Document Number LA-8241P		Rev 1.0
Date: Wednesday, February 01, 2012		Sheet 8 of 56	



Security Classification	Compal Secret Data		
Issued Date	2012/01/17	Deciphered Date	2013/01/16

Compal Electronics, Inc.			
Title	PROCESSOR(5/6) PWR,BYPASS		
Size	Document Number		Rev
	LA-8241P		1.0
Date:	Wednesday, February 01, 2012	Sheet	9 of 56

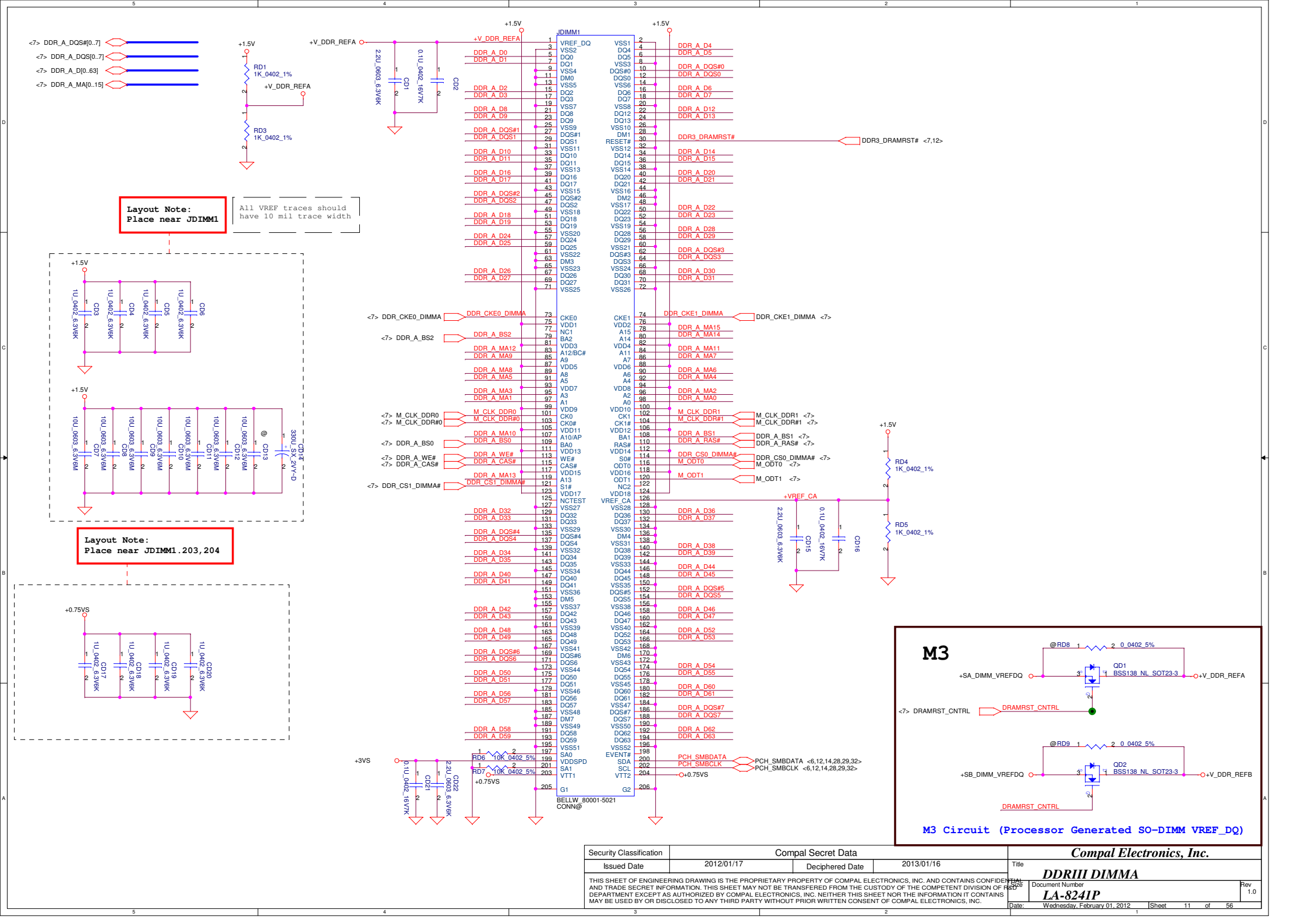
+1.5V_CPU_VDDQ Source



add CC181 , CC182, 4 caps are all pop.
follow checklist 1.0 5/24

Security Classification	Compal Secret Data		Compal Electronics, Inc.
Issued Date	2012/01/17	Deciphered Date 2013/01/16	Title PROCESSOR(6/6) PWR,VSS

Size	Document Number		Rev
	LA-8241P		1.0
Date:	Wednesday, February 01, 2012	Sheet 10 of 56	



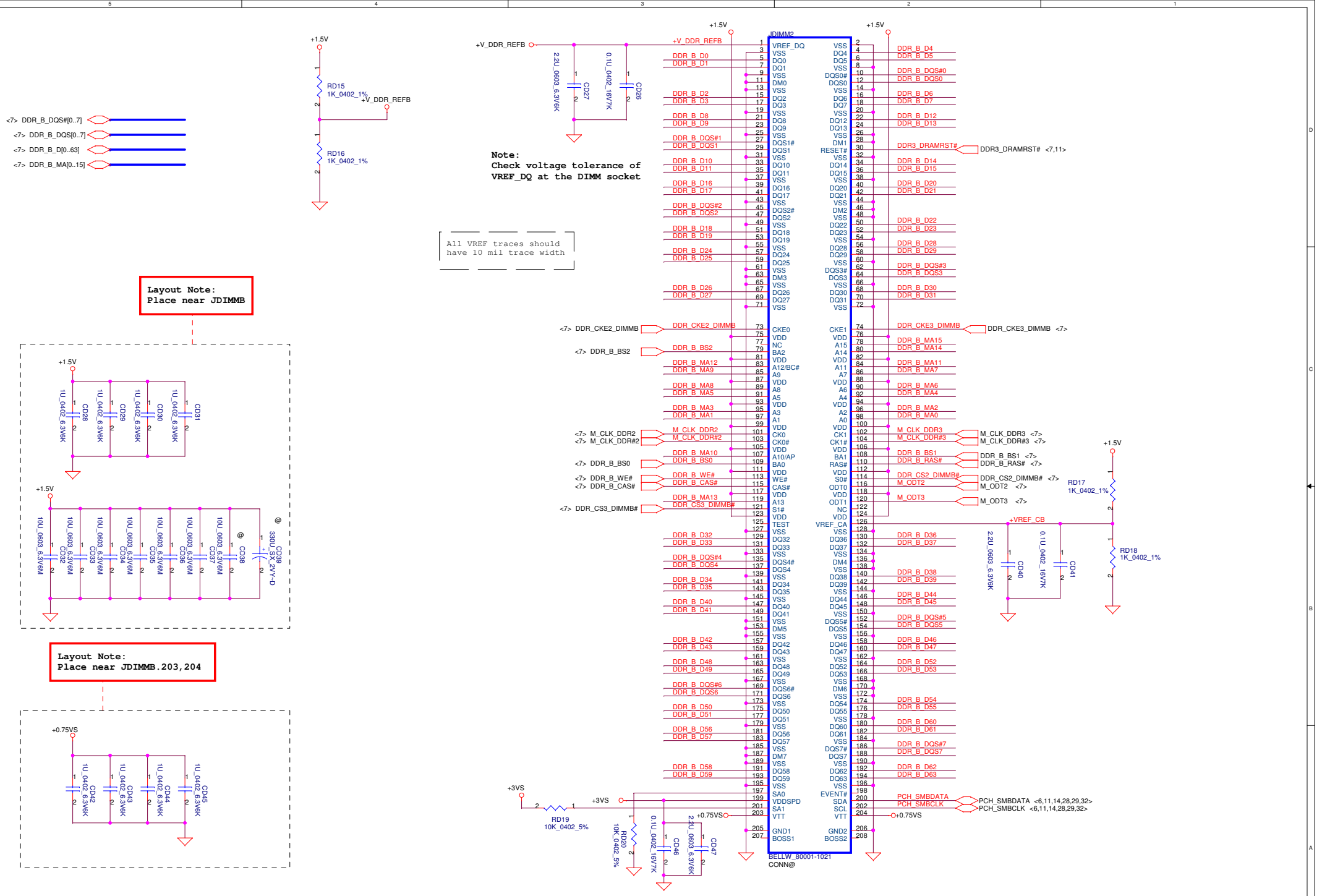
Security Classification	Compal Secret Data		
Issued Date	2012/01/17	Deciphered Date	2013/01/16

Compal Electronics, Inc.

Title: DDRIII DIMMA

Size: | Document Number: LA-8241P | Rev: 1.0

Date: Wednesday, February 01, 2012 | Sheet 11 of 56


+1.5V
RD15
1K_0402_1%
+V_DDR_REFB
RD16
1K_0402_1%
+V_DDR_REFB
2.2U_0603_6.3V6K
CD27
0.1U_0402_16V7K
CD26
Note:
Check voltage tolerance of
VREF_DQ at the DIMM socket
All VREF traces should
have 10 mil trace width
JDIMM2
BELLW_80001-1021
CONN@
<7> DDR_B_DQS#[0..7]
<7> DDR_B_DQS[0..7]
<7> DDR_B_D[0..63]
<7> DDR_B_MA[0..15]
Layout Note:
Place near JDIMMB
1U_0402_6.3V6K
CD28
CD29
CD30
CD31
10U_0603_6.3V6M
CD32
CD33
CD34
CD35
CD36
CD37
CD38
330U_SX_2VY-D
CD39
Layout Note:
Place near JDIMMB.203,204
+0.75VS
CD42
CD43
CD44
CD45
DDR_CKE2_DIMMB
DDR_CKE3_DIMMB
M_CLK_DDR2
M_CLK_DDR#2
M_CLK_DDR3
M_CLK_DDR#3
DDR_B_BS2
DDR_B_BS0
DDR_B_BS1
DDR_B_WE#
DDR_B_CAS#
DDR_B_RAS#
DDR_CS3_DIMMB#
DDR_CS2_DIMMB#
M_ODT2
M_ODT3
DDR3_DRAMRST#
PCH_SMBDATA
PCH_SMBCLK
+3VS
RD19
10K_0402_5%
RD20
10K_0402_5%
CD46
CD47
+0.75VS
RD17
1K_0402_1%
RD18
1K_0402_1%
+VREF_CB
CD40
CD41
Security Classification
Compal Secret Data
Issued Date
2012/01/17
Deciphered Date
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Title
DDRIII DIMMB
Size
Document Number
LA-8241P
Rev
1.0
Date:
Wednesday, February 01, 2012
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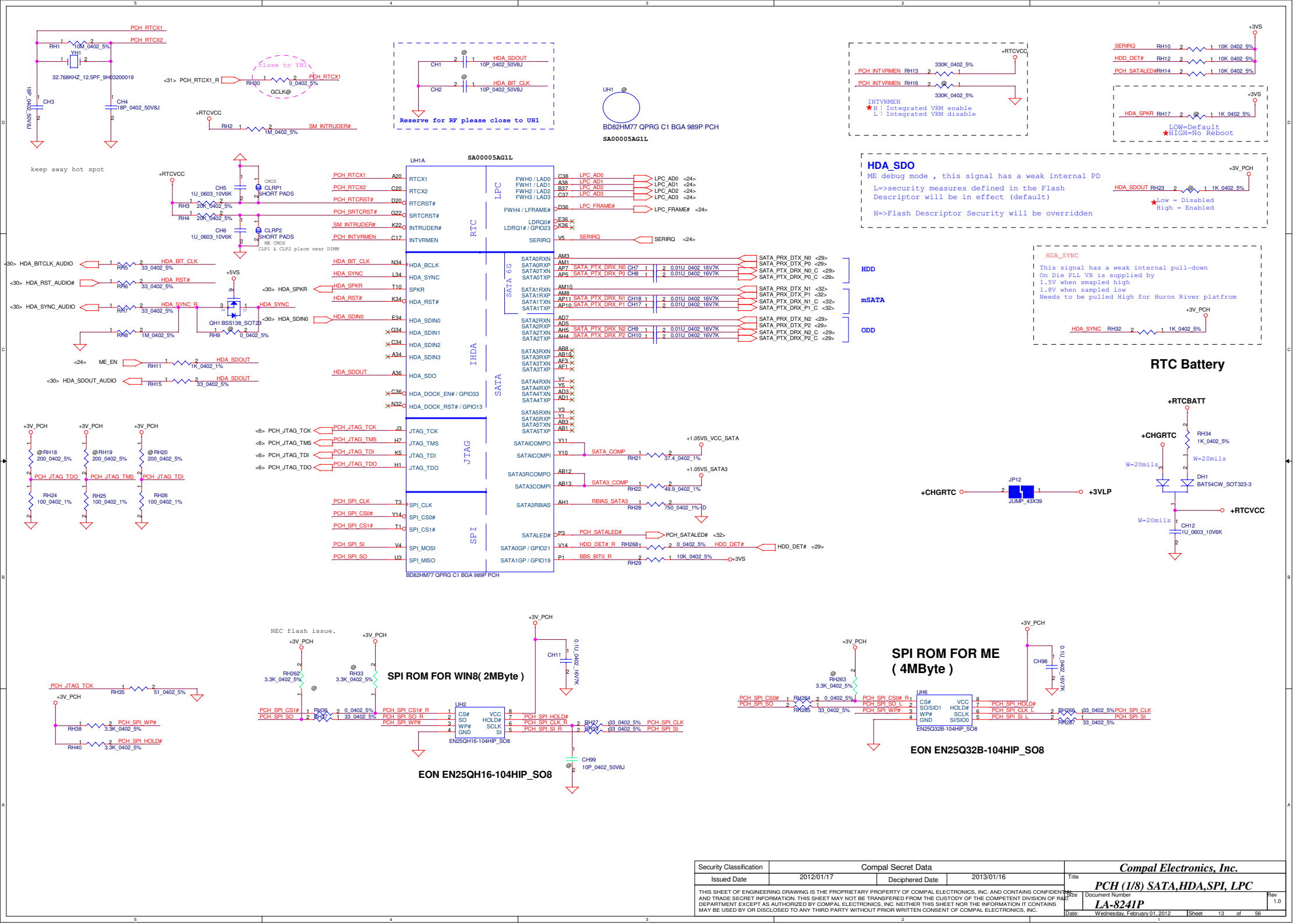
12
of
56



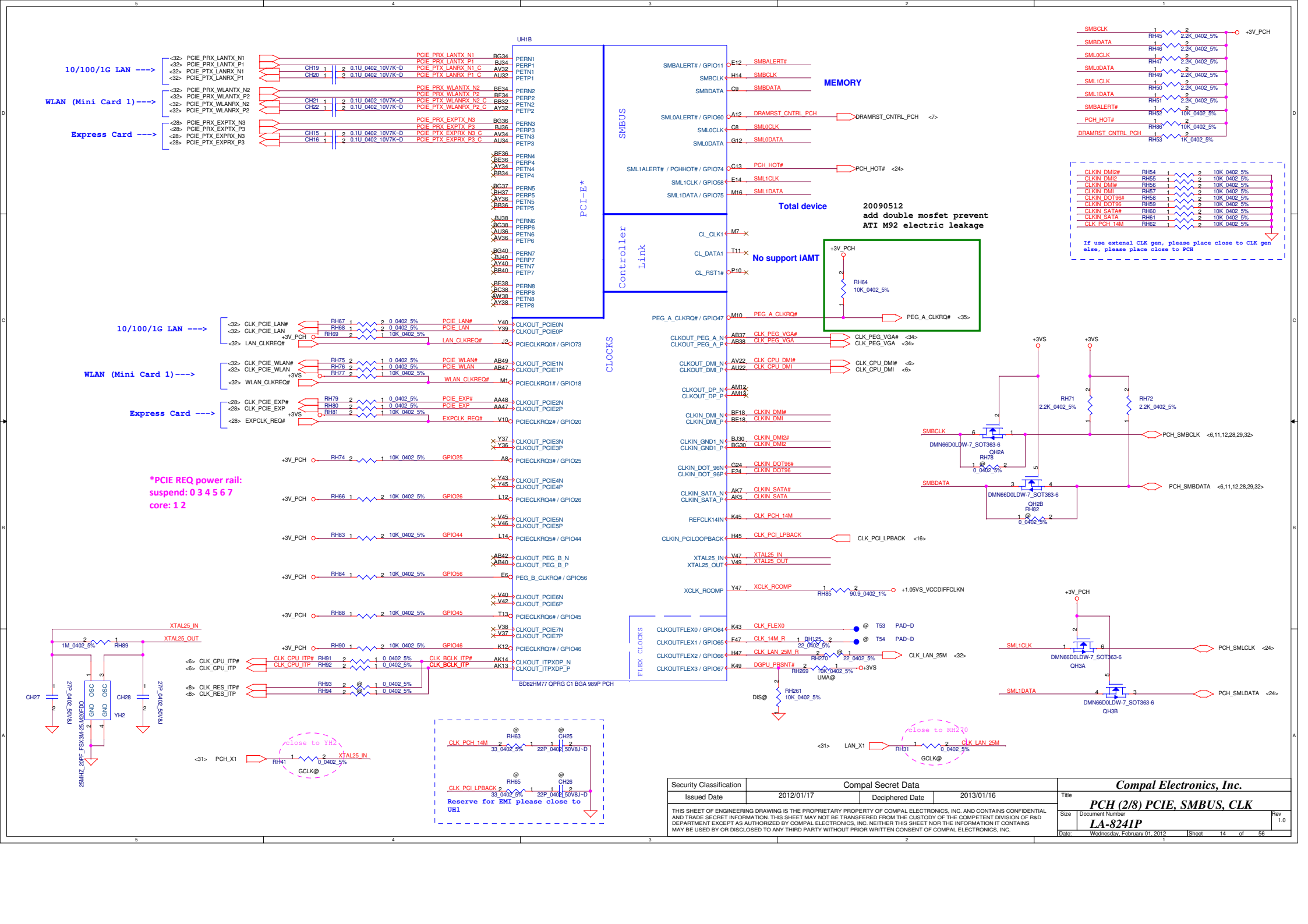
Security Classification	Compal Secret Data		
Issued Date	2012/01/17	Deciphered Date	2013/01/16

Compal Electronics, Inc.

Title: PCH (1/8) SATA,HDA,SPI, LPC

Size	Document Number	Rev
	LA-8241P	1.0

Date: Wednesday, February 01, 2012 Sheet 13 of 56


10/100/1G LAN ---->
WLAN (Mini Card 1)---->
Express Card ---->
UH1B
PCI-E*
SMBUS
Controller Link
CLOCKS
FLEX CLOCKS
MEMORY
Total device
20090512
add double mosfet prevent
ATI M92 electric leakage
No support iAMT
*PCIE REQ power rail:
suspend: 0 3 4 5 6 7
core: 1 2
If use extenal CLK gen, please place close to CLK gen else, please place close to PCH
close to YH2
close to RH270
Reserve for EMI please close to UH1
BD82HM77 QPRG C1 BGA 989P PCH
Security Classification
Compal Secret Data
Issued Date
2012/01/17
Deciphered Date
2013/01/16
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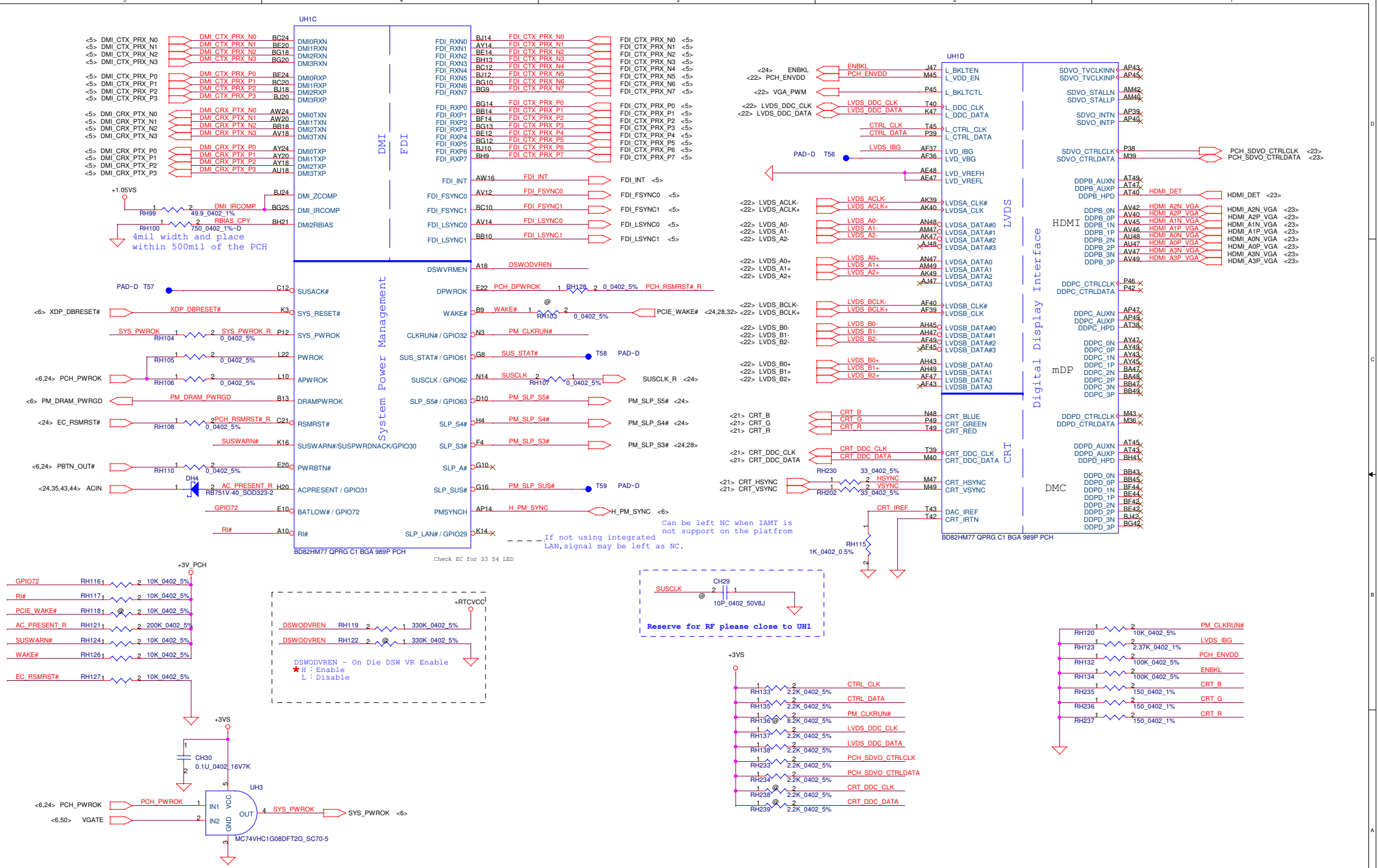
Compal Electronics, Inc.
Title
PCH (2/8) PCIE, SMBUS, CLK
Size
Document Number
LA-8241P
Rev
1.0
Date: Wednesday, February 01, 2012
Sheet 14 of 56



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Issued Date	2012/01/17	Deciphered Date	2013/01/16

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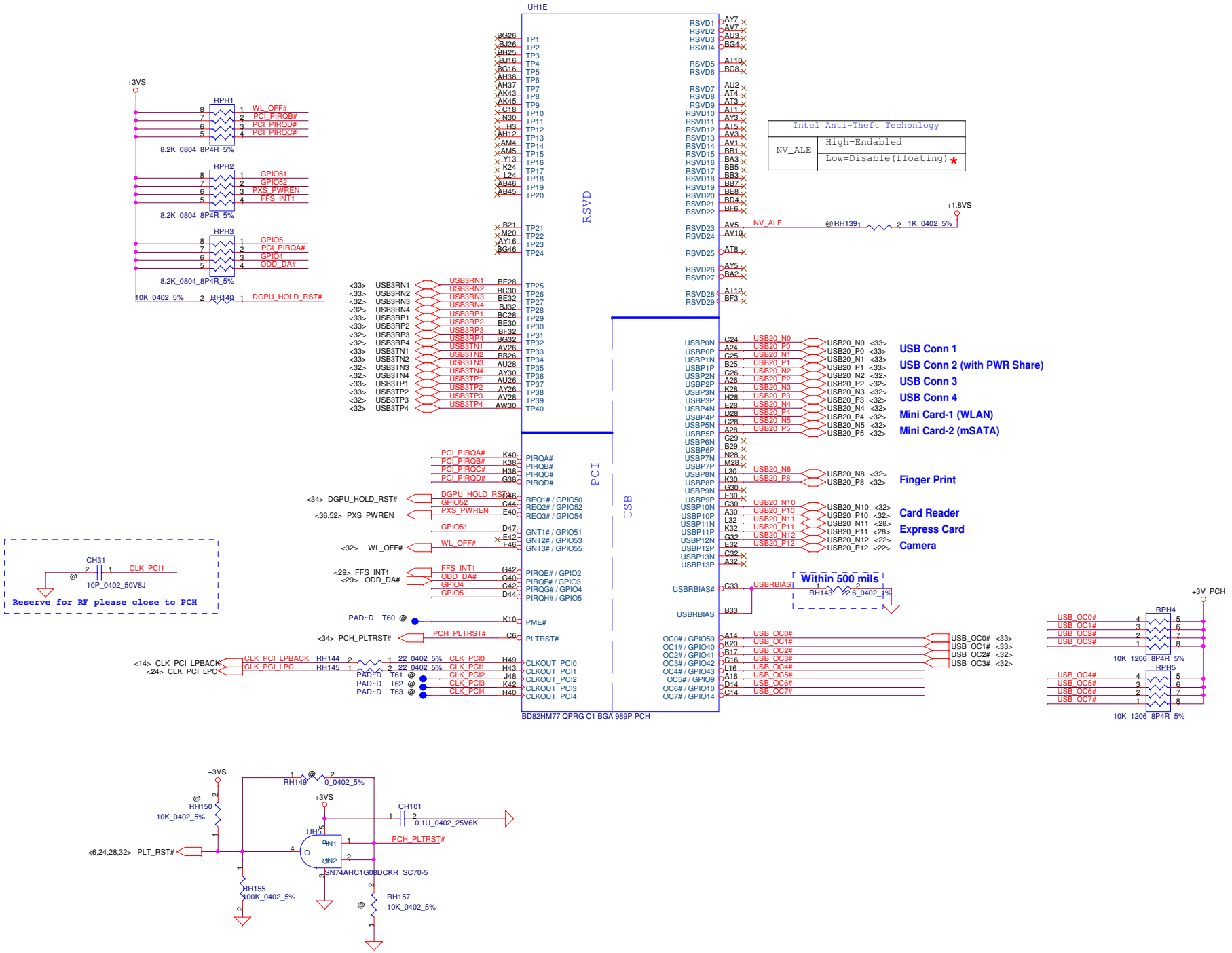
Compal Electronics, Inc.

Title: **PCH (3/8) DMI,FDI,PM,GFX,DP**

Size	Document Number	Rev
	LA-8241P	1.0

Date: Wednesday, February 01, 2012 | Sheet 15 of 56

Compal Electronics, Inc



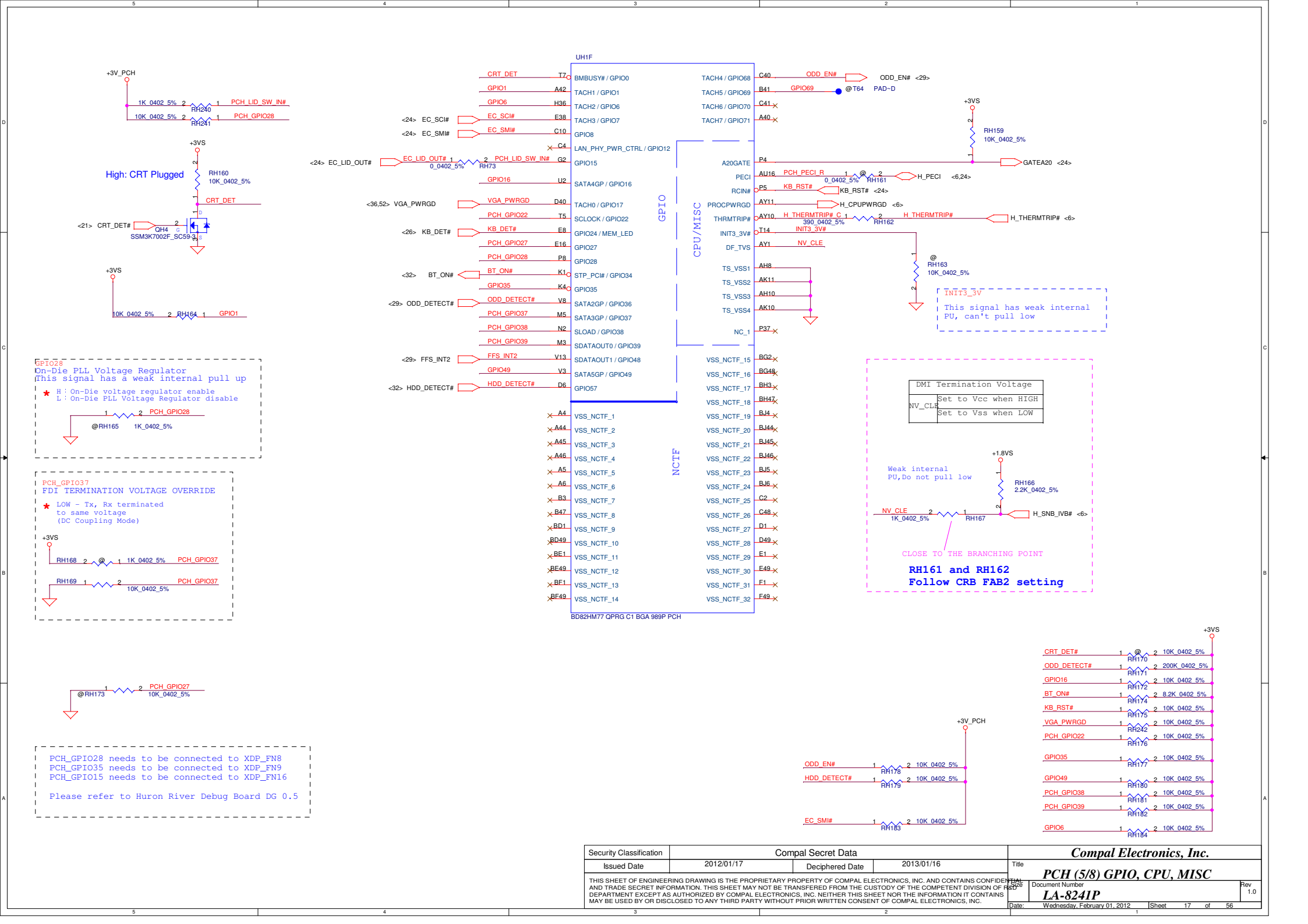
Security Classification	Compal Secret Data		
Issued Date	2012/01/17	Deciphered Date	2013/01/16

Compal Electronics, Inc.

Title: PCH (4/8) PCI, USB, NVRAM

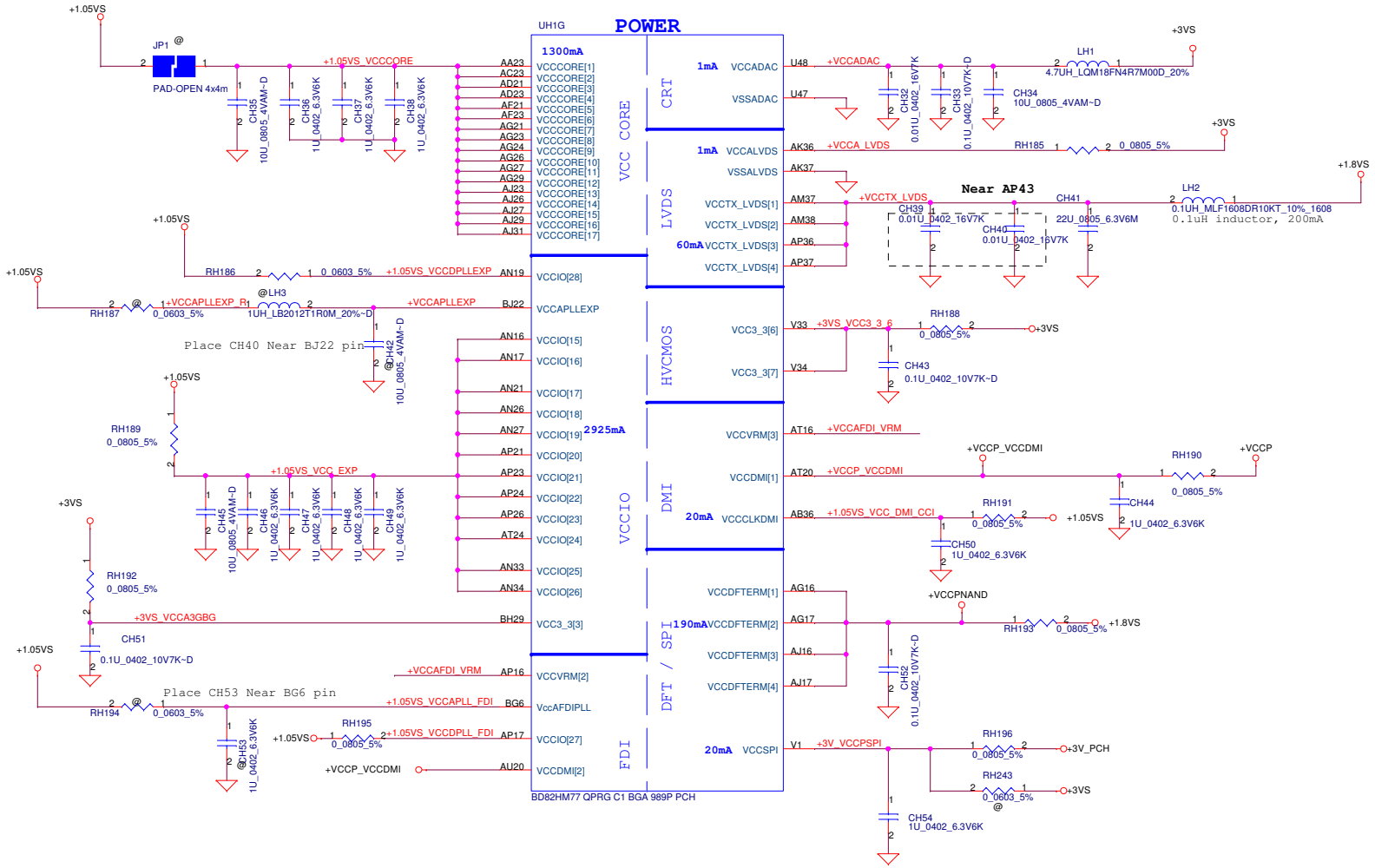
Size: | Document Number: LA-8241P | Rev: 1.0

Date: Wednesday, February 01, 2012 | Sheet 16 of 56



Security Classification	Compal Secret Data		
Issued Date	2012/01/17	Deciphered Date	2013/01/16

Compal Electronics, Inc.			
Title	PCH (5/8) GPIO, CPU, MISC		
Size	Document Number	LA-8241P	Rev 1.0
Date:	Wednesday, February 01, 2012	Sheet 17 of 56	



PCH Power Rail Table

Voltage Rail	Voltage	S0 Iccmax Current (A)
V_PROC_IO	1.05	0.001
V5REF	5	0.001
V5REF_Sus	5	0.001
Vcc3_3	3.3	0.266
VccADAC	3.3	0.001
VccADPLLA	1.05	0.08
VccADPLLB	1.05	0.08
VccCore	1.05	1.3
VccDMI	1.05	0.042
VccIO	1.05	2.925
VccASW	1.05	1.01
VccSPI	3.3	0.02
VccDSW	3.3	0.003
VccpNAND	1.8	0.19
VccRTC	3.3	6 uA
VccSus3_3	3.3	0.119
VccSusHDA	3.3 / 1.5	0.01
VccVRM	1.8 / 1.5	0.16
VccCLKDMI	1.05	0.02
VccSSC	1.05	0.095
VccDIFFCLKN	1.05	0.055
VccALVDS	3.3	0.001
VccTX_LVDS	1.8	0.06

Security Classification	Compal Secret Data		
Issued Date	2012/01/17	Deciphered Date	2013/01/16

Compal Electronics, Inc.

Title: PCH (6/8) PWR

Size | Document Number: LA-8241P | Rev: 1.0

Date: Wednesday, February 01, 2012 | Sheet 18 of 56

VCC3_3 = 266mA detal waiting for newest spec

VCCDMI = 42mA detal waiting for newest spec

UH1J

POWER

BD82HM77 QPRG C1 BGA 989P PCH

USB

Clock and Miscellaneous

PCI/GPIO/LPC

SATA

CPU

MISC

RTC

HDA

If it support 3.3V audio signals
POP:RH244
Depop RH245 / RH246

If it support 1.5V audio signals
POP:RH245 / RH246
Depop R244

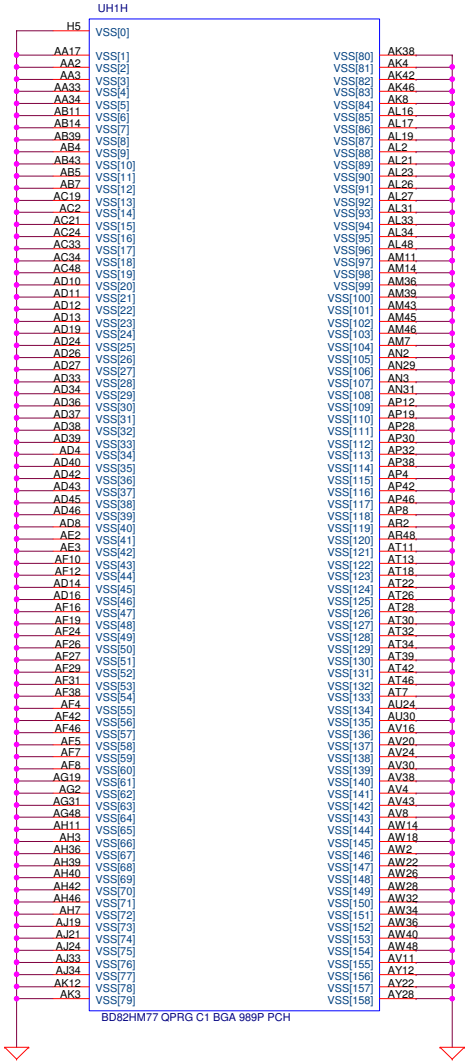
Security Classification	Compal Secret Data		
Issued Date	2012/01/17	Deciphered Date	2013/01/16

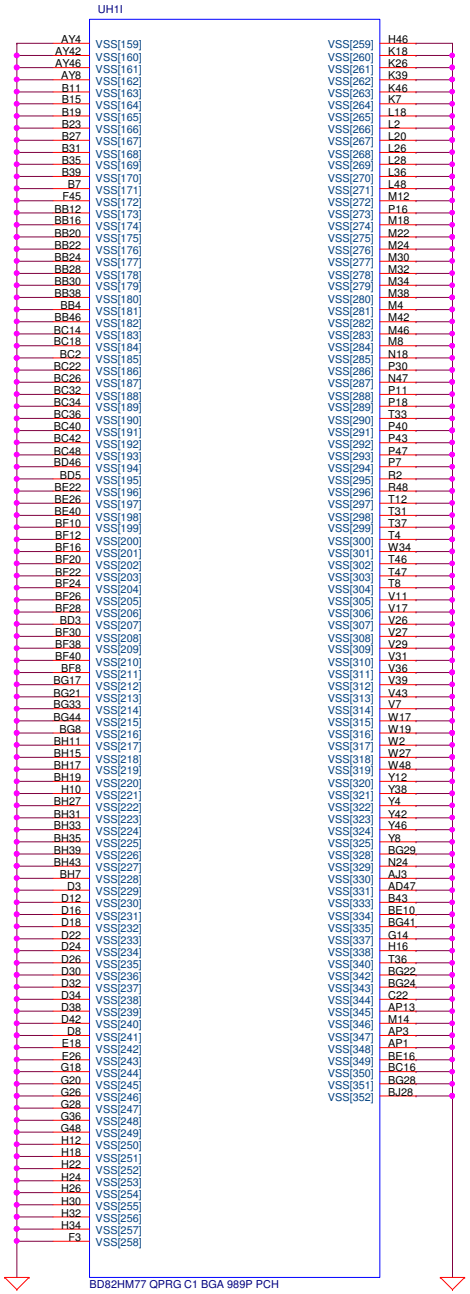
Compal Electronics, Inc.

Title: PCH (7/8) PWR

Size: | Document Number: LA-8241P | Rev: 1.0

Date: Wednesday, February 01, 2012 | Sheet 19 of 56





Security Classification	Compal Secret Data		
Issued Date	2012/01/17	Deciphered Date	2013/01/16

Compal Electronics, Inc.

Title: **PCH (8/8) VSS**

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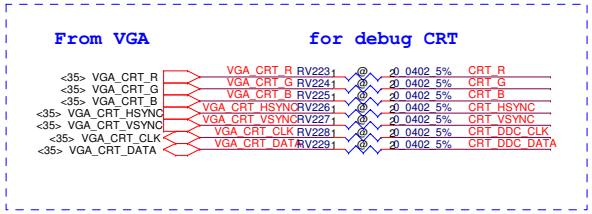
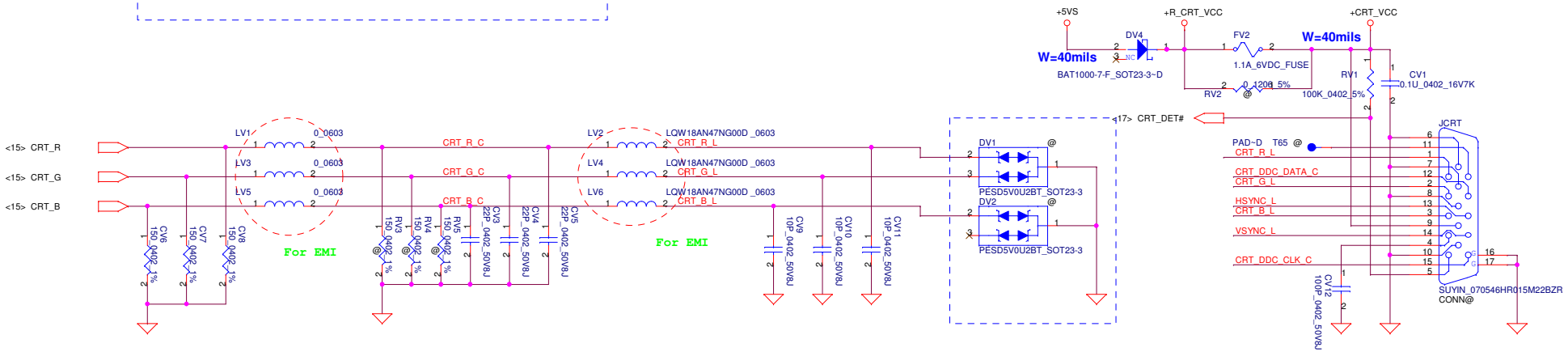
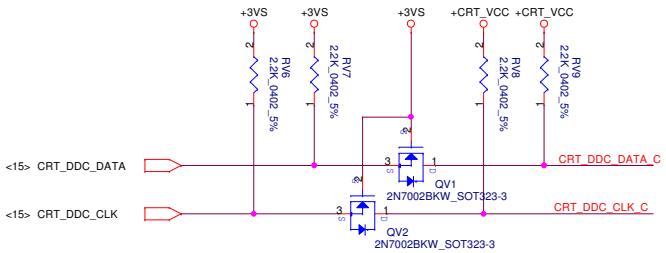
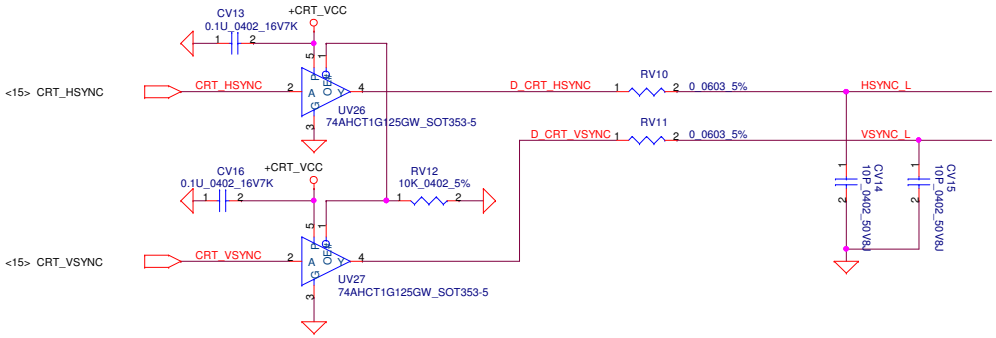
C R T









Security Classification	Compal Secret Data		
Issued Date	2012/01/17	Deciphered Date	2013/01/16

Compal Electronics, Inc.	
Title	VGA / LVDS /camera conn.
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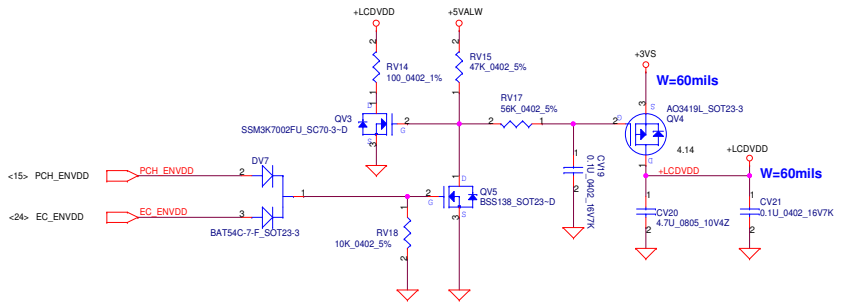
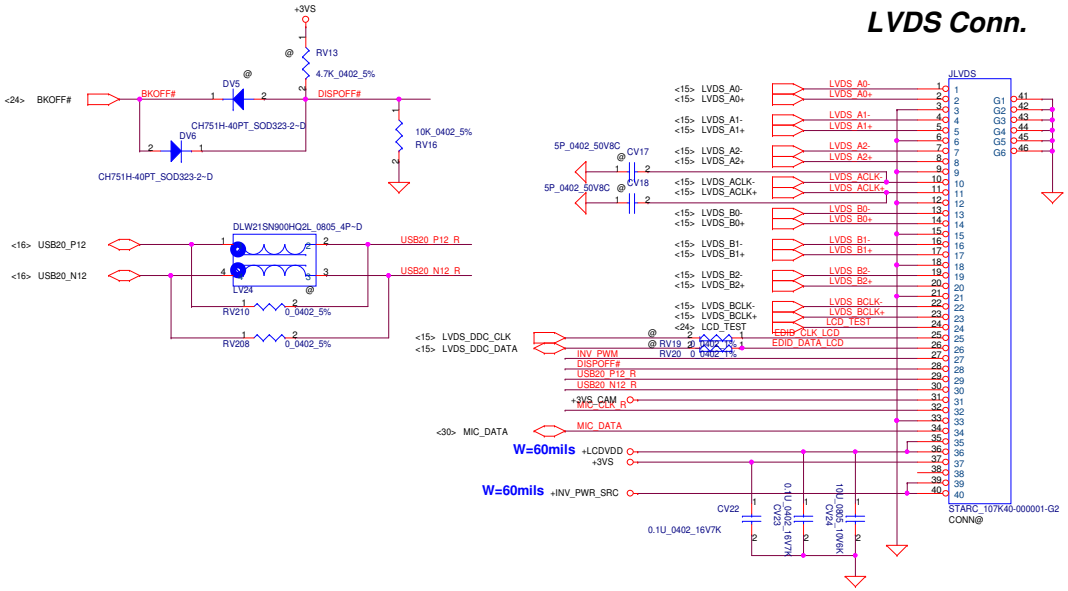
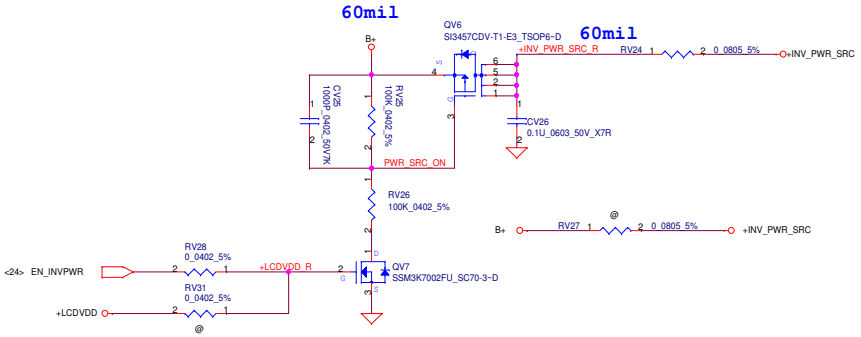
LCD PWR CTRL



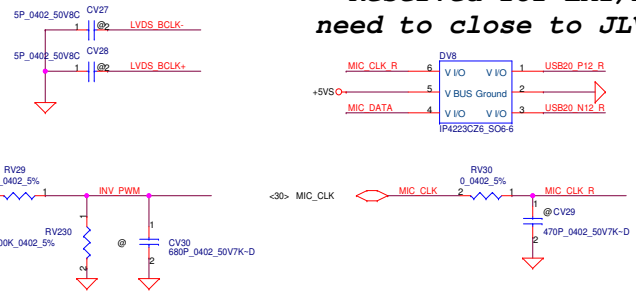
LVDS Conn.



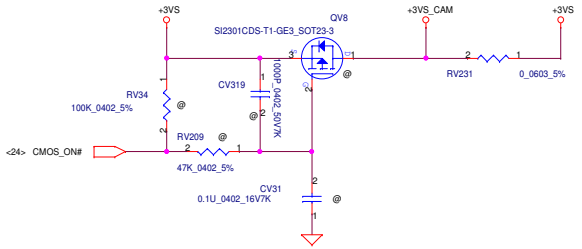
LCD backlight PWR CTRL



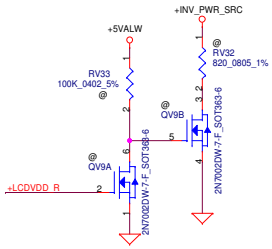
* Reserved for EMI/ESD/RF need to close to JLVDS



Wedcam PWR CTRL



* Reserved for LCD sequence tuning



Security Classification	Compal Secret Data		
Issued Date	2012/01/17	Deciphered Date	2013/01/16

Compal Electronics, Inc.			
Title	LVDS /camera conn.		
Size	Document Number		Rev
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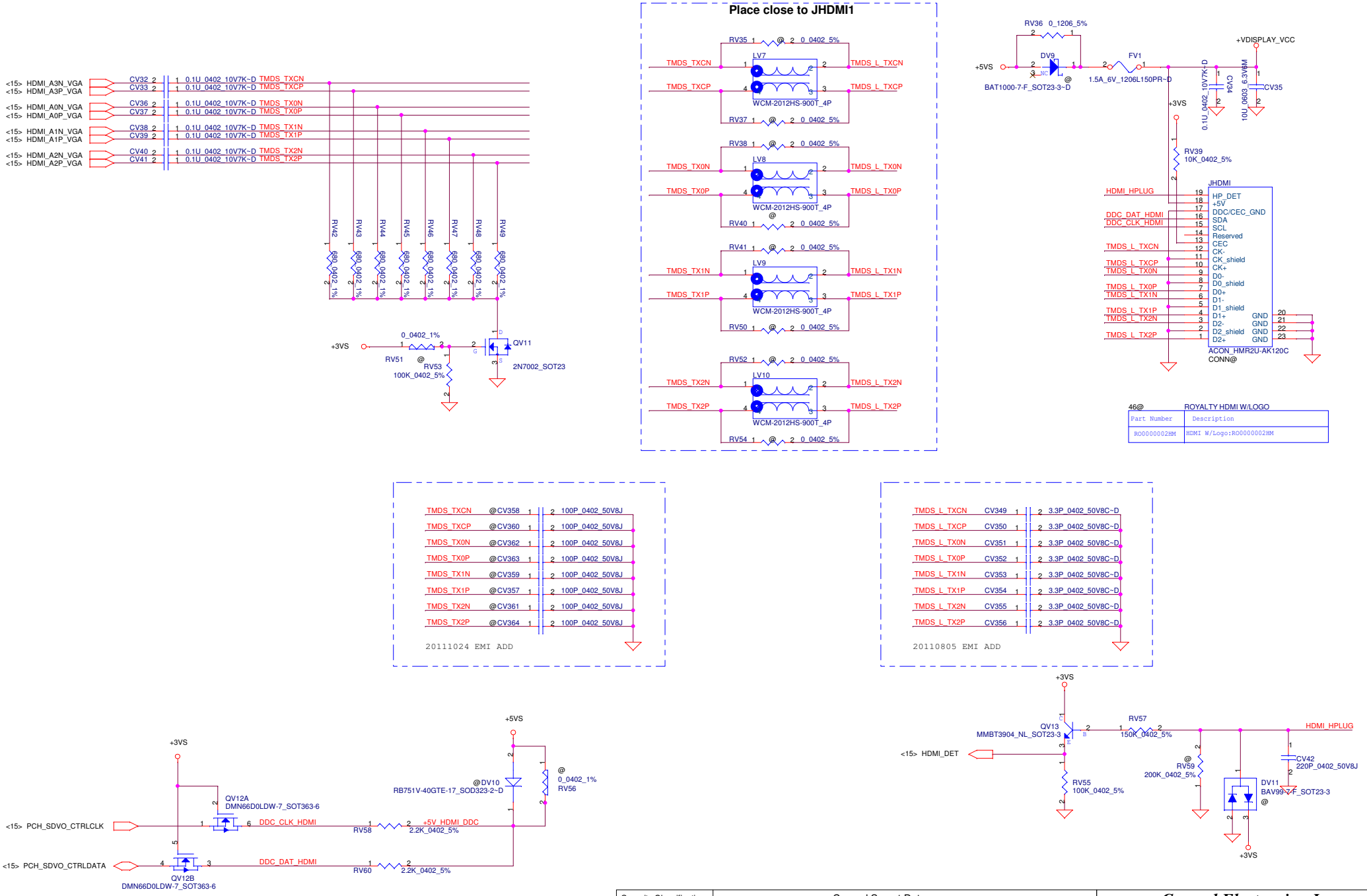

Security Classification	Compal Secret Data		
Issued Date	2012/01/17	Deciphered Date	2013/01/16

Compal Electronics, Inc.

Title: HDMI

Size	Document Number	Rev
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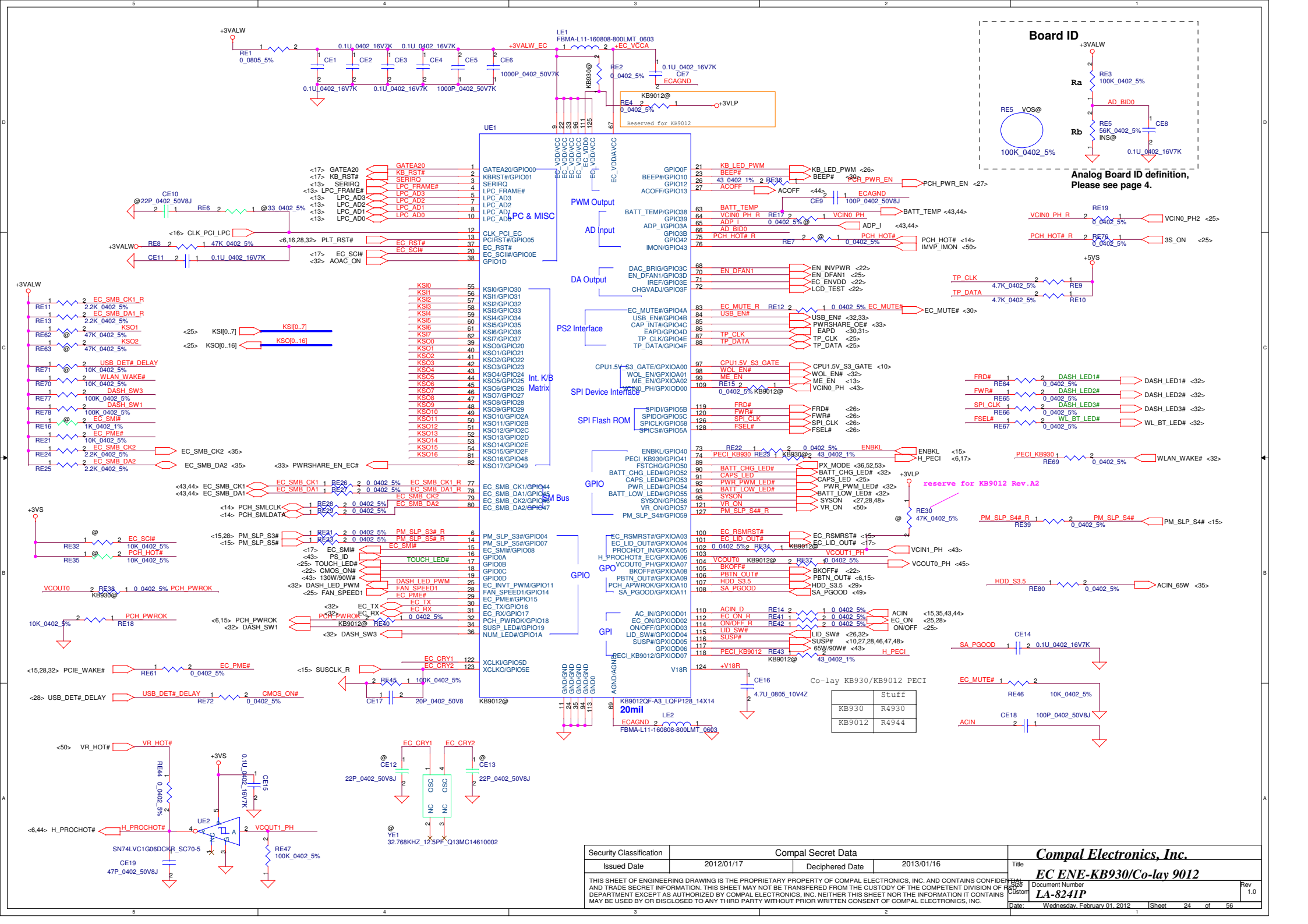
Board ID
Analog Board ID definition,
Please see page 4.
Reserved for KB9012
reserve for KB9012 Rev.A2
Co-lay KB930/KB9012 PECI
Stuff
KB930 R4930
KB9012 R4944
20mil
KB9012QF-A3_LQFP128_14X14
Compal Secret Data
Issued Date 2012/01/17
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Compal Electronics, Inc.
EC ENE-KB930/Co-lay 9012
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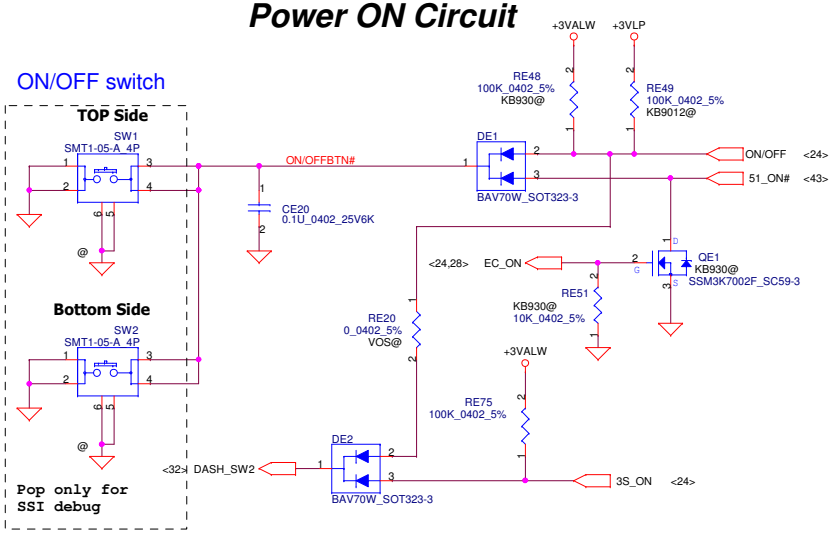
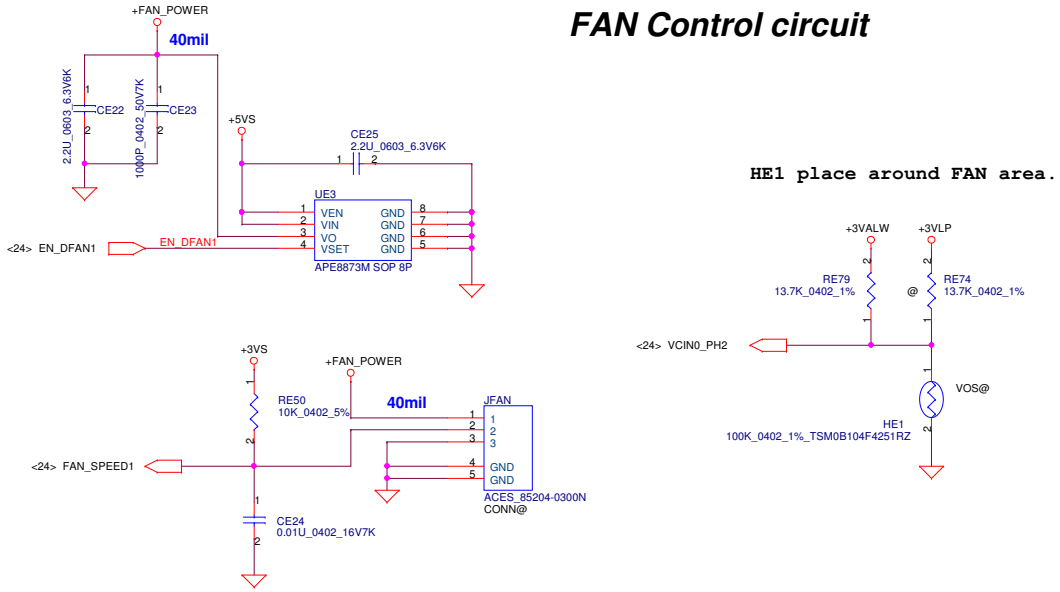
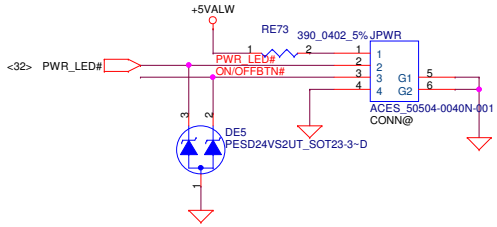
Power ON Circuit



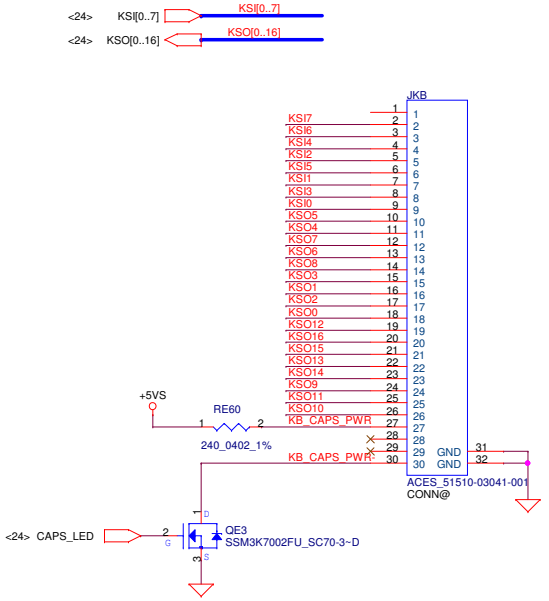
FAN Control circuit



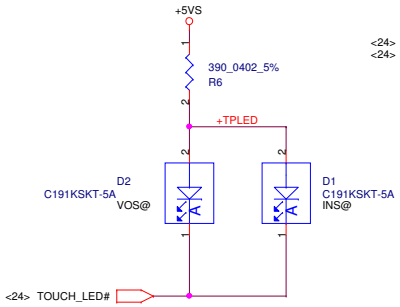
To POWER/B



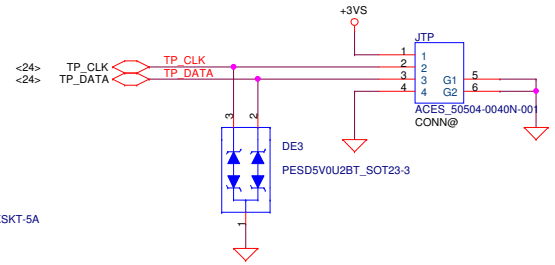
INT_KBD Conn.



Touch Pad LED



Touch pad



Security Classification	Compal Secret Data		
Issued Date	2012/01/17	Deciphered Date	2013/01/16

Compal Electronics, Inc.			
Title	SW/TP/SCREW		
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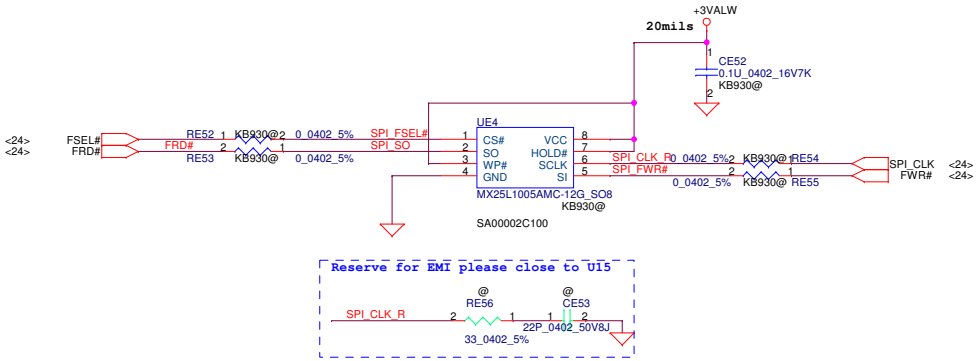
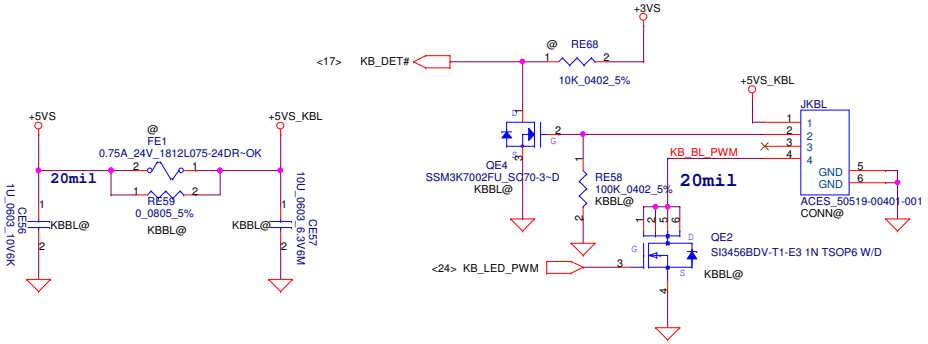
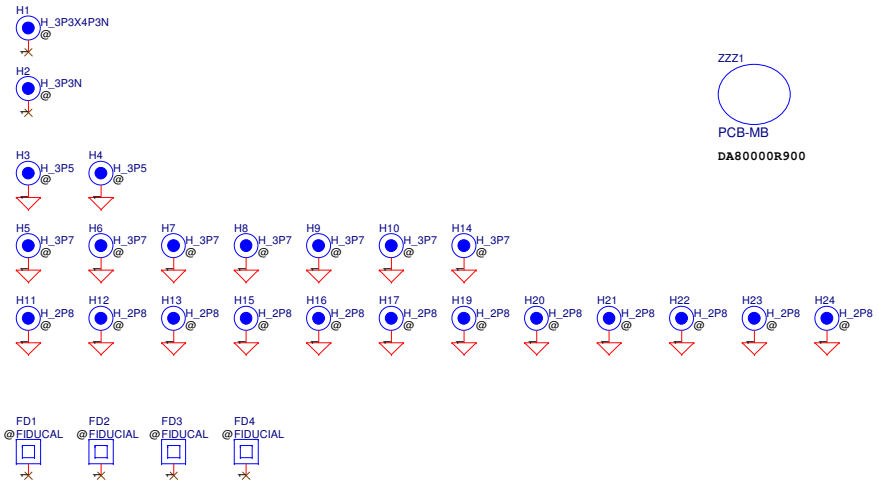
SPI ROM 128KB



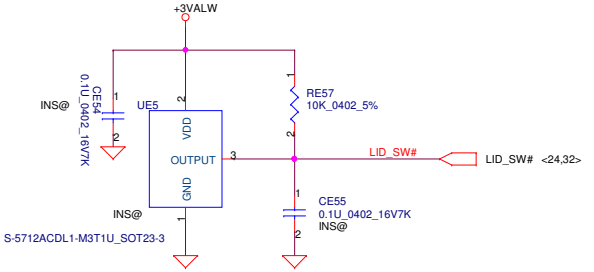
Keyboard back light



Screw Hole



Lid Switch



Security Classification	Compal Secret Data		
Issued Date	2012/01/17	Deciphered Date	2013/01/16

Compal Electronics, Inc.			
Title: CONN & LID			
Size	Document Number: LA-8241P		Rev: 1.0
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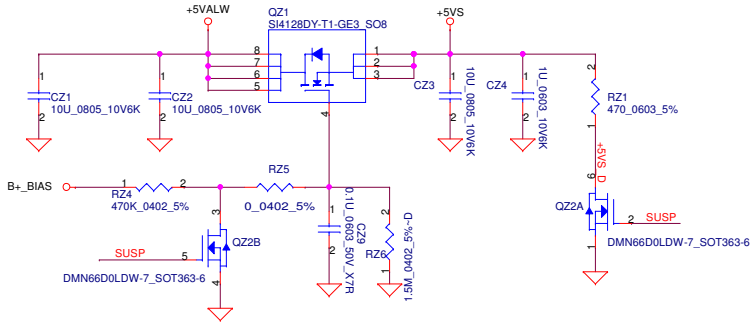
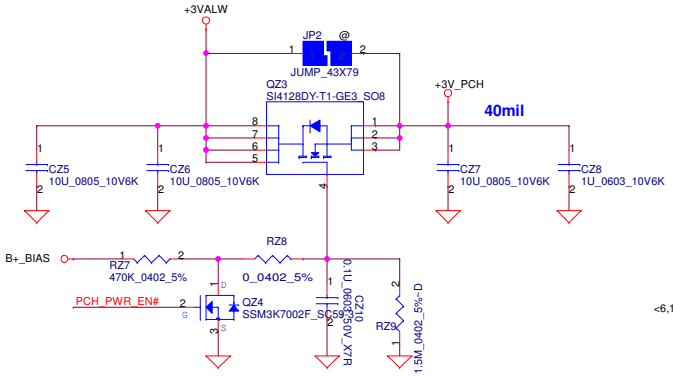
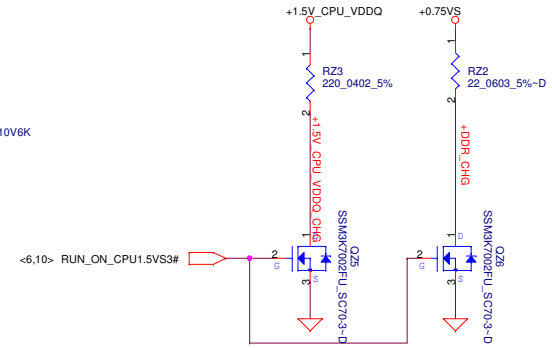
+5VALW to +5VS

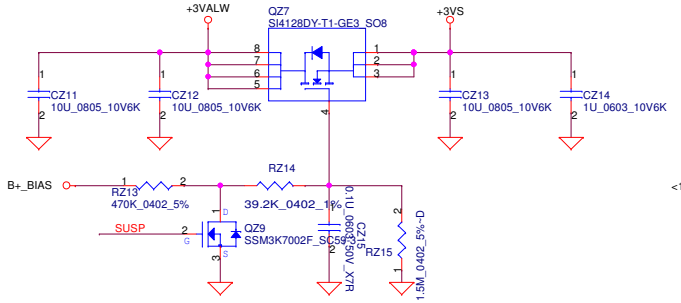


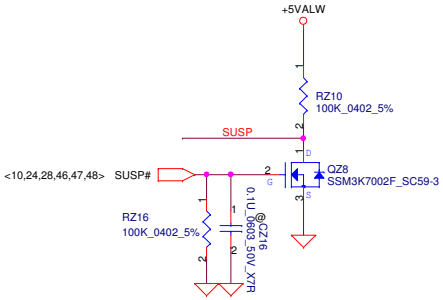
+3VALW to +3V_PCH

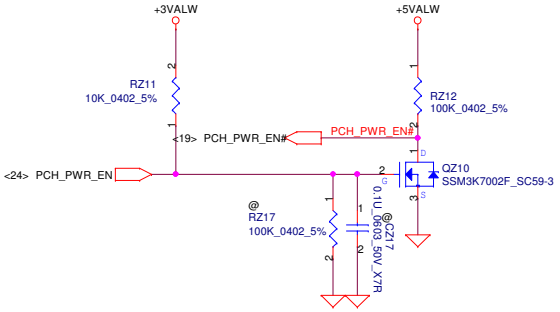




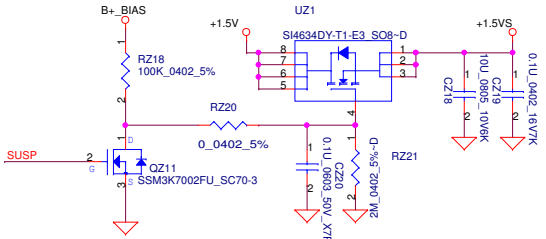
+3VALW to +3VS

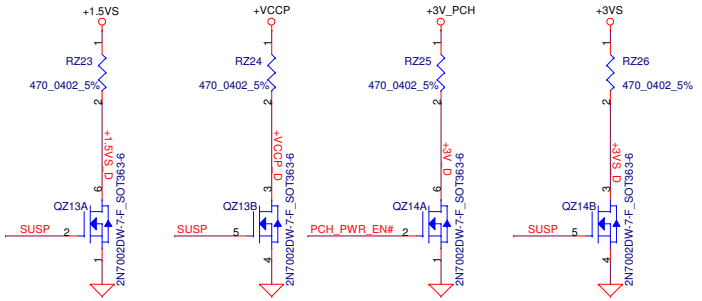


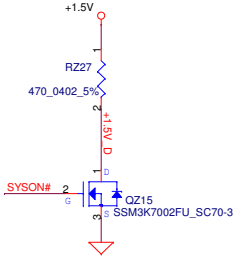


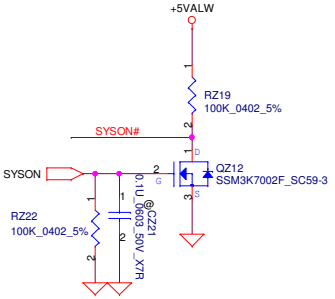


+1.5V To +1.5VS









Security Classification	Compal Secret Data		
Issued Date	2012/01/17	Deciphered Date	2013/01/16

Compal Electronics, Inc.

Title: DC/DC Interface

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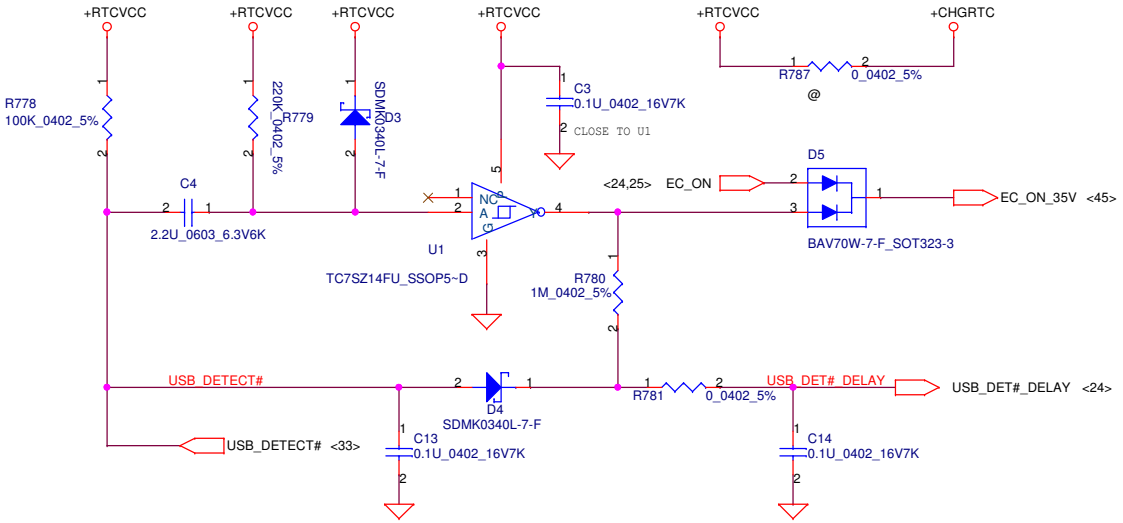
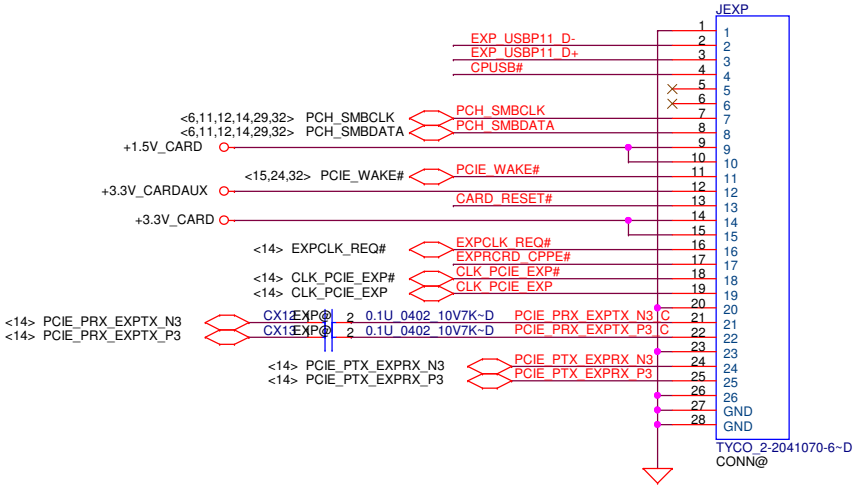
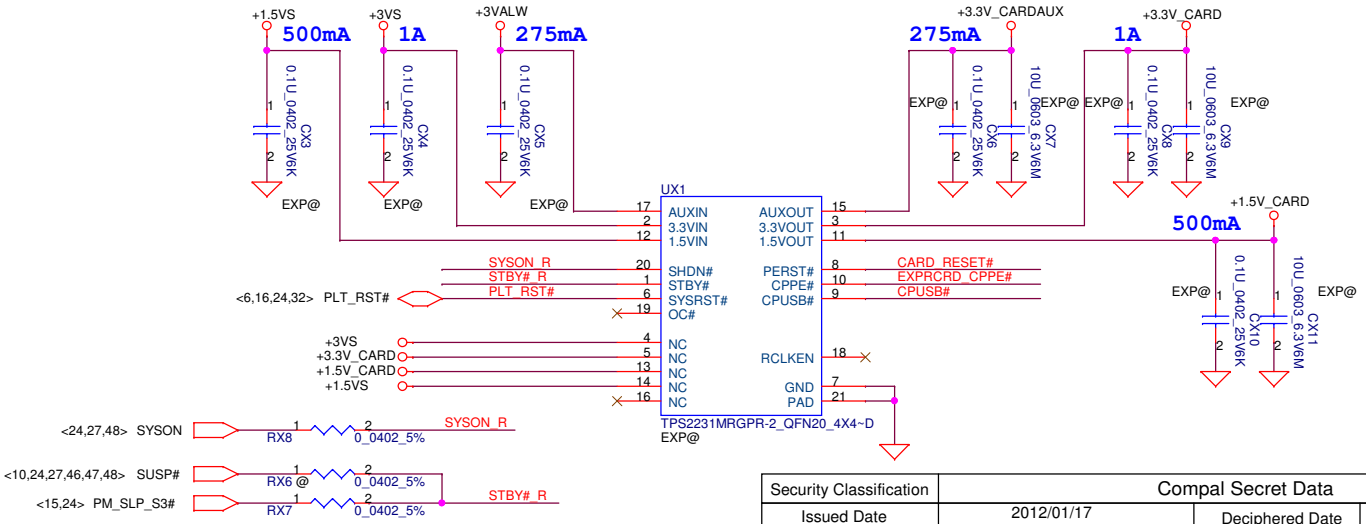
USB Detected for PWR Share

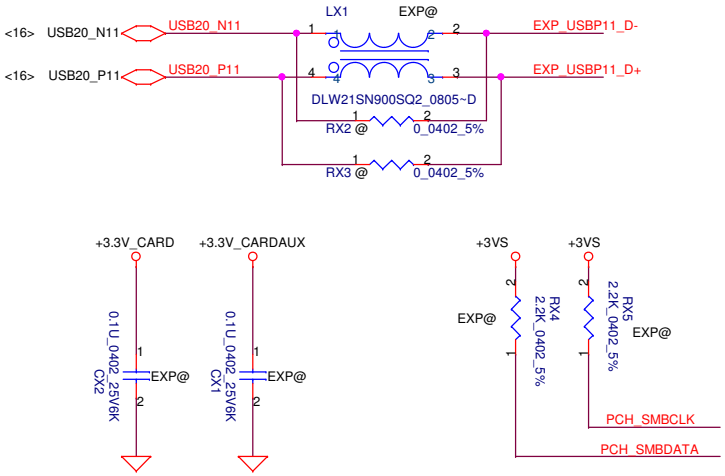


Express Card



Express Card PWR S/W





Security Classification	Compal Secret Data		
Issued Date	2012/01/17	Deciphered Date	2013/01/16

Compal Electronics, Inc.

Title: PROCESSOR(1/6) DMI,FDI,PEG

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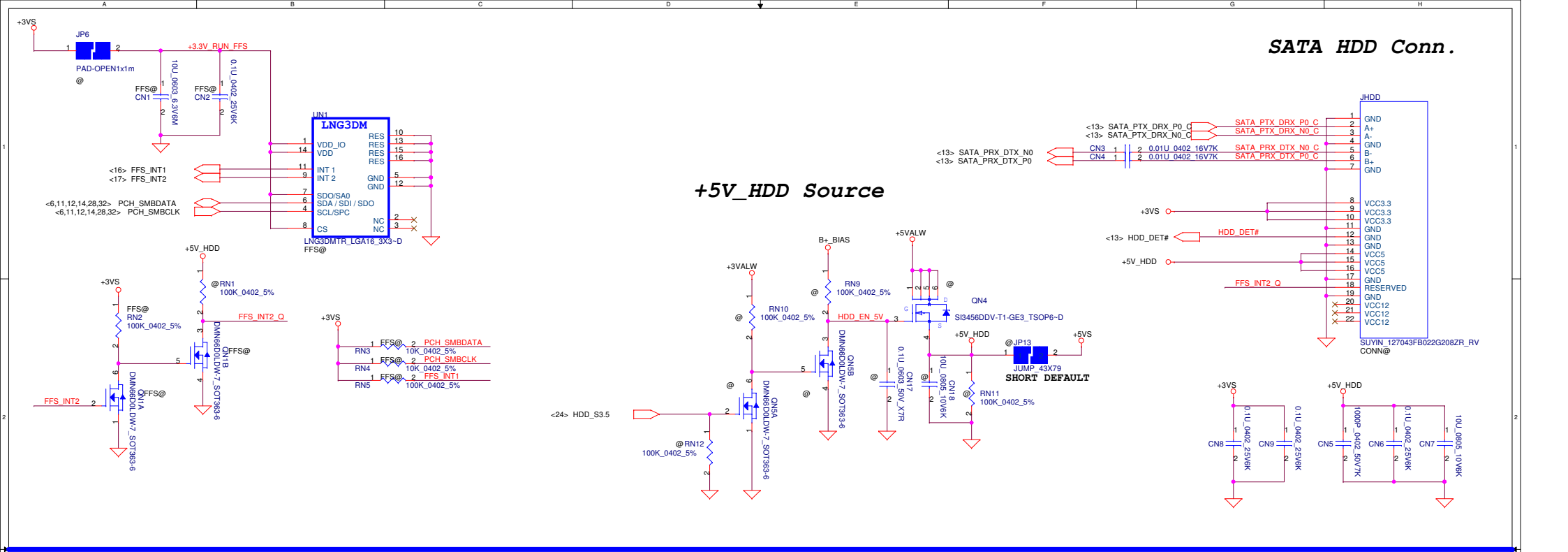

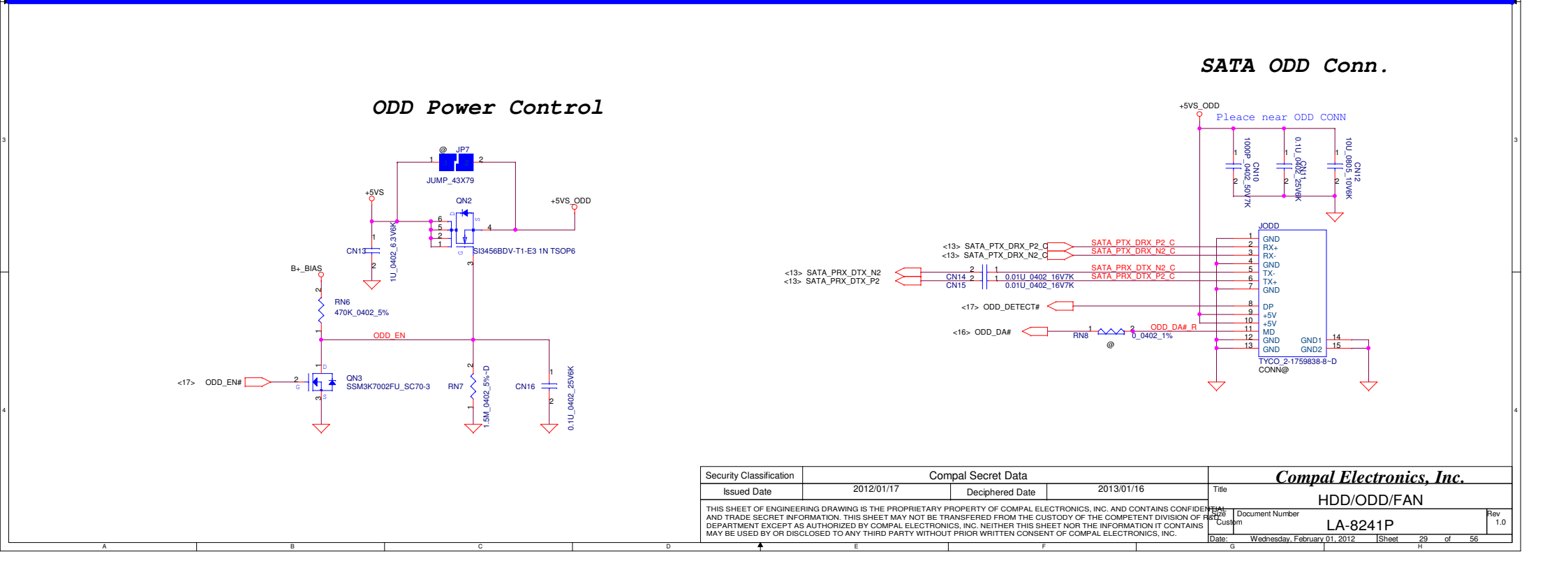

Security Classification	Compal Secret Data		
Issued Date	2012/01/17	Deciphered Date	2013/01/16

Compal Electronics, Inc.

Title: HDD/ODD/FAN

Size: Custom | Document Number: LA-8241P | Rev: 1.0

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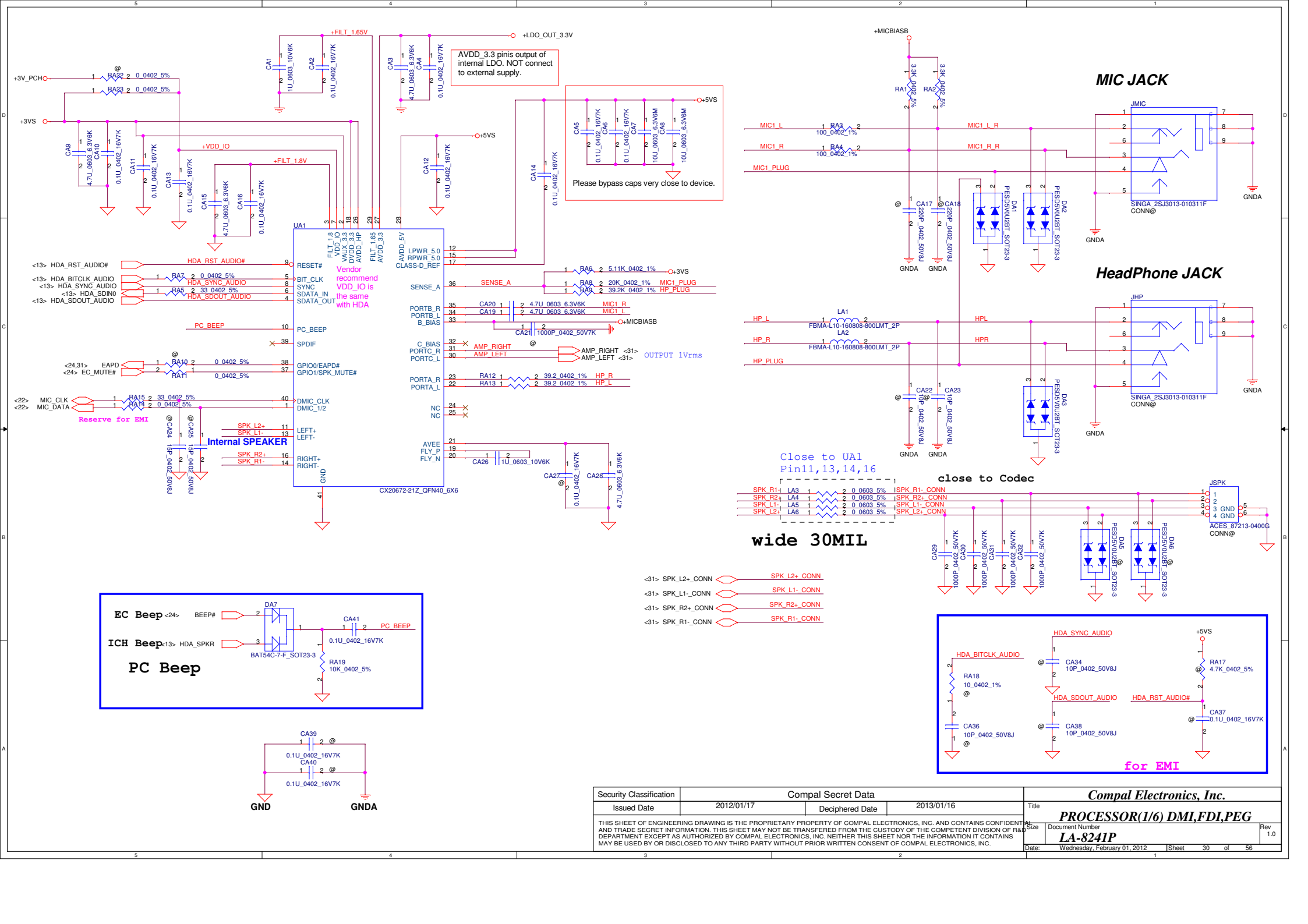

Security Classification	Compal Secret Data		
Issued Date	2012/01/17	Deciphered Date	2013/01/16

Compal Electronics, Inc.	
Title	PROCESSOR(1/6) DMI,FDI,PEG
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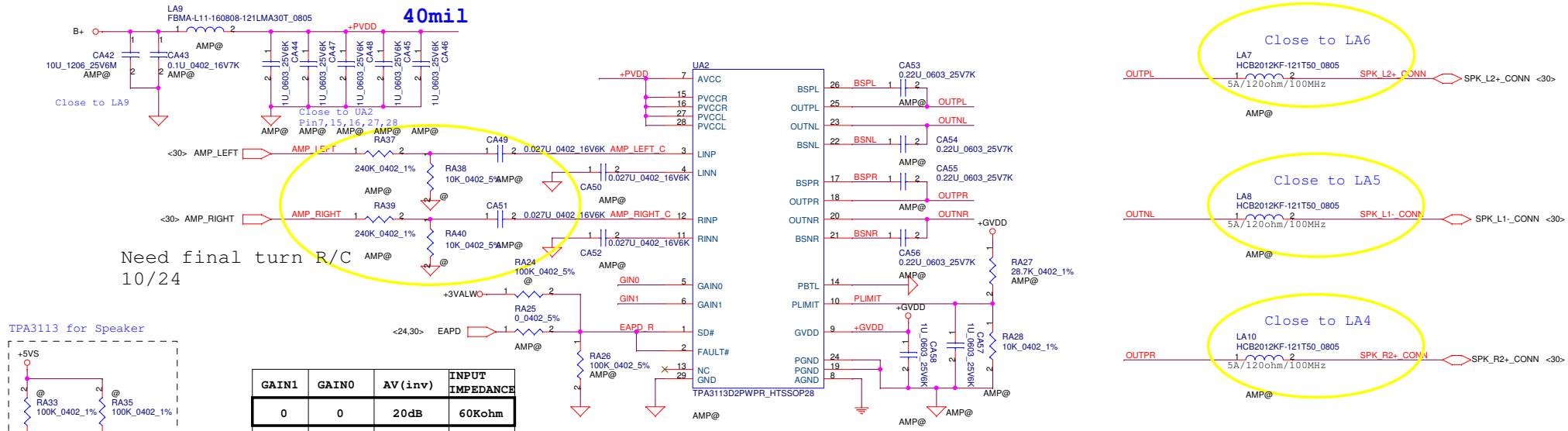
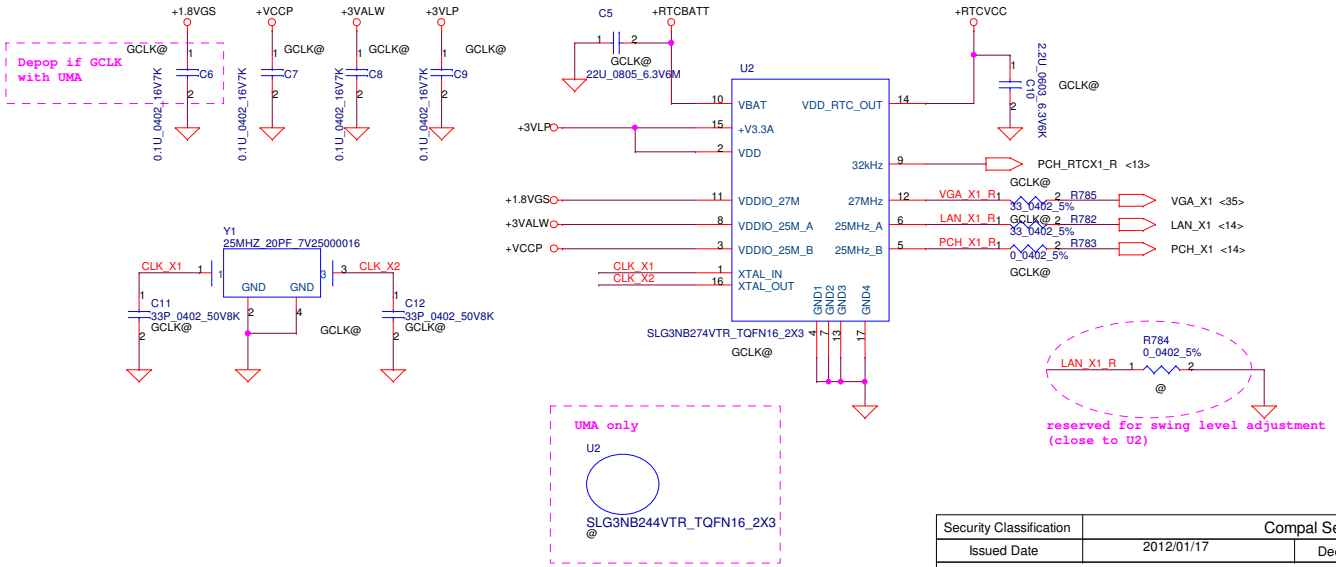


GAIN1	GAIN0	AV(inv)	INPUT IMPEDANCE
0	0	20dB	60Kohm
0	1	26dB	30Kohm
1	0	32dB	15Kohm
1	1	36dB	9Kohm



Security Classification	Compal Secret Data		
Issued Date	2012/01/17	Deciphered Date	2013/01/16

Compal Electronics, Inc.

Title: AMP

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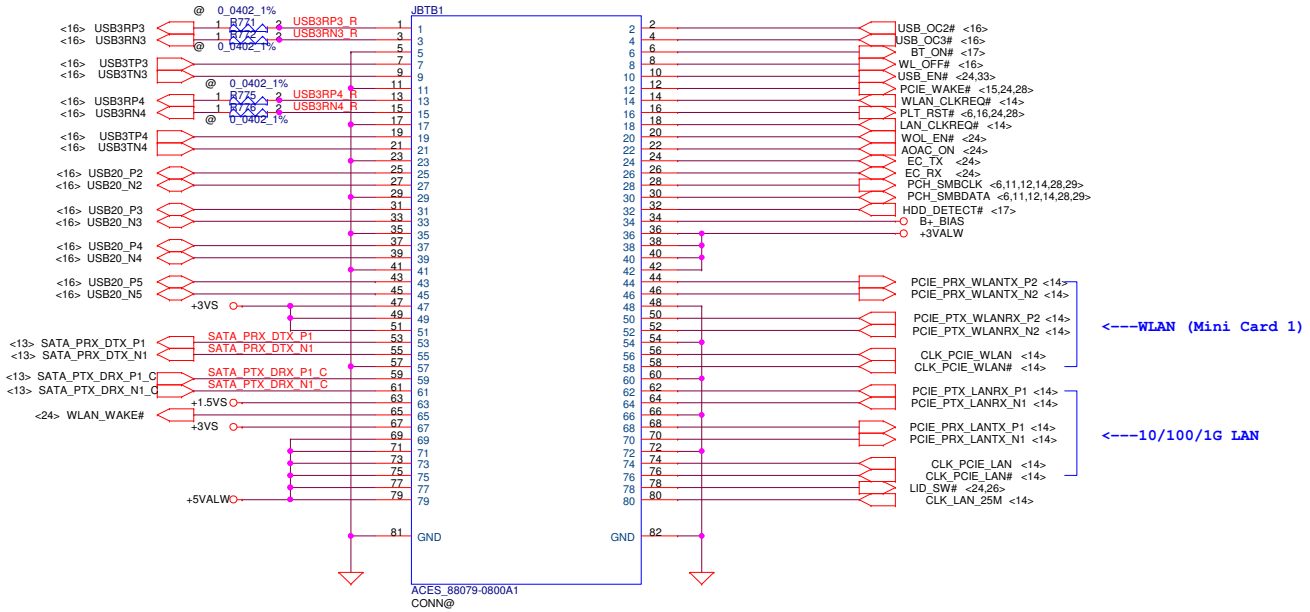
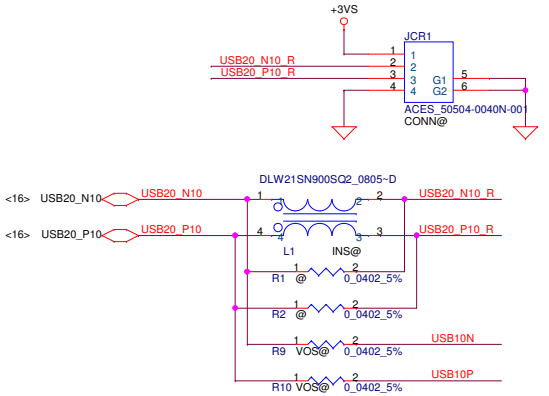


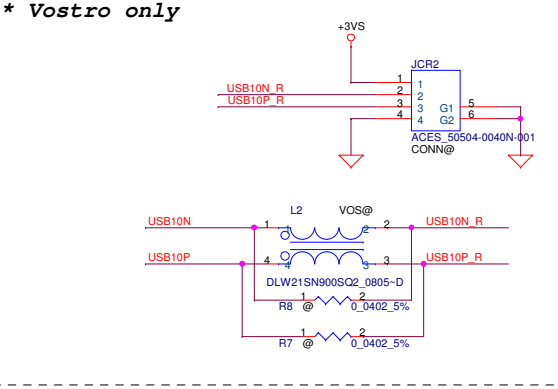
To CardReader/B

*** Inspiron only**

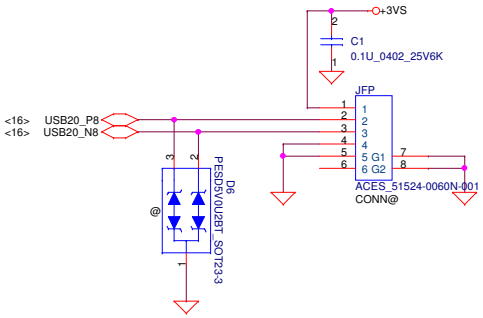


To CardReader/B

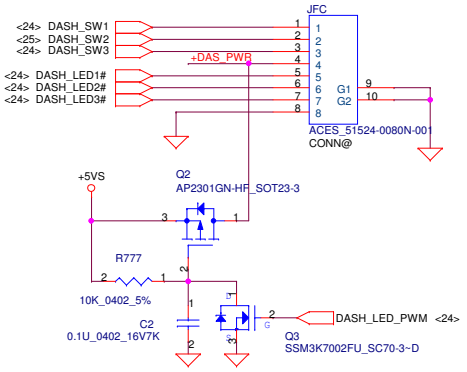
*** Vostro only**



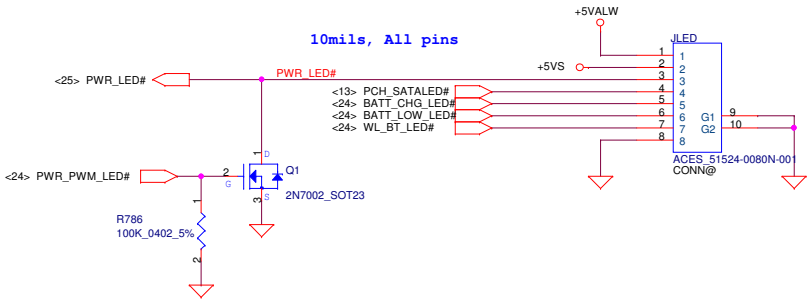
To Finger Print

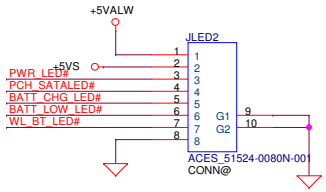


TO Function/B



To LED/B





Security Classification	Compal Secret Data		
Issued Date	2012/01/17	Deciphered Date	2013/01/16

Compal Electronics, Inc.

Title: PROCESSOR(1/6) DMI,FDI,PEG

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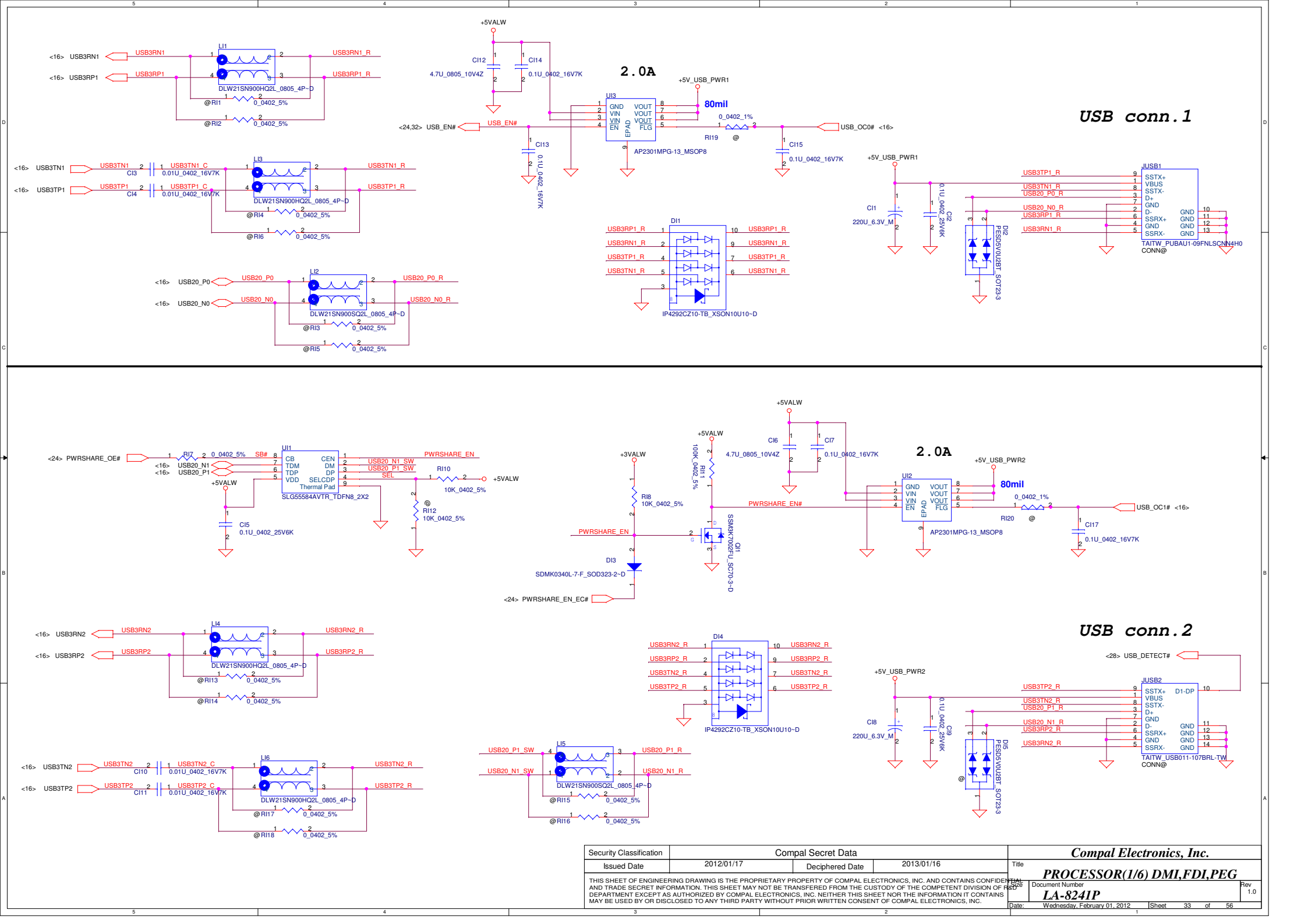

Security Classification	Compal Secret Data		
Issued Date	2012/01/17	Deciphered Date	2013/01/16

Compal Electronics, Inc.

Title: PROCESSOR(1/6) DMI,FDI,PEG

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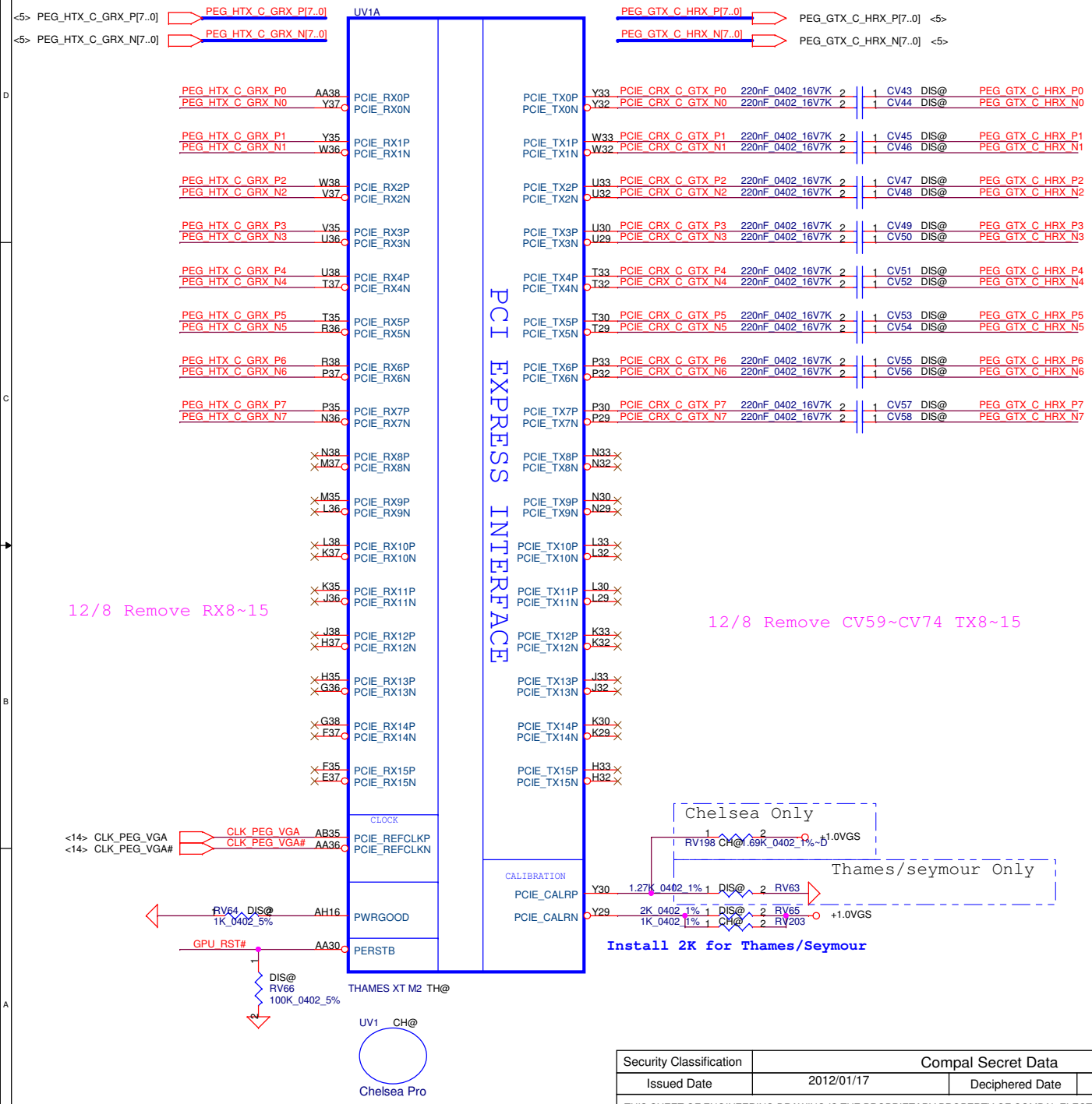
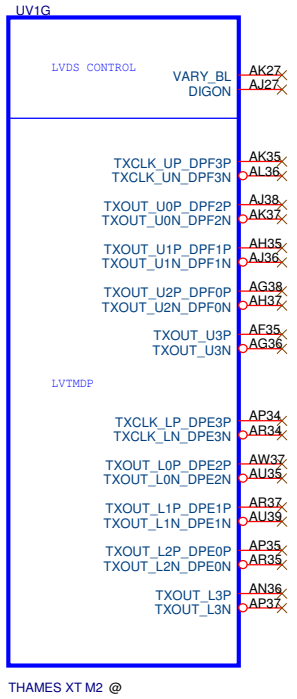
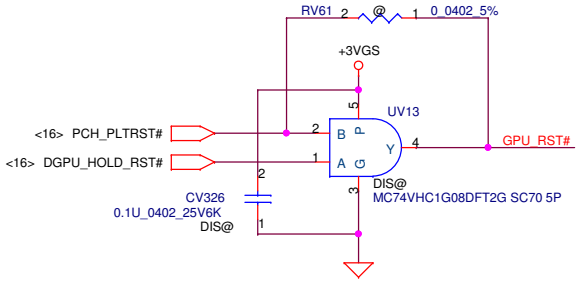
GFX PCIE LANE REVERSAL



LVDS Interface





Security Classification	Compal Secret Data		
Issued Date	2012/01/17	Deciphered Date	2013/01/16

Compal Electronics, Inc.

Title: ATI_SeymourXT_M2_PCIE/LVDS

Size: Custom | Document Number: LA-8241P | Rev: 1.0

Date: Wednesday, February 01, 2012 | Sheet 34 of 56

CONFIGURATION STRAPS

ALLOW FOR PULLUP PADS FOR THESE STRAPS AND IF THESE GPIOS ARE USED, THEY MUST NOT CONFLICT DURING RESET

RECOMMENDED SETTINGS
0= DO NOT INSTALL RESISTOR
1 = INSTALL 10K RESISTOR
X = DESIGN DEPENDANT
NA = NOT APPLICABLE

STRAPS	PIN	DESCRIPTION OF DEFAULT SETTINGS	RECOMMENDED SETTINGS
TX_PWRS_ENB	GPIO0	PCIE FULL TX OUTPUT SWING 0: 50% swing 1: Full swing	X
TX_DEEMPH_EN	GPIO1	PCIE TRANSMITTER DE-EMPHASIS 0: disable 1: enable	X
RSVD	GPIO2	Advertises PCIE speed when compliance test 0: 2.5GT/s 1: 5GT/s	0
RSVD	GPIO8	RESERVED	0
BIF_VGA DIS	GPIO9	VGA ENABLED	0
RSVD	GPIO21	RESERVED	0
BIOS_ROM_EN	GPIO_22_ROMCSB	ENABLE EXTERNAL BIOS ROM 0: disable 1: enable	X
ROMIDCFG(2:0)	GPIO[13:11]	SERIAL ROM TYPE OR MEMORY APERTURE SIZE SELECT	XXX
VIP_DEVICE_STRAP_ENA	V2SYNC	IGNORE VIP DEVICE STRAPS	0
RSVD	H2SYNC		0
RSVD	GENERICC		0
AUD[1] AUD[0]	HSYNC VSYNC	AUD[1] AUD[0]: 0 0 No audio function; 0 1 Audio for DisplayPort and HDMI if dongle is detected; 1 0 Audio for DisplayPort only; 1 1 Audio for both DisplayPort and HDMI	11

AMD RESERVED CONFIGURATION STRAPS

ALLOW FOR PULLUP PADS FOR THESE STRAPS BUT DO NOT INSTALL RESISTOR. IF THESE GPIOS ARE USED, THEY MUST KEEP "LOW" AND NOT CONFLICT DURING RESET

GPIO21	H2SYNC	GENERICC	GPIO2	GPIO8

	TX_PWRS_ENB	GPIO0	Transmitter Power Saving Enable 0: 50% Tx output swing for mobile mode 1: full Tx output swing (Default setting for Desktop)
	TX_DEEMPH_EN	GPIO1	PCI Express Transmitter De-emphasis Enable 0: Tx de-emphasis diabled for mobile mode 1: Tx de-emphasis enabled (Defailt setting for desktop)

Vendor	VRAM_ID0	VRAM_ID1	VRAM_ID2	
64MX16 (1G) Hynix 1GB PN:SA000041S3L	RV67 1	RV70 0	RV72 0	PT
64MX16 (1G) Samsung 1GB PN:SA00004GS1L	RV68 0	RV69 1	RV72 0	PT
128M16 (2G) Samsung 2GB PN:SA00003YQ1L	RV67 1	RV70 0	RV71 1	
128M16 (2G) Samsung 2GB PN:SA000047Q1L	RV68 0	RV69 1	RV71 1	
64MX16 (1G) Micron 1GB PN:SA00004Y20L	RV67 1	RV69 1	RV71 1	PT

Not share via for other GND

Reserved test pad of CRT Signals for debug

Add 12/6 for MLPS

Add 12/8

NC_TSVSSQ should be tied to GND on Thames/Seymour

Reserved test pad of CRT Signals for debug

Add 12/6 for MLPS

12/8 Add external thermal sensor BOM

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Issued Date	2012/01/17	Deciphered Date 2013/01/16

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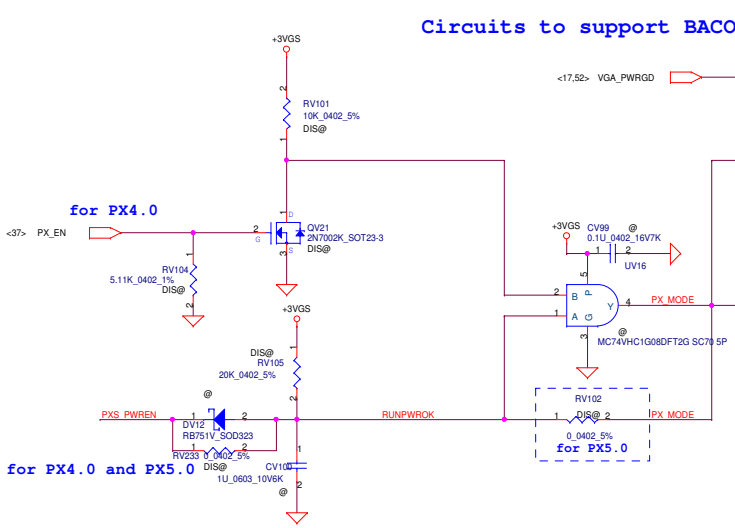
Compal Electronics, Inc.

Title: ATI_SeymourXT_M2_Main_MSIC

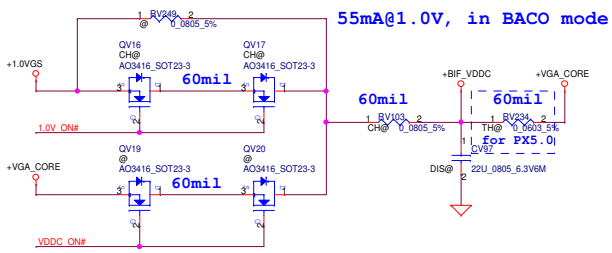
Size: Custom | Document Number: LA-8241P | Rev: 1.0

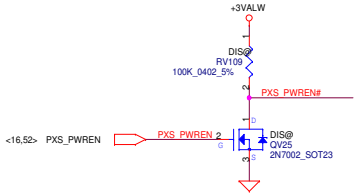
Date: Wednesday, February 01, 2012 | Sheet 35 of 56

Circuits to support BACO



Switch circuits in BACO desingns for Thanes/Seymour only





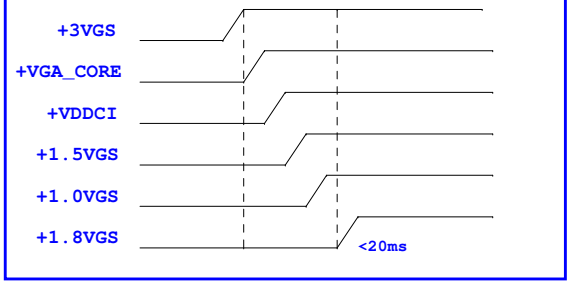
Note:

PX4.0 +VGA_CORE,VDDCI,+1.5VGS ON

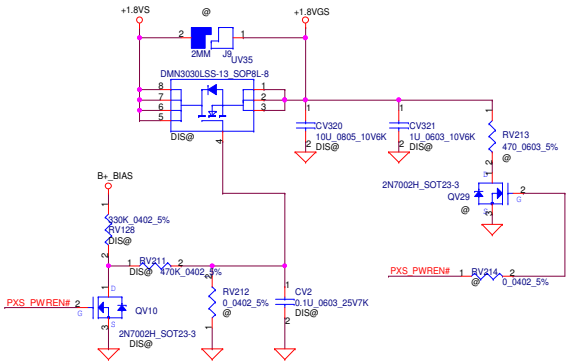
PX4.0 +3VGS, +1.0VGS,+1.8VGS OFF

PX5.0 +3VGS,+VGA_CORE,VDDCI,+1.5VGV,+1.0VGS,+1.8VGS OFF

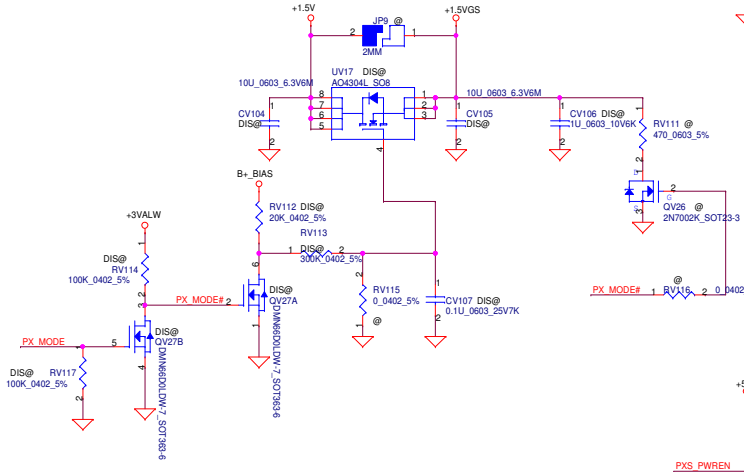
Power Seguence of Thames and Chelsea



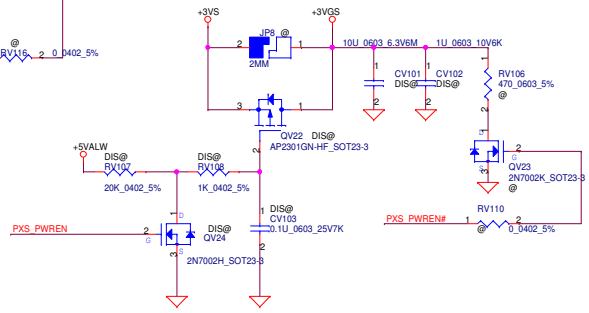
+1.8VS TO +1.8VGS



+1.5VS TO +1.5VGS



+3.3VS TO +3.3VGS



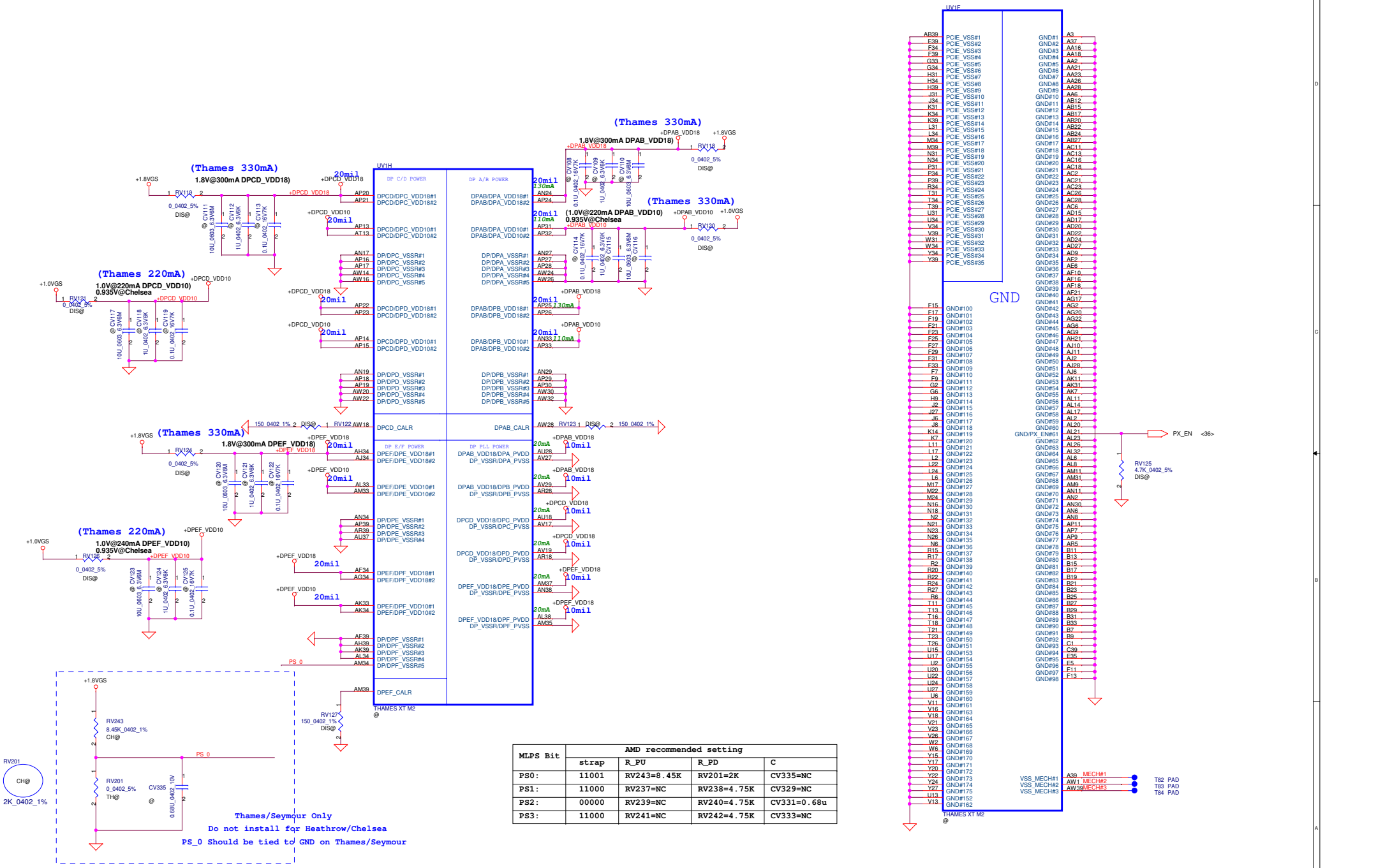
Security Classification	Compal Secret Data		
Issued Date	2012/01/17	Deciphered Date	2013/01/16

Compal Electronics, Inc.

Title: ATI_SeymourXT_M2_BACO POWER

Size: C | Document Number: LA-8241P | Rev: 1.0

Date: Wednesday, February 01, 2012 | Sheet 36 of 56



MLPS Bit	AMD recommended setting			
	strap	R_PU	R_PD	C
PS0:	11001	RV243=8.45K	RV201=2K	CV335=NC
PS1:	11000	RV237=NC	RV238=4.75K	CV329=NC
PS2:	00000	RV239=NC	RV240=4.75K	CV331=0.68u
PS3:	11000	RV241=NC	RV242=4.75K	CV333=NC

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Issued Date	2012/01/17	Deciphered Date	2013/01/16

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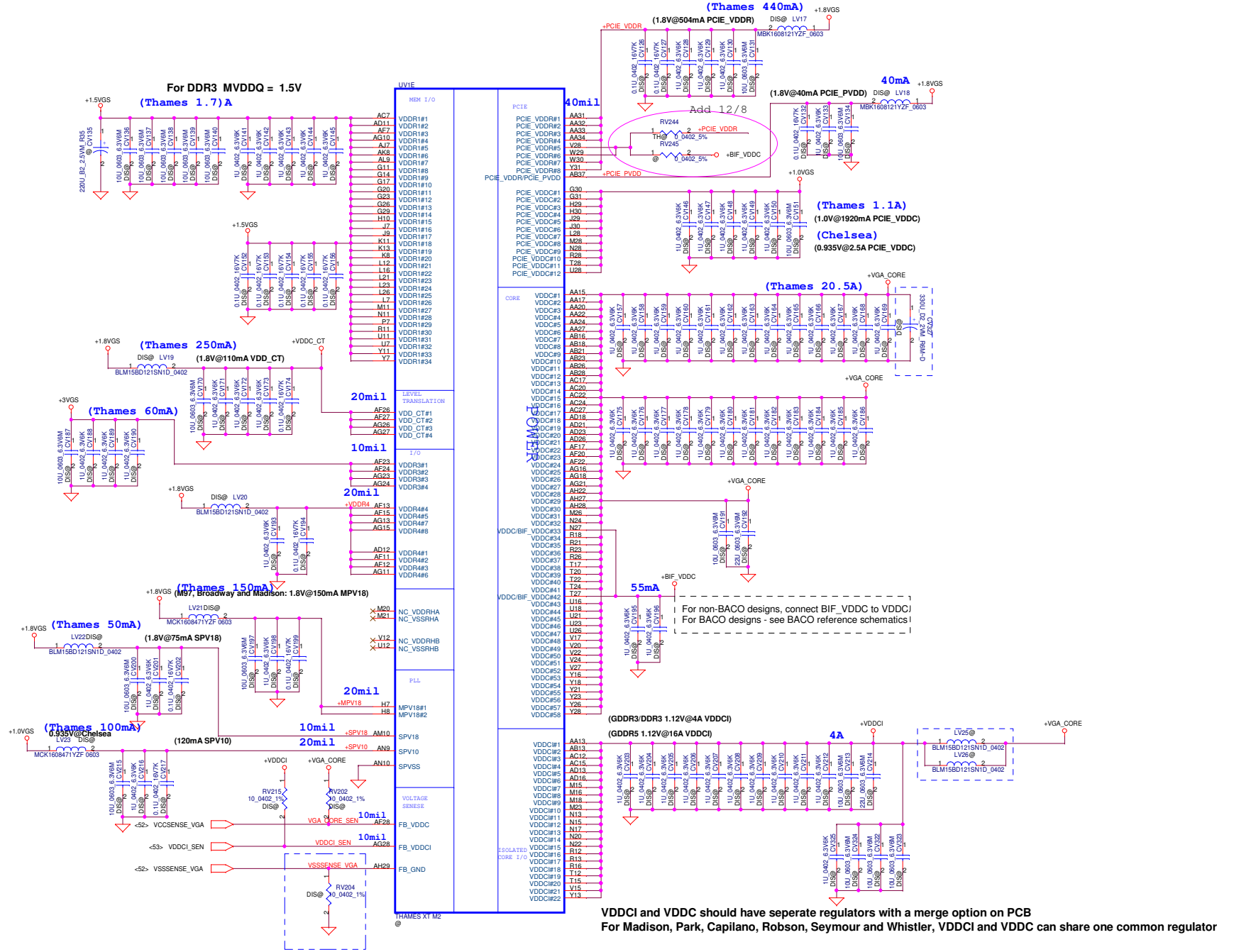
Compal Electronics, Inc.

Title: ATI_SetmourXT_M2_PWR_GND

Size	Document Number	Rev
C	LA-8241P	1.0

Date: Wednesday, February 01, 2012 Sheet 37 of 56



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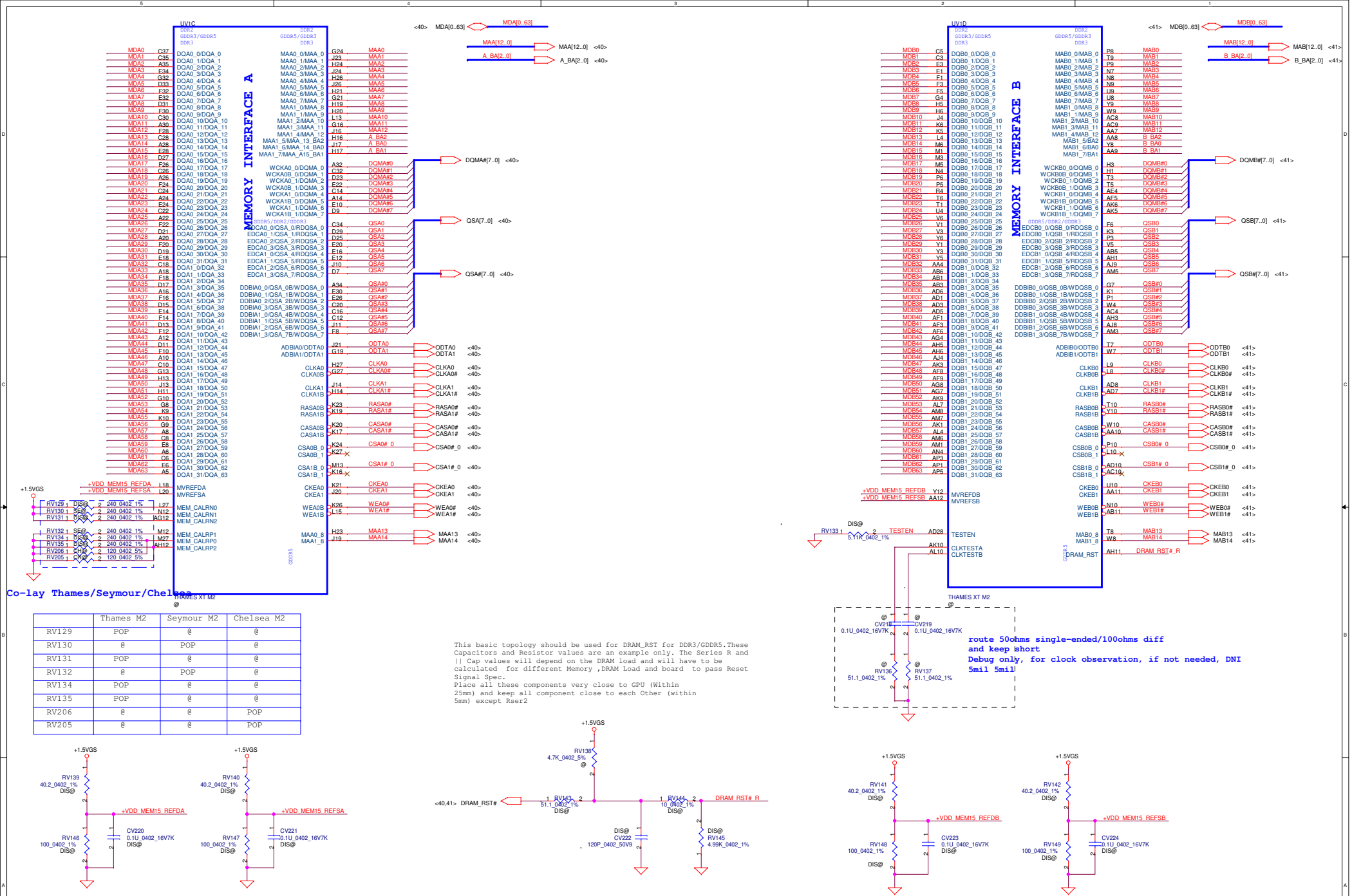
Compal Electronics, Inc.

Title: ATI_SeymourXT_M2_Power

Size	Document Number	Rev
C	LA-8241P	1.0

Date: Wednesday, February 01, 2012 Sheet 38 of 56



	Thames M2	Seymour M2	Chelsea M2
RV129	POP	@	@
RV130	@	POP	@
RV131	POP	@	@
RV132	@	POP	@
RV134	POP	@	@
RV135	POP	@	@
RV206	@	@	POP
RV205	@	@	POP

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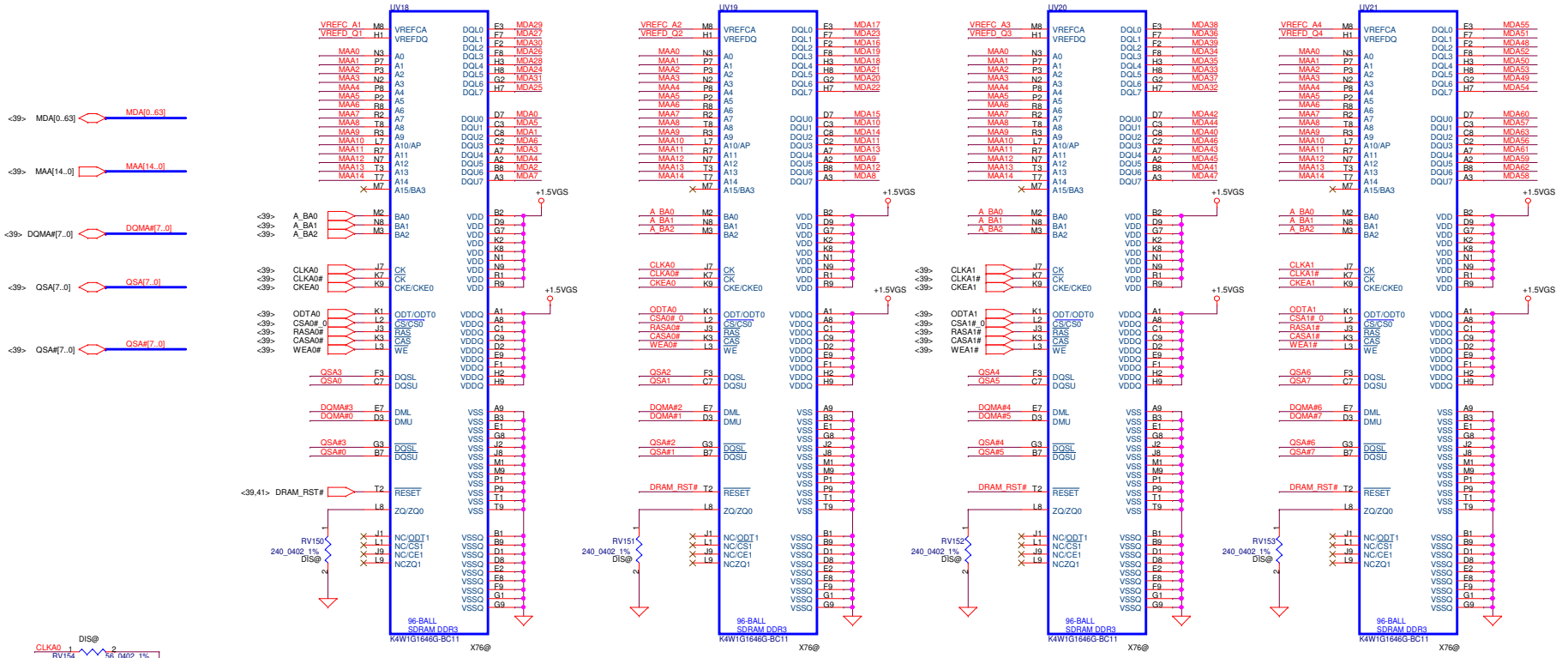
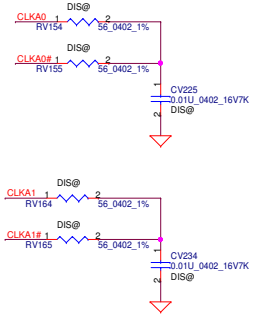
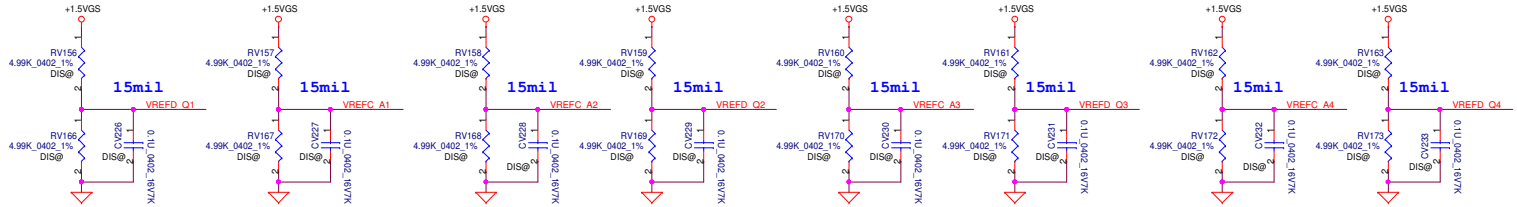
Issued Date	2012/01/17	Deciphered Date	2013/01/16

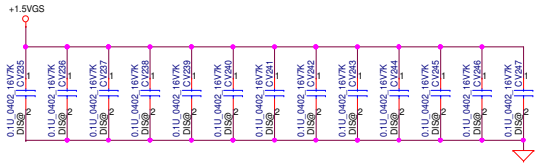
Compal Electronics, Inc.			
Title	ATI_SeymourXT_M2_MEM IF		
Size C	Document Number LA-8241P		Rev 1.0
Date: Wednesday, February 01, 2012	Sheet 39 of 56		

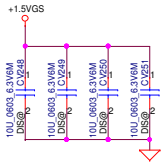
CHANNEL A: 256MB/512MB DDR3

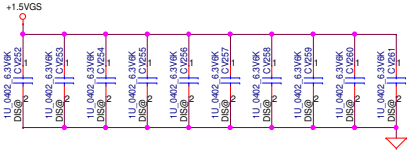


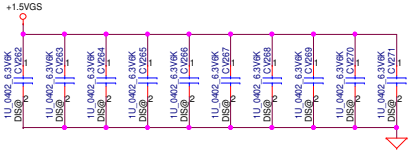












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Title: ATI_SeymourXT_M2_VRAM_A

Size	Document Number	Rev
C	LA-8241P	1.0

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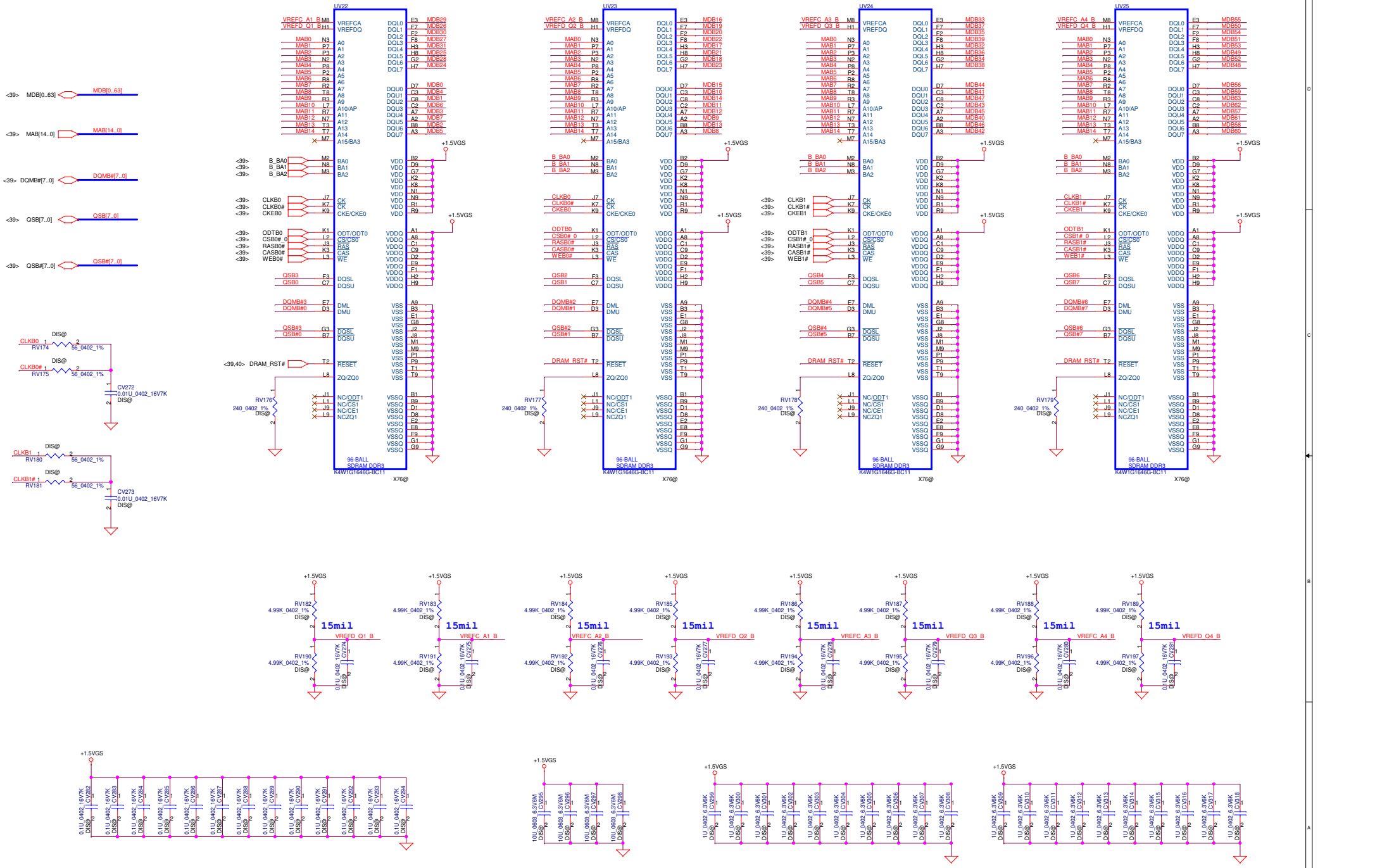
CHANNEL B: 256MB/512MB DDR3



Security Classification	Compal Secret Data		
Issued Date	2012/01/17	Deciphered Date	2013/01/16

Compal Electronics, Inc.

Title: ATI_SeymourXT_M2_VRAM_B

Size	Document Number	Rev
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Version Change List (P. I. R. List) Page 1

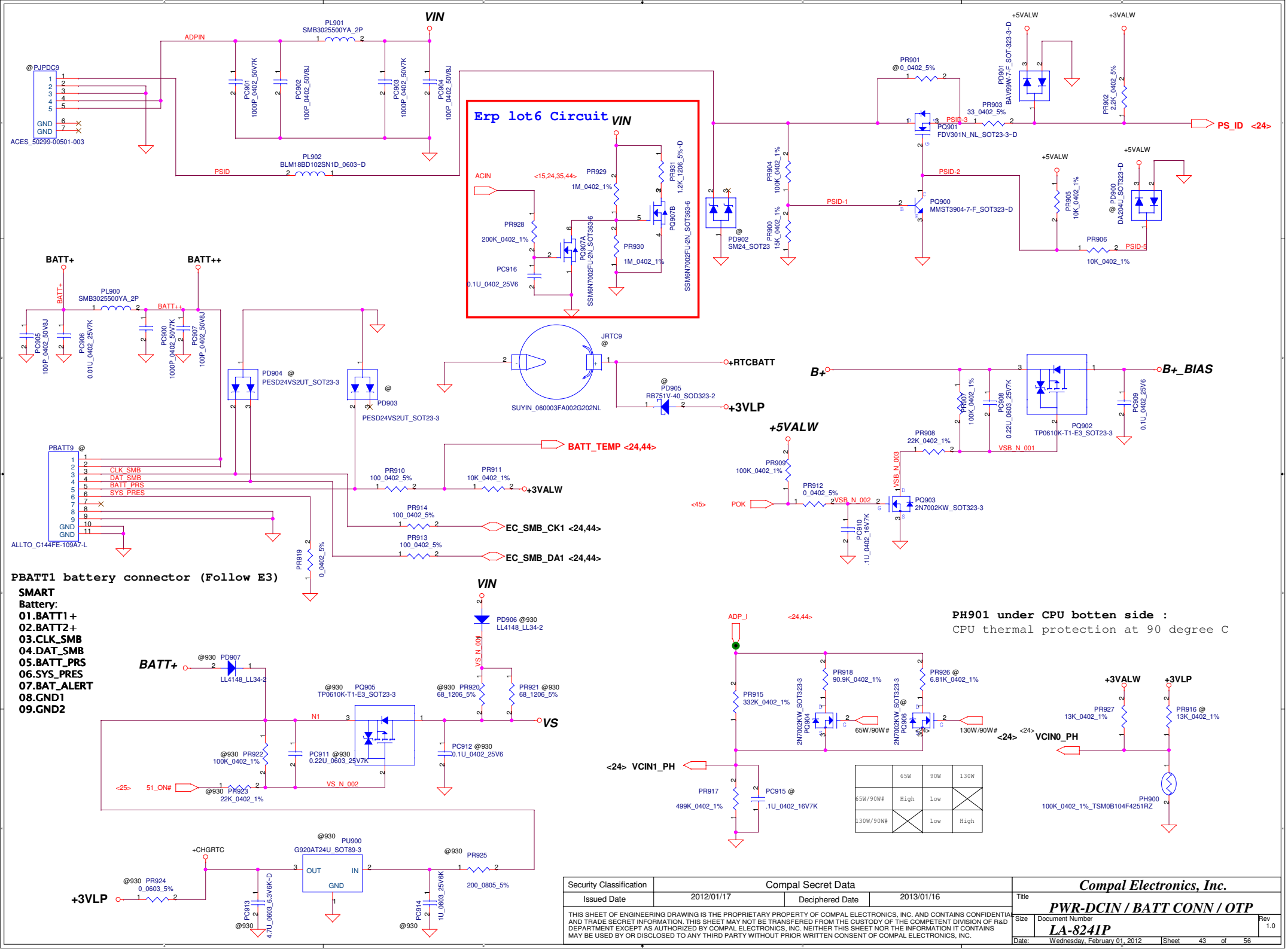
Item	Page #	Title	Date	Request Owner	Issue Description	Solution Description	Rev.
1	08,11,12	DIMM	11/07/28	COMPAL	The M3 traces are routed to the Sandy Bridge Processor reserved pins for DDR3 VREF	Intel CHKLST Rev1.5 required	0.1
2	18,19	PCH	11/07/28	COMPAL	VCCDMI, V_PROC_IO change to +VCCP from +1.05VS	Intel CHKLST Rev1.5 required	0.1
3	09,10	CPU	11/07/28	COMPAL	remove decoupling cap for +VCC_CORE, +VCCP, +VCC_GFXCORE_AXG, owner change to PWR	Intel CHKLST Rev1.5 required	0.1
4	10	CPU	11/07/28	COMPAL	VCCSA_SELECT[0:1] which should be connected to VID[1:0] of the System Agent (SA) VR controller.	Intel CHKLST Rev1.5 required	0.1
5							
6							
7							
8							
9							
10							
11							
12							
13							
14							
15							
16							
17							
18							

Compal Electronics, Inc.

Title: HW-PIR

Size | Document Number | Rev 1.0

Date: Wednesday, February 01, 2012 | Sheet 42 of 56



Security Classification	Compal Secret Data		
Issued Date	2012/01/17	Deciphered Date	2013/01/16

Compal Electronics, Inc.

Title: **PWR-DCIN / BATT CONN / OTP**

Size: | Document Number: **LA-8241P** | Rev: 1.0

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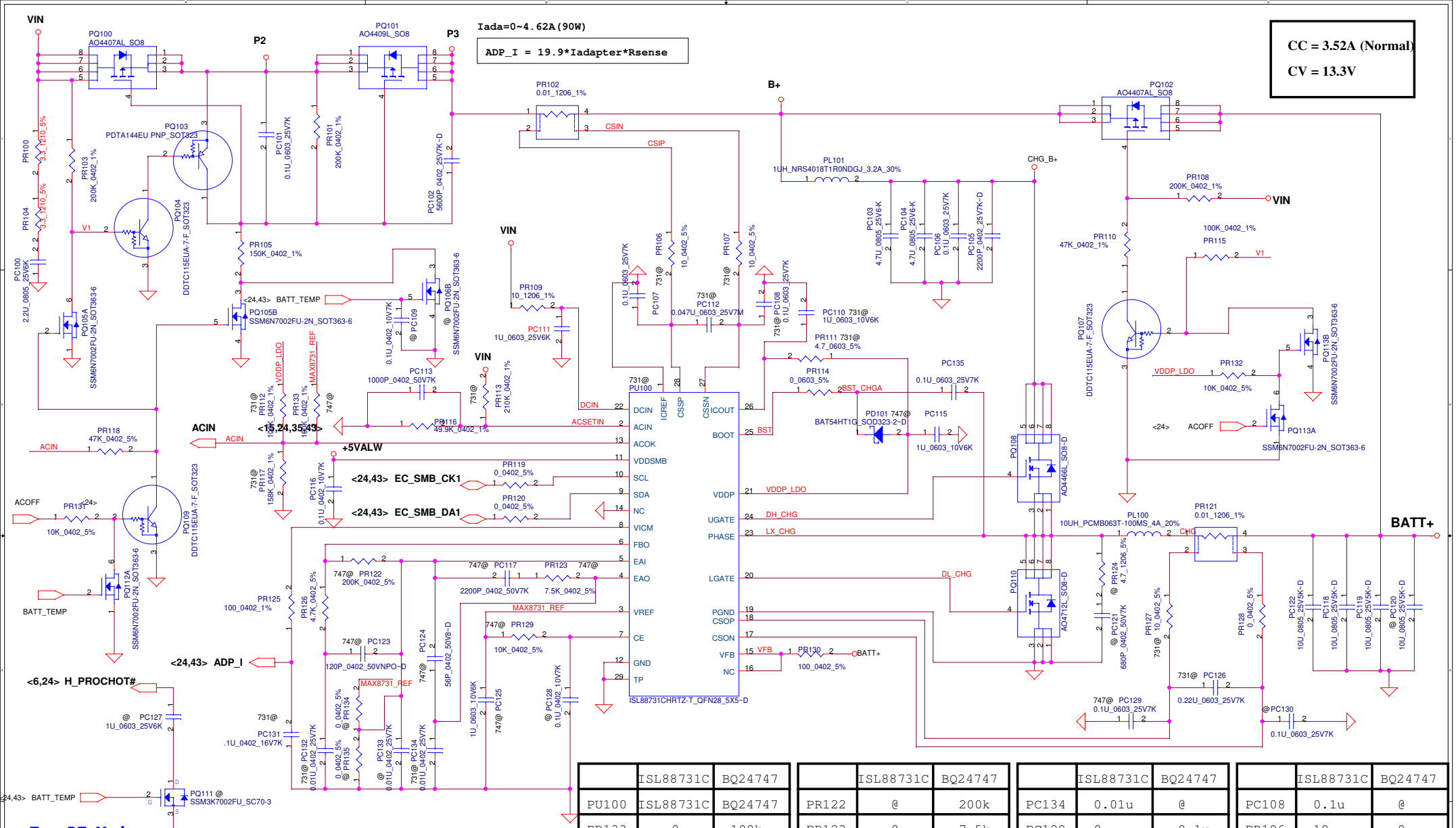


	ISL88731C	BQ24747
PU100	ISL88731C	BQ24747
PR133	@	100k
PR112	100k	@
PR117	158k	@
PR113	210k	309k
PC131	0.1u	220p
PC132	0.01u	@

	ISL88731C	BQ24747
PR122	@	200k
PR123	@	7.5k
PR129	@	10k
PC117	@	2200p
PC124	@	56p
PC123	@	120p
PC125	@	1u

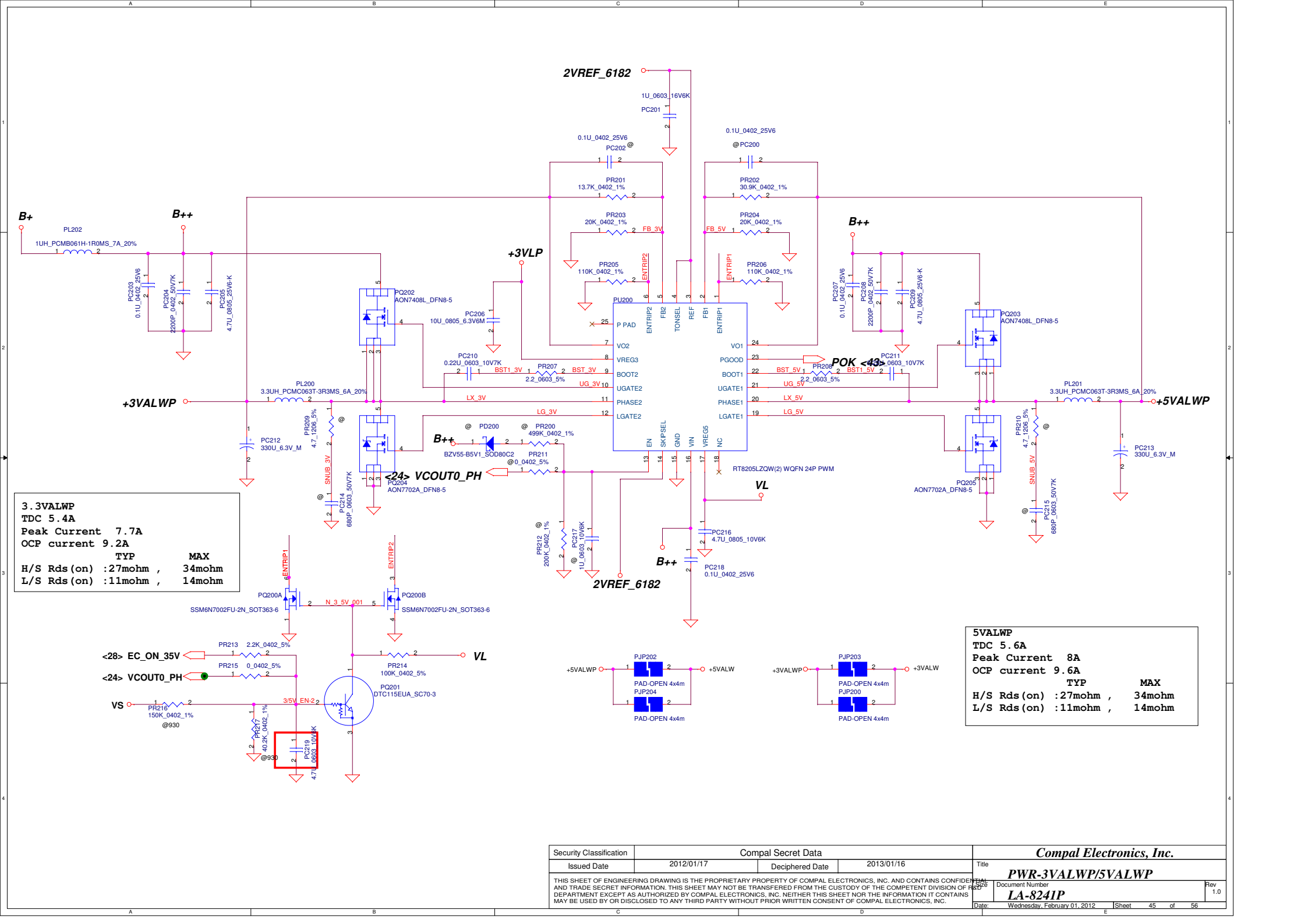
	ISL88731C	BQ24747
PC134	0.01u	@
PC129	@	0.1u
PC126	0.22u	0.1u
PR127	10	0
PR111	4.7	@
PC110	1u	@
PD101	@	BAT54HT1G

	ISL88731C	BQ24747
PC108	0.1u	@
PR106	10	0
PR107	10	0
PC112	0.047u	0.1u

731@ for ISL88731C
747@ for BQ24747

Security Classification	Compal Secret Data		
Issued Date	2012/01/17	Deciphered Date	2013/01/16

Compal Electronics, Inc.	
Title	PWR-Charger
Size	Document Number: LA-8241P
Rev	1.0
Date:	Wednesday, February 01, 2012
Sheet	44 of 56



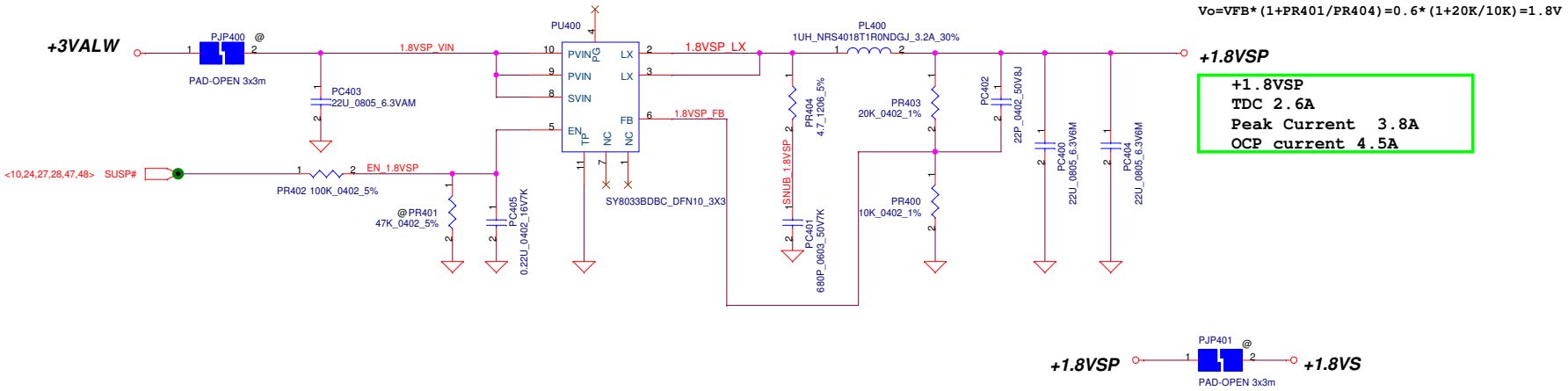
Security Classification	Compal Secret Data		
Issued Date	2012/01/17	Deciphered Date	2013/01/16

Compal Electronics, Inc.

Title: PWR-3VALWP/5VALWP

Size: B | Document Number: LA-8241P | Rev: 1.0

Date: Wednesday, February 01, 2012 | Sheet 45 of 56



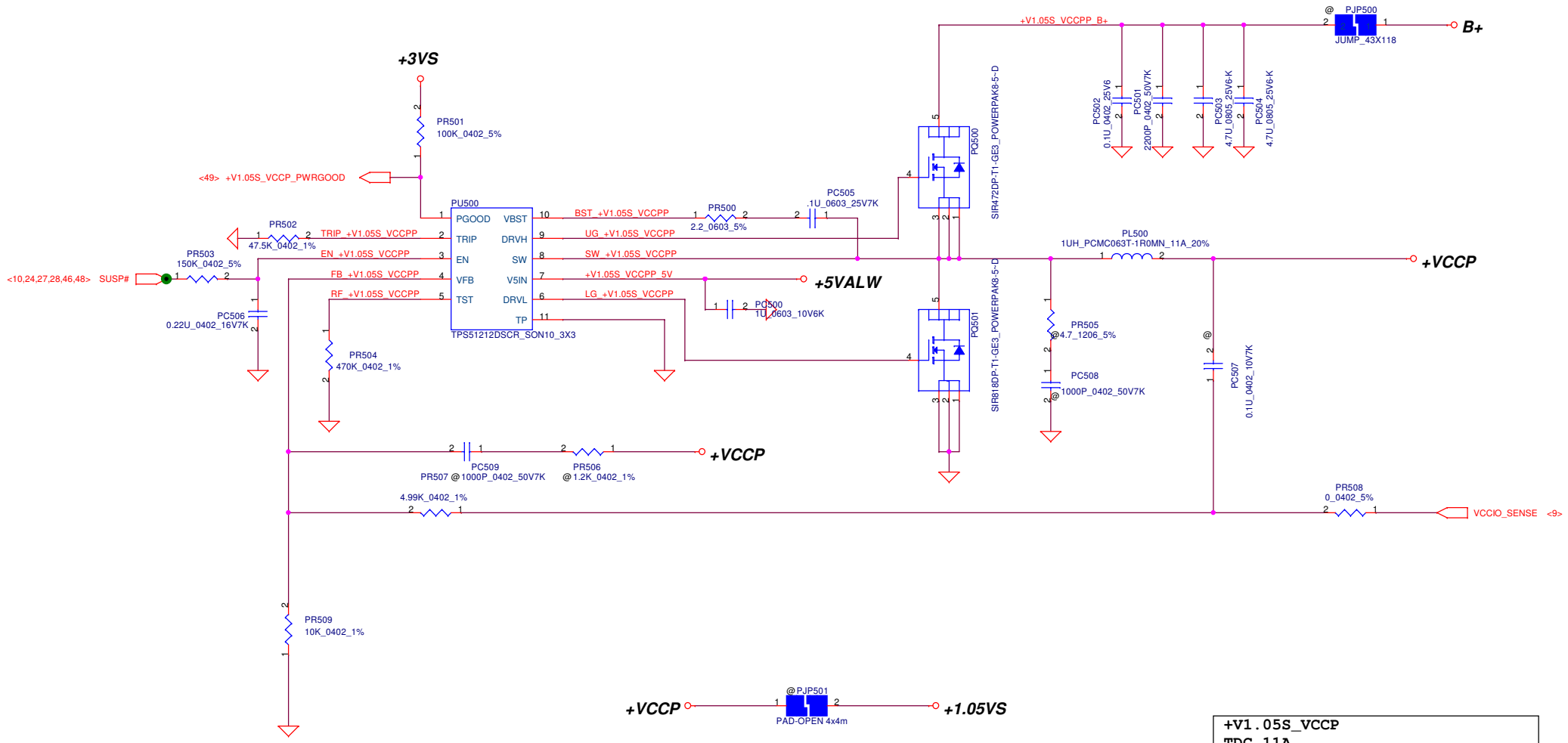
Security Classification	Compal Secret Data		
Issued Date	2012/01/17	Deciphered Date	2013/01/16

Compal Electronics, Inc.

Title: PWR-1.8VSP

Size | Document Number: LA-8241P | Rev: 1.0

Date: Wednesday, February 01, 2012 | Sheet 46 of 56



+V1.05S_VCCP
TDC 11A
Peak Current 16A
OCP current 19A

	TYP	MAX
H/S Rds(on)	10mohm ,	14.5mohm
L/S Rds(on)	:3mohm ,	3.6mohm

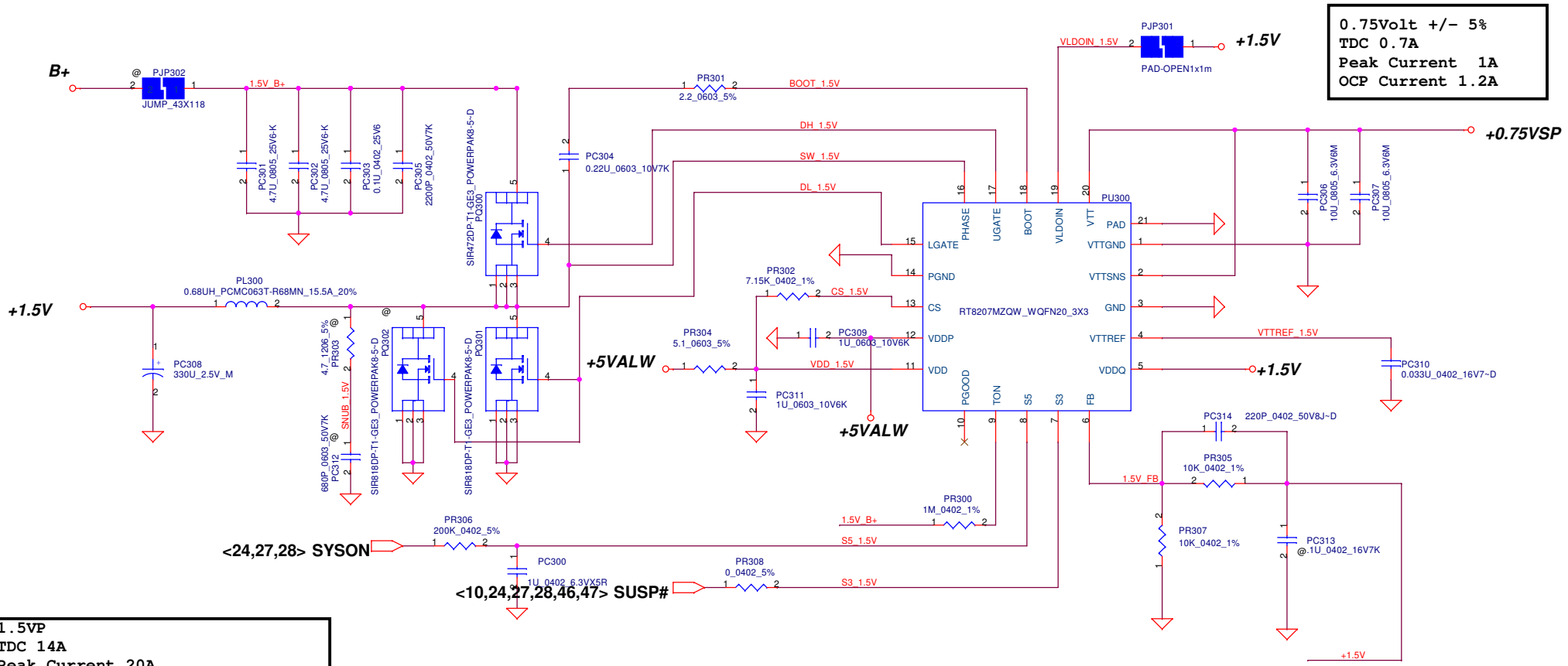
Security Classification	Compal Secret Data		
Issued Date	2012/01/17	Deciphered Date	2013/01/16

Compal Electronics, Inc.

Title: PWR-V1.05S_VCCPP

Size | Document Number: LA-8241P | Rev: 1.0

Date: Wednesday, February 01, 2012 | Sheet 47 of 56



Security Classification	Compal Secret Data		
Issued Date	2012/01/17	Deciphered Date	2013/01/16

Compal Electronics, Inc.

Title: PWR-1.5V/0.75VSP

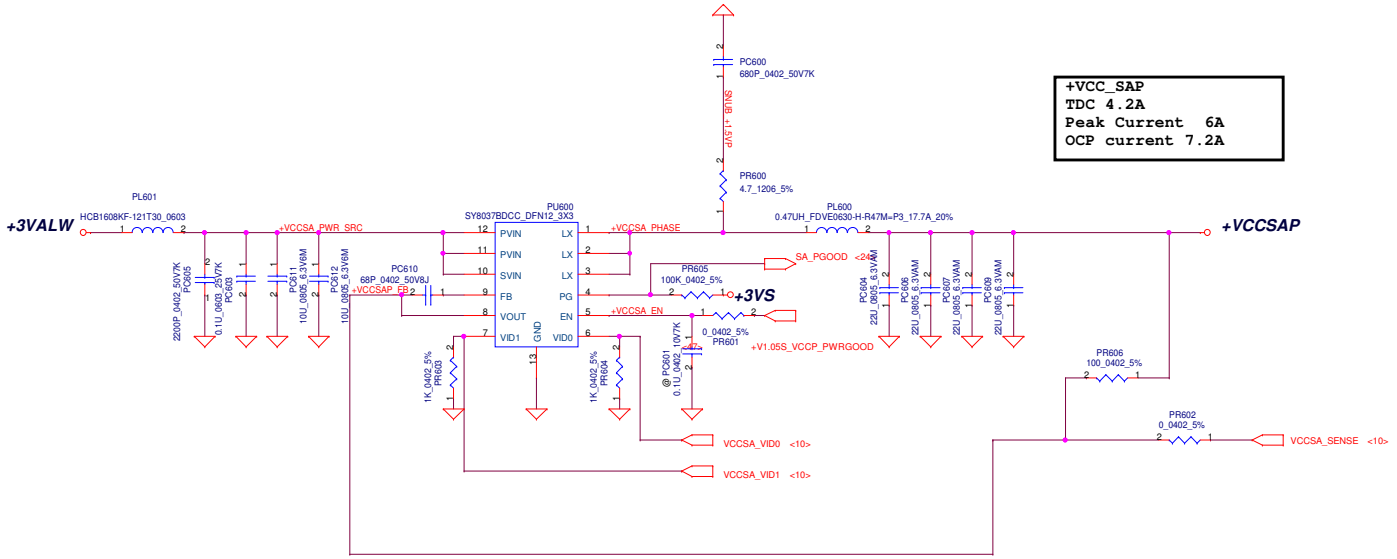
Size: | Document Number: LA-8241P | Rev: 1.0

Date: Wednesday, February 01, 2012 | Sheet 48 of 56

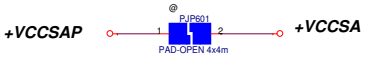
VID [0]	VID[1]	VCCSA Vout
0	0	0.9V
0	1	0.8V
1	0	0.725V
1	1	0.675V

output voltage adjustable network

+VCC_SAP
TDC 4.2A
Peak Current 6A
OCP current 7.2A



The 1k PD on the VCCSA VIDs are empty. These should be stuffed to ensure that VCCSA VID is 00 prior to VCCIO stability.



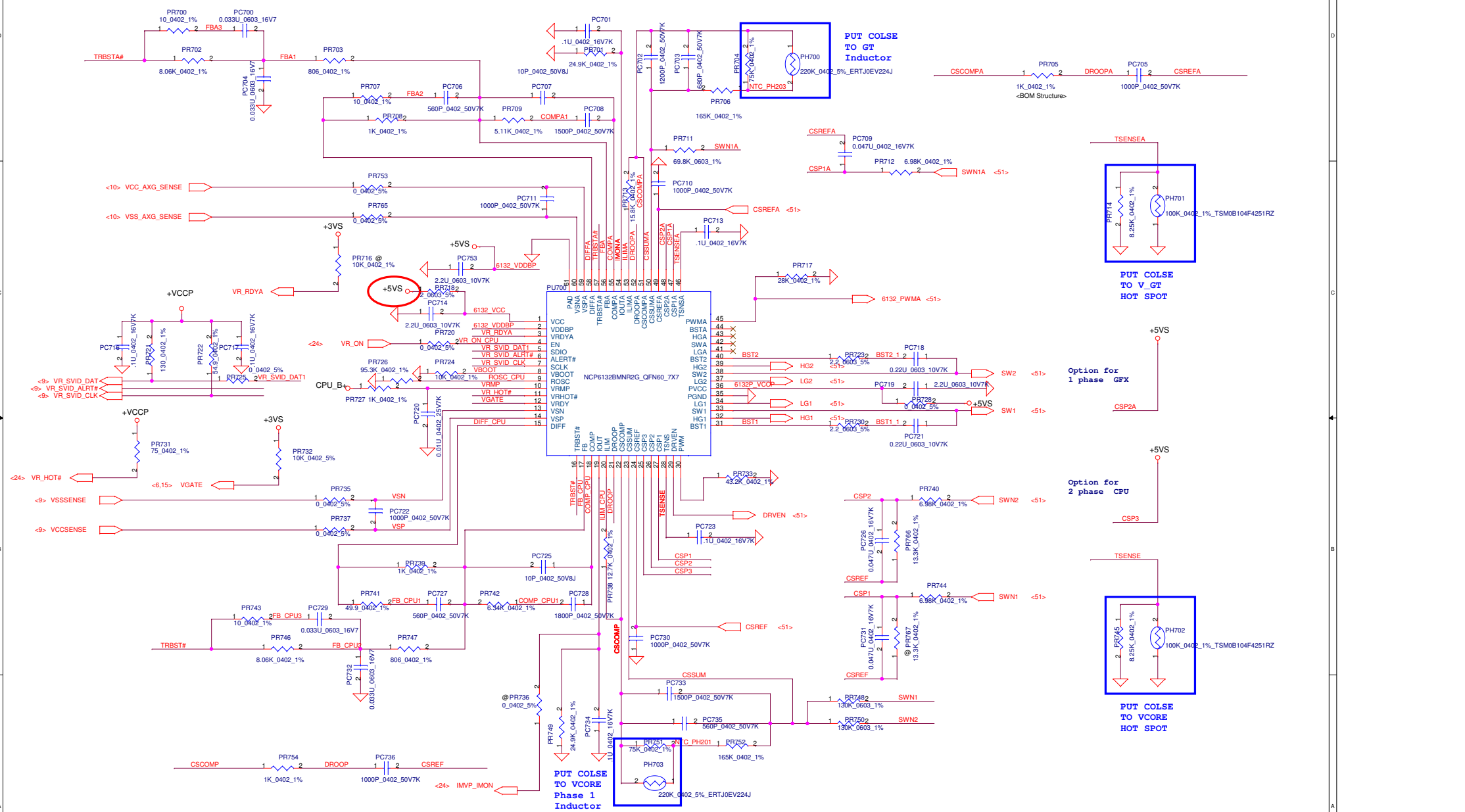
Security Classification	Compal Secret Data		
Issued Date	2012/01/17	Deciphered Date	2013/01/16

Compal Electronics, Inc.

Title: PWR-VCC_SAP

Size: | Document Number: LA-8241P | Rev: 1.0

Date: Wednesday, February 01, 2012 | Sheet 49 of 56



Security Classification	Compal Secret Data		
Issued Date	2012/01/17	Deciphered Date	2013/01/16

Compal Electronics, Inc.

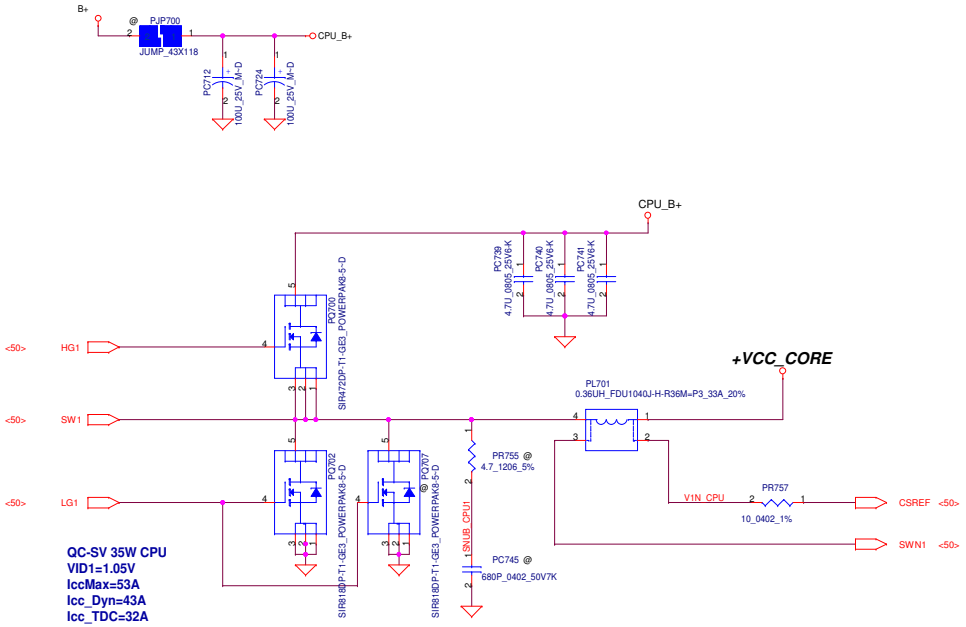
Title: **CPU Core**

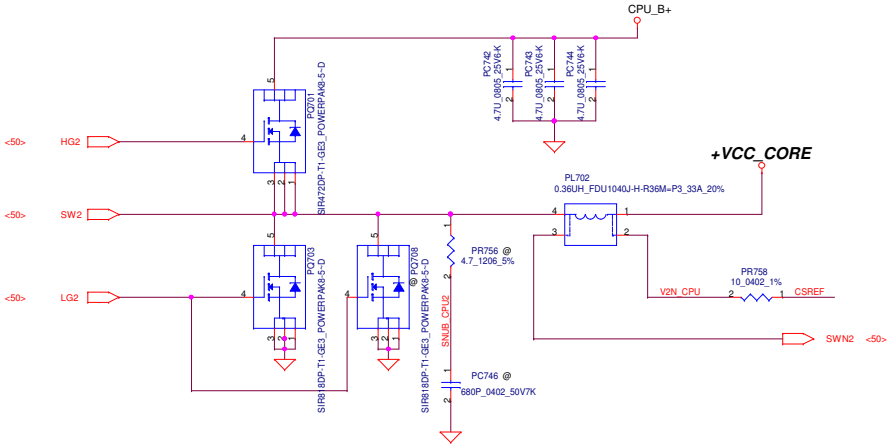
Size | Document Number: **LA-8241P** | Rev: 1.0

Date: Wednesday, February 01, 2012 | Sheet 50 of 56

VCC_core
TDC 32A
Peak Current 53A
OCP current 65
Load line -1.9mV/A
FSW=300kHz
DCR 1.1mohm +/-5%

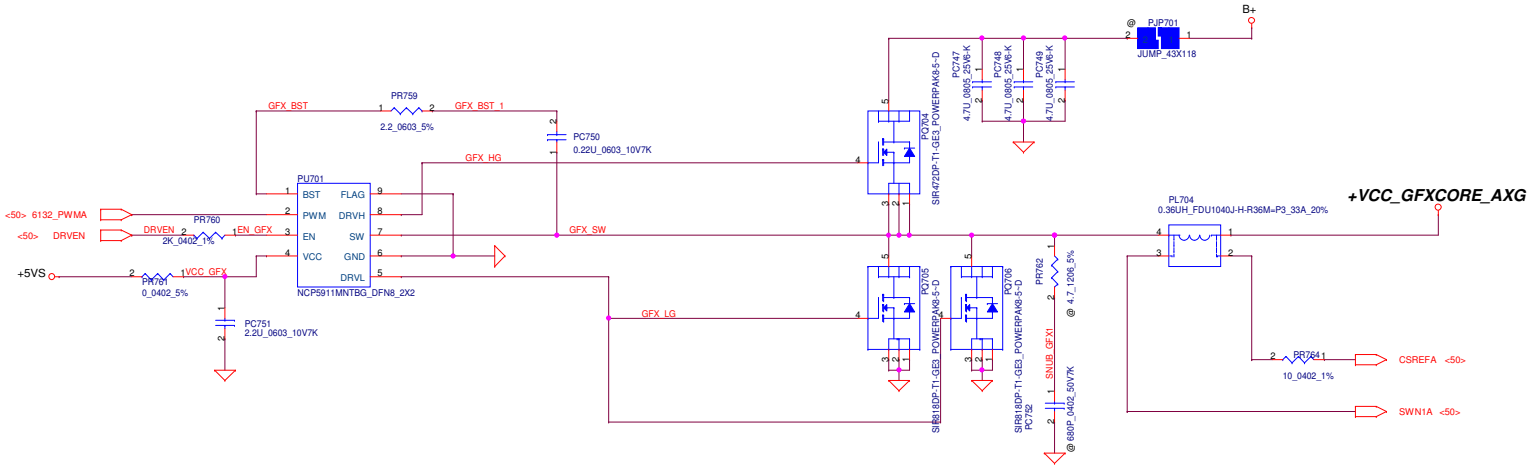
	TYP	MAX
H/S Rds(on)	:10mohm ,	14.5mohm
L/S Rds(on)	:3mohm ,	3.6mohm





+VCC_GFXCORE_AXG
TDC 21.5A
Peak Current 33A
OCP current 40A
Load line -3.9mV/A
FSW=300kHz
DCR 1.1mohm +/-5%

	TYP	MAX
H/S Rds(on)	:10mohm ,	14.5mohm
L/S Rds(on)	:3mohm ,	3.6mohm



Security Classification	Compal Secret Data		
Issued Date	2012/01/17	Deciphered Date	2013/01/16

Compal Electronics, Inc.

Title: PWR-VCC_SAP

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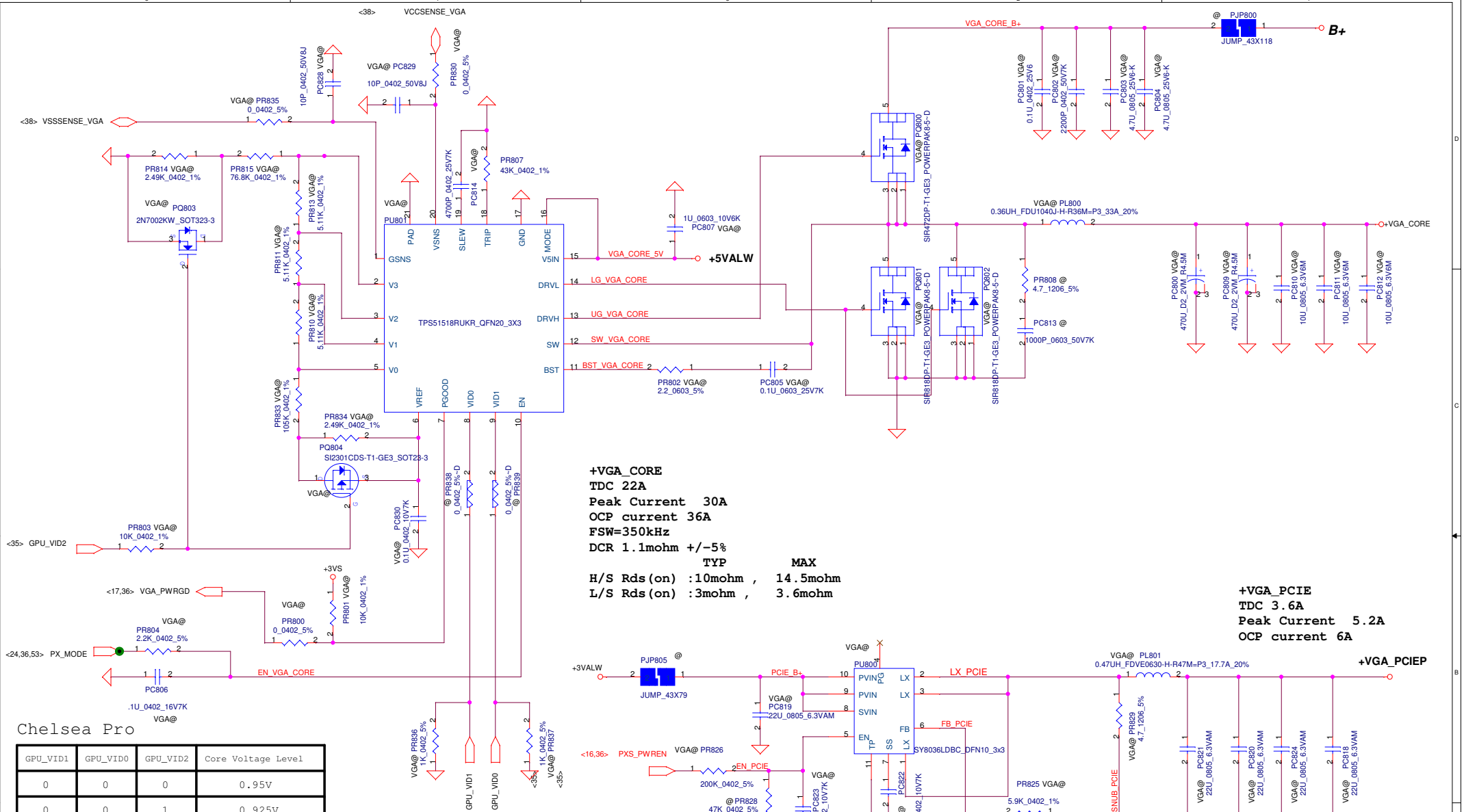

Chelsea Pro

GPU_VID1	GPU_VID0	GPU_VID2	Core Voltage Level
0	0	0	0.95V
0	0	1	0.925V
0	1	0	0.9V
0	1	1	0.875V
1	0	0	0.85V
1	0	1	0.825V
1	1	0	0.8V
1	1	1	0.775V

	Thames XT	Chelsea Pro
VGA_PCIE	1.0V	0.95V
PR825	6.81K	5.9K

Security Classification	Compal Secret Data		
Issued Date	2012/01/17	Deciphered Date	2013/01/16

Compal Electronics, Inc.			
Title: VGA_COREP			
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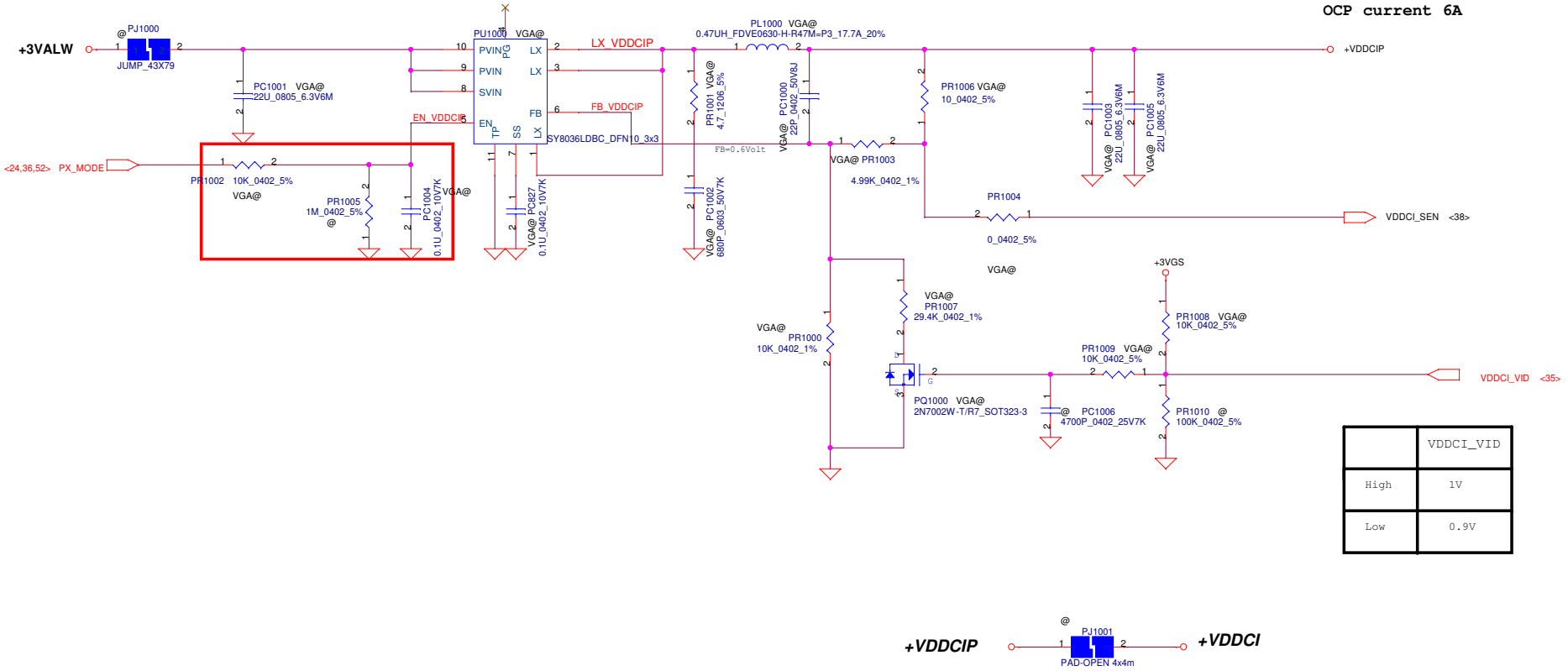
+VDDCI
TDC 2.8A
Peak Current 4A
OCP current 6A



	VDDCI_VID
High	1V
Low	0.9V

+VDDCIP @ PJ1001 PAD-OPEN 4x4m +VDDCI

Security Classification	Compal Secret Data		
Issued Date	2012/01/17	Deciphered Date	2013/01/16

Compal Electronics, Inc.

Title: +VDDCIP

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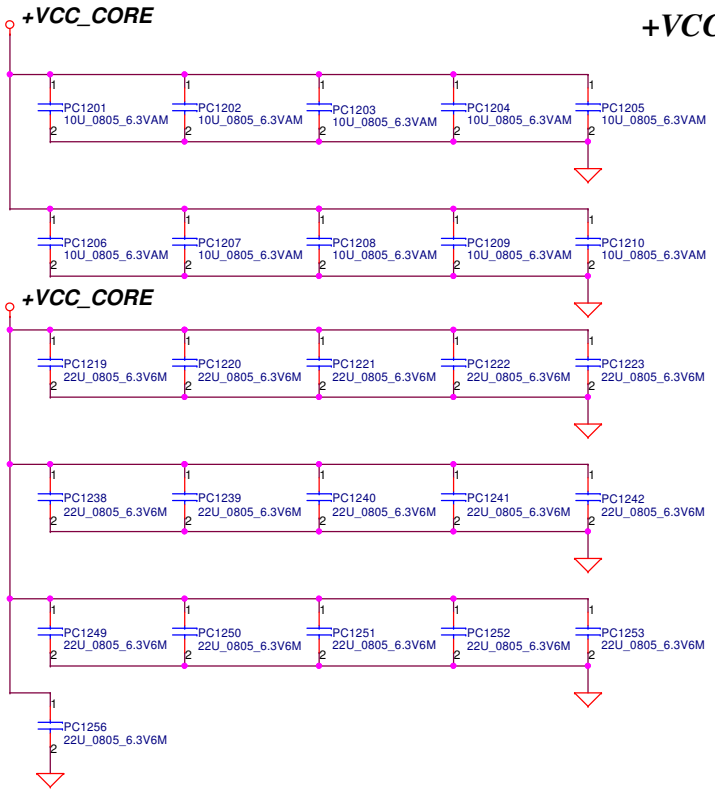
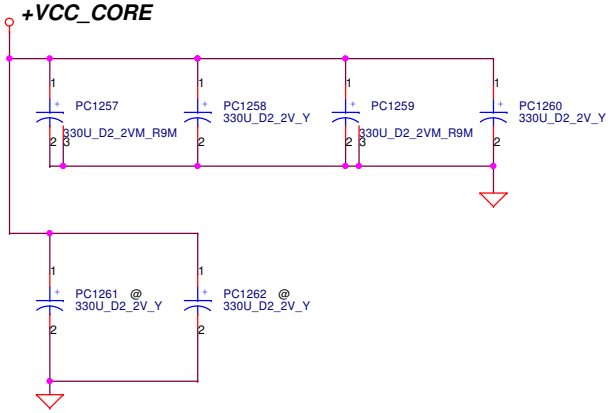
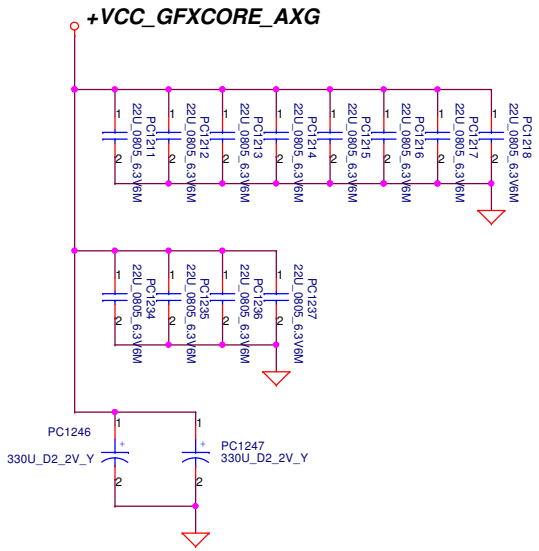




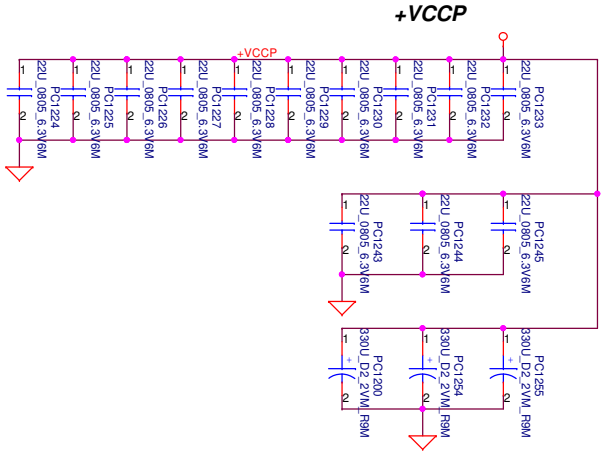
+VCC_CORE

+VCC_GFXCORE_AXG



Below is 458544_CRV_PDDG_0.5 Table 5-8.

Socket Bottom	5 x 22 µF (0805) 5 x (0805) no-stuff sites
Socket Top	7 x 22 µF (0805) 2 x (0805) no-stuff sites



Security Classification	Compal Secret Data		
Issued Date	2012/01/17	Deciphered Date	2013/01/16

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Title: PROCESSOR DECOUPLING

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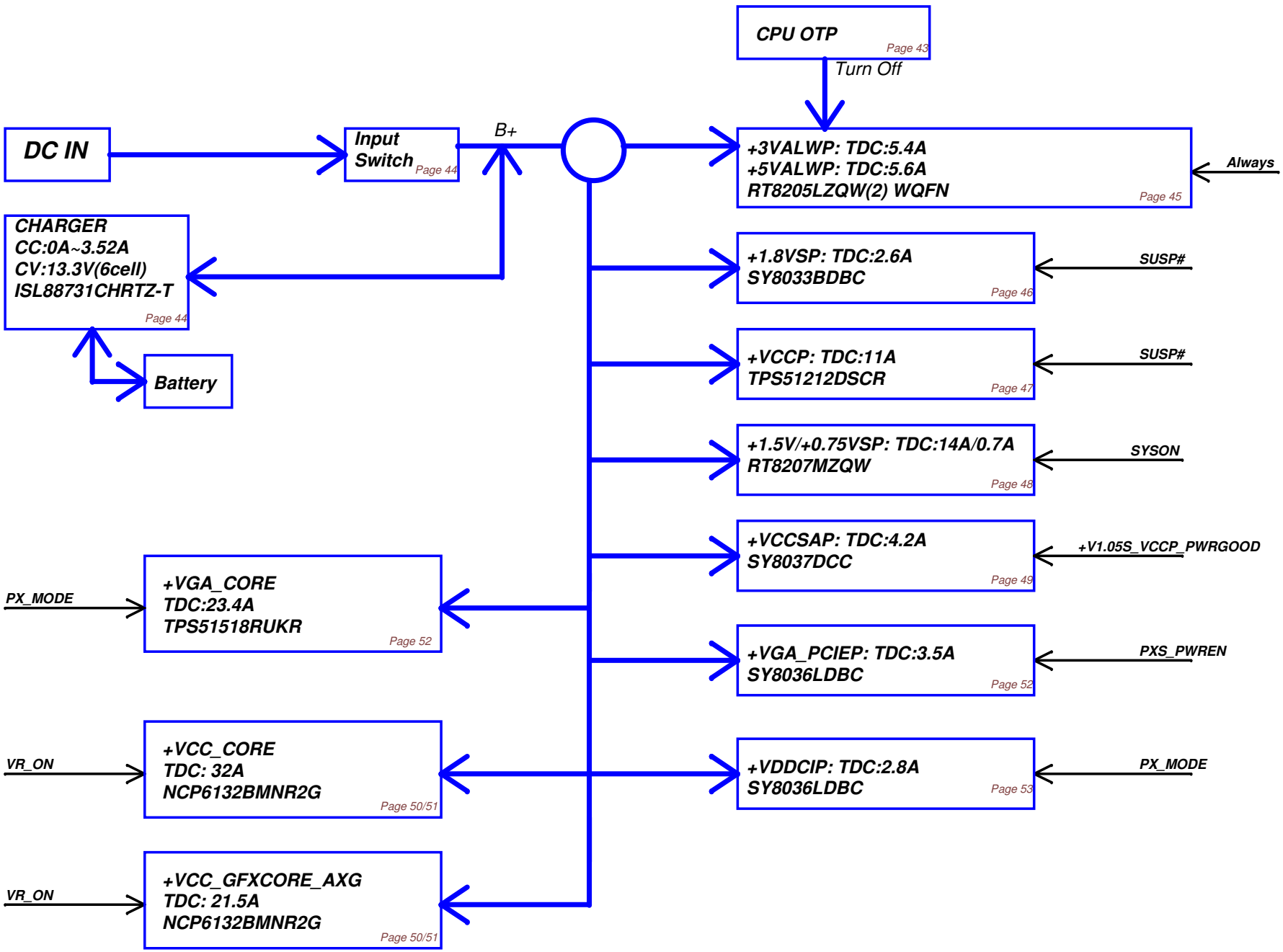
Power block



Security Classification	Compal Secret Data		Compal Electronics, Inc.
Issued Date	2012/1/17	Deciphered Date 2013/1/16	Title: PROCESSOR DECOUPLING

Size: B2B	Document Number: LA-8241P		Rev: 0.2
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Version Change List (P. I. R. List) Page 1

Item	Page#	Title	Date	Request Owner	Issue Description	Solution Description	Rev.
1	44	Charger.	11/12/08	Frank	Change PR113 for temperature and voltage test.	Change PR113 from 316k to 309k for Charger IC BQ24747RHDR. Remove PR132.	X00
2	45	3.3VALWP/5VALWP	11/12/08	Frank	Design change.	Change PC219 from 1uF to 4.7uF.	X00
3	53	+VDDCIP	11/12/08	Frank	Fine tune time sequence.	Change PR1002 from 100k to 0ohm. Remove PR1005 and PC1004.	X00